

TMS320C80 Digital Signal Processor

Data Sheet



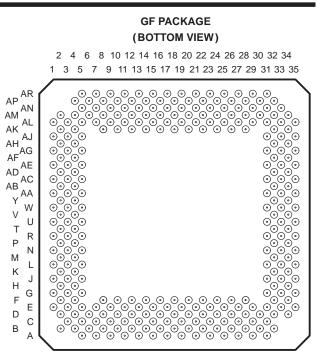


Printed in U.S.A., October 1997 SPRS023B

TMS320C80 DSP

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- Single-Chip Parallel Multiple Instruction/Multiple Data (MIMD) DSP
- More Than Two Billion RISC-Equivalent **Operations per Second**
- **Master Processor (MP)**
 - 32-Bit Reduced Instruction Set Computing (RISC) Processor
 - IEEE-754 Floating-Point Capability
 - 4K-Byte Instruction Cache
 - 4K-Byte Data Cache
- Four Parallel Processors (PP)
 - 32-Bit Advanced DSPs
 - 64-Bit Opcode Provides Many Parallel **Operations per Cycle**
 - 2K-Byte Instruction Cache and 8K-Byte Data RAM per PP
- Transfer Controller (TC)
 - 64-Bit Data Transfers
 - Up to 480M-Byte/s Transfer Rate
 - 32-Bit Addressing
 - Direct DRAM / VRAM Interface With **Dynamic Bus Sizing**
 - Intelligent Queuing and Cycle **Prioritization**
- Video Controller (VC)
 - Provides Video Timing and VRAM Control
 - Dual-Frame Timers for Two Simultaneous Image-Capture and / or Display Systems
- **Big- or Little-Endian Operation**
- 50K-Byte On-Chip RAM
- 4G-Byte Address Space
- 16.6-ns Cycle Time
- 3.3-V Operation
- IEEE Standard 1149.1[†] Test Access Port (JTAG)



GGP PACKAGE (BOTTOM VIEW)



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

† IEEE Standard 1149.1–1990, IEEE Standard Test Access Port and Boundary-Scan Architecture



TMS320C80 DIGITAL SIGNAL PROCESSOR

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description

The TMS320C80 is a single chip, MIMD parallel processor capable of performing over two billion operations per second. It consists of a 32-bit RISC master processor with a 120-MFLOP IEEE floating-point unit, four 32-bit parallel processing digital signal processors (DSPs), a transfer controller with up to 480M-byte/s off-chip transfer rate, and a video controller. All the processors are coupled tightly through an on-chip crossbar that provides shared access to on-chip RAM. This performance and programmability make the 'C80 ideally suited for video, imaging, and high-speed telecommunications applications.



GF Terminal Assignments – Numerical Listing

	TERMINAL		TERMINAL	TERMINAL		TE	RMINAL
NO.	NAME	NO.	NAME	NO.	NAME	NO.	NAME
A5	CT1	C21	V_{DD}	E33	HSYNC0	L5	V_{SS}
A7	V_{DD}	C23	W	E35	TCK	L31	V_{SS}
A9	HACK	C25	DBEN	F2	V_{DD}	L33	TRST
A11	Vss	C27	V _{SS}	F4	V _{SS}	L35	XPT1
A13	CAS/DQM7	C29	CAREA0	F8	V_{DD}	M2	V_{DD}
A15	CAS/DQM5	C31	CBLNK0 / VBLNK0	F10	V _{SS}	M4	Vss
A17	V_{DD}	D2	RETRY	F12	V_{DD}	M32	V _{SS}
A19	V _{SS}	D4	V_{DD}	F14	PS0	M34	V_{DD}
A21	RAS	D6	V_{SS}	F16	V_{SS}	N1	V_{DD}
A23	DSF	D8	AS0	F18	CT2	N3	A8
A25	Vss	D10	UTIME	F20	V_{DD}	N5	VSS
A27	SCLK1	D12	V _{SS}	F22	V _{SS}	N31	Vss
A29	V_{DD}	D14	RESET	F24	V_{DD}	N33	TMS
A31	EINT1	D16	REQ0	F26	V _{SS}	N35	V_{DD}
B2	No Connect	D18	V _{SS}	F28	V_{DD}	P2	A4
B4	BS1	D20	CAS/DQM0	F32	V _{SS}	P4	A9
В6	V_{DD}	D22	FCLK1	F34	V_{DD}	P32	TDO
B8	PS1	D24	Vss	G1	V_{DD}	P34	XPT0
B10	REQ1	D26	CAREA1	G3	A2	R1	VSS
B12	V_{DD}	D28	SCLK0	G5	A1	R3	V_{DD}
B14	CAS/DQM6	D30	V _{SS}	G31	EINT2	R5	V_{DD}
B16	CAS/DQM3	D32	V_{DD}	G33	CBLNK1 / VBLNK1	R31	V_{DD}
B18	V_{DD}	D34	VSYNC0	G35	V_{DD}	R33	V_{DD}
B20	CAS/DQM1	E1	AS1	H2	STATUS0	R35	VSS
B22	TRG/CAS	E3	FAULT	H4	A3	T2	A5
B24	V_{DD}	E5	Vss	H32	CSYNC1 / HBLNK1	T4	A13
B26	DDIN	E7	STATUS2	H34	TDI	T32	D62
B28	FCLK0	E9	READY	J1	STATUS1	T34	EMU0
B30	V_{DD}	E11	BS0	J3	V _{SS}	U1	V_{DD}
B32	CSYNC0 / HBLNK0	E13	V _{SS}	J5	V_{DD}	U3	A10
C3	Vss	E15	HREQ	J31	V_{DD}	U5	PS3
C5	STATUS3	E17	CAS/DQM4	J33	V _{SS}	U31	FF1
C7	AS2	E19	RL	J35	EMU1	U33	D61
C9	V_{SS}	E21	STATUS5	K2	STATUS4	U35	V_{DD}
C11	СТ0	E23	V _{SS}	K4	A6	V2	V_{DD}
C13	PS2	E25	CLKOUT	K32	VSYNC1	V4	Vss
C15	V_{DD}	E27	LINT4	K34	HSYNC1	V32	V _{SS}
C17	CLKIN	E29	EINT3	L1	A0	V34	V_{DD}
C19	CAS/DQM2	E31	V _{SS}	L3	A7	W1	A11



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GF Terminal Assignments – Numerical Listing (Continued)

TERI	TERMINAL		WINAL	TERM	MINAL	TERM	/INAL
NO.	NAME	NO.	NAME	NO.	NAME	NO.	NAME
W3	A18	AG1	A16	AL17	D20	AN29	D35
W5	V _{SS}	AG3	V _{SS}	AL19	D21	AN31	D45
W31	VSS	AG5	V_{DD}	AL21	D24	AN33	V_{DD}
W33	D59	AG31	V_{DD}	AL23	VSS	AP4	A27
W35	D63	AG33	Vss	AL25	D29	AP6	V_{DD}
Y2	A12	AG35	D57	AL27	D32	AP8	D5
Y4	A19	AH2	A20	AL29	D38	AP10	D8
Y32	XPT2	AH4	A30	AL31	V _{SS}	AP12	V_{DD}
Y34	D56	AH32	D44	AL33	D48	AP14	D13
AA1	VSS	AH34	D54	AL35	D53	AP16	D17
AA3	V_{DD}	AJ1	V_{DD}	AM2	A24	AP18	V_{DD}
AA5	V_{DD}	AJ3	A31	AM4	V_{DD}	AP20	D26
AA31	V_{DD}	AJ5	Vss	AM6	Vss	AP22	D34
AA33	V_{DD}	AJ31	V _{SS}	AM8	D2	AP24	V_{DD}
AA35	V _{SS}	AJ33	D42	AM10	D6	AP26	D39
AB2	A14	AJ35	V_{DD}	AM12	V _{SS}	AP28	D41
AB4	A21	AK2	V_{DD}	AM14	D14	AP30	V_{DD}
AB32	D55	AK4	Vss	AM16	D19	AP32	D47
AB34	D60	AK8	V_{DD}	AM18	Vss	AR5	D0
AC1	V_{DD}	AK10	V _{SS}	AM20	D23	AR7	V_{DD}
AC3	A22	AK12	V_{DD}	AM22	D25	AR9	D7
AC5	VSS	AK14	VSS	AM24	Vss	AR11	VSS
AC31	VSS	AK16	V_{DD}	AM26	D31	AR13	D11
AC33	D52	AK18	FF2	AM28	D33	AR15	D15
AC35	V_{DD}	AK20	VSS	AM30	V _{SS}	AR17	V_{SS}
AD2	V_{DD}	AK22	D27	AM32	V_{DD}	AR19	V_{DD}
AD4	V_{SS}	AK24	V_{DD}	AM34	D50	AR21	D30
AD32	V_{SS}	AK26	V_{SS}	AN5	A29	AR23	D36
AD34	V_{DD}	AK28	V_{DD}	AN7	D1	AR25	V_{SS}
AE1	A15	AK32	VSS	AN9	V _{SS}	AR27	D40
AE3	A26	AK34	V_{DD}	AN11	D9	AR29	V_{DD}
AE5	V_{SS}	AL1	A23	AN13	D12	AR31	D43
AE31	V_{SS}	AL3	A25	AN15	V_{DD}		
AE33	D51	AL5	V_{SS}	AN17	D18		
AE35	D58	AL7	D3	AN19	D22		
AF2	A17	AL9	D4	AN21	V_{DD}		
AF4	A28	AL11	D10	AN23	D28		
AF32	D46	AL13	V _{SS}	AN25	D37		
AF34	D49	AL15	D16	AN27	V _{SS}		



GF Terminal Assignments – Alphabetical Listing

TERM	IINAL	TERMINA	 L	TERM	/INAL	TERM	NAL
NAME	NO.	NAME	NO.	NAME	NO.	NAME	NO.
A0	L1	CAS/DQM0	D20	D22	AN19	D61	U33
A1	G5	CAS/DQM1	B20	D23	AM20	D62	T32
A2	G3	CAS/DQM2	C19	D24	AL21	D63	W35
A3	H4	CAS/DQM3	B16	D25	AM22	DBEN	C25
A4	P2	CAS/DQM4	E17	D26	AP20	DDIN	B26
A5	T2	CAS/DQM5	A15	D27	AK22	DSF	A23
A6	K4	CAS/DQM6	B14	D28	AN23	EINT1	A31
A7	L3	CAS/DQM7	A13	D29	AL25	EINT2	G31
A8	N3	CBLNK0/VBLNK0	C31	D30	AR21	EINT3	E29
A9	P4	CBLNK1/VBLNK1	G33	D31	AM26	EMU0	T34
A10	U3	CLKIN	C17	D32	AL27	EMU1	J35
A11	W1	CLKOUT	E25	D33	AM28	FAULT	E3
A12	Y2	CSYNC0/HBLNK0	B32	D34	AP22	FCLK0	B28
A13	T4	CSYNC1/HBLNK1	H32	D35	AN29	FCLK1	D22
A14	AB2	СТО	C11	D36	AR23	FF1	U31
A15	AE1	CT1	A5	D37	AN25	FF2	AK18
A16	AG1	CT2	F18	D38	AL29	HACK	A9
A17	AF2	D0	AR5	D39	AP26	HREQ	E15
A18	W3	D1	AN7	D40	AR27	HSYNC0	E33
A19	Y4	D2	AM8	D41	AP28	HSYNC1	K34
A20	AH2	D3	AL7	D42	AJ33	LINT4	E27
A21	AB4	D4	AL9	D43	AR31	PS0	F14
A22	AC3	D5	AP8	D44	AH32	PS1	B8
A23	AL1	D6	AM10	D45	AN31	PS2	C13
A24	AM2	D7	AR9	D46	AF32	PS3	U5
A25	AL3	D8	AP10	D47	AP32	RAS	A21
A26	AE3	D9	AN11	D48	AL33	READY	E9
A27	AP4	D10	AL11	D49	AF34	REQ0	D16
A28	AF4	D11	AR13	D50	AM34	REQ1	B10
A29	AN5	D12	AN13	D51	AE33	RESET	D14
A30	AH4	D13	AP14	D52	AC33	RETRY	D2
A31	AJ3	D14	AM14	D53	AL35	RL	E19
AS0	D8	D15	AR15	D54	AH34	SCLK0	D28
AS1	E1	D16	AL15	D55	AB32	SCLK1	A27
AS2	C7	D17	AP16	D56	Y34	STATUS0	H2
BS0	E11	D18	AN17	D57	AG35	STATUS1	J1
BS1	B4	D19	AM16	D58	AE35	STATUS2	E7
CAREA0	C29	D20	AL17	D59	W33	STATUS3	C5
CAREA1	D26	D21	AL19	D60	AB34	STATUS4	K2



GF Terminal Assignments – Alphabetical Listing (Continued)

TERMINAL		TERM	IINAL	TERM	IINAL	TERM	/INAL
NAME	NO.	NAME	NO.	NAME	NO.	NAME	NO.
STATUS5	E21	V_{DD}	R31	V_{DD}	AR29	V _{SS}	AA35
TCK	E35	V_{DD}	R33	V _{SS}	A11	V _{SS}	AC5
TDI	H34	V_{DD}	U1	V _{SS}	A19	V _{SS}	AC31
TDO	P32	V_{DD}	U35	V _{SS}	A25	V _{SS}	AD4
TMS	N33	V_{DD}	V2	V _{SS}	C3	V _{SS}	AD32
TRG/CAS	B22	V_{DD}	V34	V _{SS}	C9	VSS	AE5
TRST	L33	V_{DD}	AA3	V_{SS}	C27	V _{SS}	AE31
UTIME	D10	V_{DD}	AA5	V _{SS}	D6	V _{SS}	AG3
V_{DD}	A7	V_{DD}	AA31	V _{SS}	D12	V _{SS}	AG33
V_{DD}	A17	V_{DD}	AA33	V _{SS}	D18	VSS	AJ5
V_{DD}	A29	V_{DD}	AC1	V _{SS}	D24	VSS	AJ31
V_{DD}	B6	V_{DD}	AC35	V _{SS}	D30	VSS	AK4
V_{DD}	B12	V_{DD}	AD2	V _{SS}	E5	VSS	AK10
V_{DD}	B18	V_{DD}	AD34	V _{SS}	E13	V _{SS}	AK14
V_{DD}	B24	V_{DD}	AG5	V _{SS}	E23	V _{SS}	AK20
V_{DD}	B30	V_{DD}	AG31	V _{SS}	E31	Vss	AK26
V_{DD}	C15	V_{DD}	AJ1	V _{SS}	F4	VSS	AK32
V_{DD}	C21	V_{DD}	AJ35	V _{SS}	F10	VSS	AL5
V_{DD}	D4	V_{DD}	AK2	V _{SS}	F16	Vss	AL13
V_{DD}	D32	V_{DD}	AK8	V _{SS}	F22	VSS	AL23
V_{DD}	F2	V_{DD}	AK12	V _{SS}	F26	V _{SS}	AL31
V_{DD}	F8	V_{DD}	AK16	V _{SS}	F32	VSS	AM6
V_{DD}	F12	V_{DD}	AK24	V _{SS}	J3	V _{SS}	AM12
V_{DD}	F20	V_{DD}	AK28	V _{SS}	J33	V _{SS}	AM18
V_{DD}	F24	V_{DD}	AK34	V _{SS}	L5	V _{SS}	AM24
V_{DD}	F28	V_{DD}	AM4	V _{SS}	L31	V _{SS}	AM30
V_{DD}	F34	V_{DD}	AM32	V _{SS}	M4	V _{SS}	AN9
V_{DD}	G1	V_{DD}	AN15	V_{SS}	M32	V _{SS}	AN27
V_{DD}	G35	V_{DD}	AN21	V _{SS}	N5	V _{SS}	AR11
V_{DD}	J5	V_{DD}	AN33	V _{SS}	N31	V _{SS}	AR17
V_{DD}	J31	V_{DD}	AP6	V _{SS}	R1	V _{SS}	AR25
V_{DD}	M2	V_{DD}	AP12	V _{SS}	R35	VSYNC0	D34
V_{DD}	M34	V_{DD}	AP18	V _{SS}	V4	VSYNC1	K32
V_{DD}	N1	V_{DD}	AP24	V _{SS}	V32	W	C23
V_{DD}	N35	V_{DD}	AP30	V _{SS}	W5	XPT0	P34
V_{DD}	R3	V_{DD}	AR7	V _{SS}	W31	XPT1	L35
V_{DD}	R5	V_{DD}	AR19	V _{SS}	AA1	XPT2	Y32



GGP Terminal Assignments – Numerical Listing

1	ΓERMINAL	Т	ERMINAL	Т	ERMINAL	Т	TERMINAL	
NO.	NAME	NO.	NAME	NO.	NAME	NO.	NAME	
A1	No Connect	B1	No Connect	C1	No Connect	D1	A0	
A2	No Connect	B2	No Connect	C2	No Connect	D2	V_{DD}	
А3	No Connect	В3	No Connect	C3	No Connect	D3	STATUS4	
A4	STATUS1	B4	STATUS2	C4	V _{SS}	D4	STATUS3	
A5	AS1	B5	AS2	C5	STATUS0	D5	V_{DD}	
A6	RETRY	B6	READY	C6	FAULT	D6	AS0	
A7	CT1	В7	BS0	C7	BS1	D7	UTIME	
A8	PS0	B8	PS1	C8	PS2	D8	CT0	
A9	V_{DD}	В9	HACK	C9	HREQ	D9	RESET	
A10	V _{SS}	B10	Vss	C10	V _{SS}	D10	REQ1	
A11	V _{SS}	B11	V_{DD}	C11	V_{DD}	D11	REQ0	
A12	V_{DD}	B12	CAS/DQM7	C12	CLKIN	D12	V_{DD}	
A13	No Connect	B13	No Connect	C13	V _{SS}	D13	CAS/DQM6	
A14	No Connect	B14	Vss	C14	CAS/DQM5	D14	V_{DD}	
A15	V_{DD}	B15	CAS/DQM4	C15	CAS/DQM3	D15	CT2	
A16	CAS/DQM2	B16	Vss	C16	CAS/DQM1	D16	V_{DD}	
A17	CAS/DQM0	B17	RL	C17	V _{SS}	D17	V _{SS}	
A18	V _{SS}	B18	RAS	C18	V_{DD}	D18	TRG/CAS	
A19	FCLK1	B19	V_{DD}	C19	W	D19	STATUS5	
A20	V_{DD}	B20	DSF	C20	V _{SS}	D20	DBEN	
A21	V_{DD}	B21	DDIN	C21	CLKOUT	D21	CAREA1	
A22	V _{SS}	B22	SCLK1	C22	V_{DD}	D22	FCLK0	
A23	V _{SS}	B23	SCLK0	C23	V_{DD}	D23	CAREA0	
A24	No Connect	B24	No Connect	C24	No Connect	D24	LINT4	
A25	No Connect	B25	No Connect	C25	No Connect	D25	EINT3	
A26	No Connect	B26	No Connect	C26	No Connect	D26	EINT2	

GGP Terminal Assignments – Numerical Listing (Continued)

	TERMINAL	Т	ERMINAL	TERMINAL		TE	RMINAL
NO.	NAME	NO.	NAME	NO.	NAME	NO.	NAME
E1	A3	J23	HSYNC0	P1	No Connect	V23	D52
E2	A2	J24	TRST	P2	No Connect	V24	V_{SS}
E3	V _{SS}	J25	TCK	P3	V _{SS}	V25	V _{SS}
E4	A1	J26	TMS	P4	V _{SS}	V26	D53
E23	EINT1	K1	A12	P23	V _{SS}	W1	A24
E24	CBLNK1/VBLNK1	K2	V_{DD}	P24	D59	W2	V _{SS}
E25	CBLNK0/VBLNK0	K3	A11	P25	V_{DD}	W3	V_{SS}
E26	V_{SS}	K4	V _{SS}	P26	No Connect	W4	V_{SS}
F1	A4	K23	TDI	R1	V _{SS}	W23	D49
F2	V_{DD}	K24	TDO	R2	A17	W24	D50
F3	V_{DD}	K25	EMU1	R3	A18	W25	D51
F4	V_{DD}	K26	XPT0	R4	Vss	W26	V_{DD}
F23	V _{SS}	L1	V_{DD}	R23	XPT2	Y1	A25
F24	CSYNC1/HBLNK1	L2	A13	R24	D57	Y2	A26
F25	V_{DD}	L3	V _{SS}	R25	V_{DD}	Y3	A27
F26	CSYNC0/HBLNK0	L4	V _{SS}	R26	D58	Y4	V_{DD}
G1	V _{SS}	L23	XPT1	T1	A19	Y23	V_{DD}
G2	V _{SS}	L24	V _{SS}	T2	V_{DD}	Y24	D48
G3	A5	L25	V _{SS}	T3	V_{DD}	Y25	V _{SS}
G4	V_{SS}	L26	EMU0	T4	A20	Y26	V_{SS}
G23	VSYNC1	M1	V_{DD}	T23	V_{DD}	AA1	V_{DD}
G24	VSYNC0	M2	A15	T24	V_{DD}	AA2	V_{DD}
G25	V _{SS}	М3	PS3	T25	D56	AA3	A28
G26	V _{SS}	M4	A14	T26	V _{SS}	AA4	V _{SS}
H1	A8	M23	V_{DD}	U1	V _{SS}	AA23	D45
H2	V_{DD}	M24	D63	U2	V _{SS}	AA24	D46
H3	A7	M25	D62	U3	A21	AA25	D47
H4	A6	M26	D61	U4	V_{DD}	AA26	V_{DD}
H23	HSYNC1	N1	No Connect	U23	V_{DD}	AB1	V _{SS}
H24	V_{DD}	N2	A16	U24	D54	AB2	A29
H25	V_{DD}	N3	V_{DD}	U25	Vss	AB3	A30
H26	V_{DD}	N4	V_{DD}	U26	D55	AB4	V _{SS}
J1	A10	N23	V _{SS}	V1	A22	AB23	V_{DD}
J2	V_{DD}	N24	D60	V2	A23	AB24	D44
J3	A9	N25	No Connect	V3	V_{DD}	AB25	V _{SS}
J4	V _{SS}	N26	No Connect	V4	V_{DD}	AB26	V _{SS}



GGP Terminal Assignments – Numerical Listing (Continued)

TE	TERMINAL TERMINAL		ERMINAL	TE	ERMINAL	TE	TERMINAL		
NO.	NAME	NO.	NAME	NO.	NAME	NO.	NAME		
AC1	A31	AD1	No Connect	AE1	No Connect	AF1	No Connect		
AC2	V_{DD}	AD2	No Connect	AE2	No Connect	AF2	No Connect		
AC3	V_{DD}	AD3	No Connect	AE3	No Connect	AF3	No Connect		
AC4	D0	AD4	V _{SS}	AE4	D1	AF4	D2		
AC5	D3	AD5	V_{DD}	AE5	D4	AF5	V _{SS}		
AC6	V _{SS}	AD6	D5	AE6	D6	AF6	D7		
AC7	V_{DD}	AD7	V_{DD}	AE7	D8	AF7	V _{SS}		
AC8	D9	AD8	D10	AE8	D11	AF8	V_{DD}		
AC9	D12	AD9	V_{SS}	AE9	D13	AF9	D14		
AC10	V_{DD}	AD10	V_{DD}	AE10	D15	AF10	V _{SS}		
AC11	D16	AD11	V _{SS}	AE11	V _{SS}	AF11	D17		
AC12	D18	AD12	D19	AE12	V_{DD}	AF12	V_{DD}		
AC13	D20	AD13	V _{SS}	AE13	V _{SS}	AF13	No Connect		
AC14	V_{DD}	AD14	D21	AE14	No Connect	AF14	No Connect		
AC15	D24	AD15	V_{DD}	AE15	D23	AF15	D22		
AC16	D27	AD16	D26	AE16	D25	AF16	V _{SS}		
AC17	V _{SS}	AD17	V _{SS}	AE17	D28	AF17	V_{DD}		
AC18	D31	AD18	D30	AE18	V_{DD}	AF18	D29		
AC19	V_{DD}	AD19	V_{DD}	AE19	D32	AF19	V _{SS}		
AC20	D35	AD20	D34	AE20	D33	AF20	V _{SS}		
AC21	D37	AD21	V_{SS}	AE21	D36	AF21	V_{DD}		
AC22	D40	AD22	V_{DD}	AE22	D39	AF22	D38		
AC23	D42	AD23	D41	AE23	V _{SS}	AF23	V _{SS}		
AC24	D43	AD24	No Connect	AE24	No Connect	AF24	No Connect		
AC25	V_{DD}	AD25	No Connect	AE25	No Connect	AF25	No Connect		
AC26	V_{DD}	AD26	No Connect	AE26	No Connect	AF26	No Connect		

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GGP Terminal Assignments – Alphabetical Listing

TERMINAL	TERMINAL			TERMIN	IAL	TERMINA	AL.
NAME	NO.	NAME	NO.	NAME	NO.	NAME	NO.
A0	D1	CAS/DQM0	A17	D22	AF15	D61	M26
A1	E4	CAS/DQM1	C16	D23	AE15	D62	M25
A2	E2	CAS/DQM2	A16	D24	AC15	D63	M24
A3	E1	CAS/DQM3	C15	D25	AE16	DBEN	D20
A4	F1	CAS/DQM4	B15	D26	AD16	DDIN	B21
A5	G3	CAS/DQM5	C14	D27	AC16	DSF	B20
A6	H4	CAS/DQM6	D13	D28	AE17	EINT1	E23
A7	НЗ	CAS/DQM7	B12	D29	AF18	EINT2	D26
A8	H1	CBLNK0/VBLNK0	E25	D30	AD18	EINT3	D25
A9	J3	CBLNK1/VBLNK1	E24	D31	AC18	EMU0	L26
A10	J1	CLKIN	C12	D32	AE19	EMU1	K25
A11	K3	CLKOUT	C21	D33	AE20	FAULT	C6
A12	K1	CSYNC0/HBLNK0	F26	D34	AD20	FCLK0	D22
A13	L2	CSYNC1/HBLNK1	F24	D35	AC20	FCLK1	A19
A14	M4	CT0	D8	D36	AE21	HACK	В9
A15	M2	CT1	A7	D37	AC21	HREQ	C9
A16	N2	CT2	D15	D38	AF22	HSYNC0	J23
A17	R2	D0	AC4	D39	AE22	HSYNC1	H23
A18	R3	D1	AE4	D40	AC22	LINT4	D24
A19	T1	D2	AF4	D41	AD23	PS0	A8
A20	T4	D3	AC5	D42	AC23	PS1	B8
A21	U3	D4	AE5	D43	AC24	PS2	C8
A22	V1	D5	AD6	D44	AB24	PS3	МЗ
A23	V2	D6	AE6	D45	AA23	RAS	B18
A24	W1	D7	AF6	D46	AA24	READY	В6
A25	Y1	D8	AE7	D47	AA25	REQ0	D11
A26	Y2	D9	AC8	D48	Y24	REQ1	D10
A27	Y3	D10	AD8	D49	W23	RESET	D9
A28	AA3	D11	AE8	D50	W24	RETRY	A6
A29	AB2	D12	AC9	D51	W25	RL	B17
A30	AB3	D13	AE9	D52	V23	SCLK0	B23
A31	AC1	D14	AF9	D53	V26	SCLK1	B22
AS0	D6	D15	AE10	D54	U24	STATUS0	C5
AS1	A5	D16	AC11	D55	U26	STATUS1	A4
AS2	B5	D17	AF11	D56	T25	STATUS2	B4
BS0	B7	D18	AC12	D57	R24	STATUS3	D4
BS1	C7	D19	AD12	D58	R26	STATUS4	D3
CAREA0	D23	D20	AC13	D59	P24	STATUS5	D19
CAREA1	D21	D21	AD14	D60	N24		



GGP Terminal Assignments – Alphabetical Listing (Continued)

TERMINA	AL	TERMIN	IAL	TERMIN	IAL	TERMINA	AL.
NAME	NO.	NAME	NO.	NAME	NO.	NAME	NO.
TCK	J25	V_{DD}	P25	V _{SS}	A10	V _{SS}	U25
TDI	K23	V_{DD}	R25	V_{SS}	A11	V_{SS}	V24
TDO	K24	V_{DD}	T2	V _{SS}	A18	V _{SS}	V25
TMS	J26	V_{DD}	T3	VSS	A22	V _{SS}	W2
TRG/CAS	D18	V_{DD}	T23	VSS	A23	V _{SS}	W3
TRST	J24	V_{DD}	T24	V _{SS}	B10	V _{SS}	W4
UTIME	D7	V_{DD}	U4	V _{SS}	B14	V _{SS}	Y25
V_{DD}	A9	V_{DD}	U23	VSS	B16	V _{SS}	Y26
$V_{ m DD}$	A12	V_{DD}	V3	VSS	C4	V _{SS}	AA4
$V_{ m DD}$	A15	V_{DD}	V4	VSS	C10	V _{SS}	AB1
$V_{ m DD}$	A20	V_{DD}	W26	VSS	C13	V _{SS}	AB4
$V_{ m DD}$	A21	V_{DD}	Y4	VSS	C17	V _{SS}	AB25
V_{DD}	B11	V_{DD}	Y23	V _{SS}	C20	V _{SS}	AB26
v_{DD}	B19	V _{DD}	AA1	V _{SS}	D17	V _{SS}	AC6
$V_{ m DD}$	C11	V_{DD}	AA2	VSS	E3	V _{SS}	AC17
$V_{ m DD}$	C18	V_{DD}	AA26	VSS	E26	V _{SS}	AD4
V_{DD}	C22	V_{DD}	AB23	VSS	F23	V _{SS}	AD9
V_{DD}	C23	V_{DD}	AC2	VSS	G1	V _{SS}	AD11
V_{DD}	D2	V_{DD}	AC3	VSS	G2	V _{SS}	AD13
v_{DD}	D5	V_{DD}	AC7	V _{SS}	G4	V _{SS}	AD17
V_{DD}	D12	V _{DD}	AC10	VSS	G25	V _{SS}	AD21
V_{DD}	D14	V_{DD}	AC14	VSS	G26	V _{SS}	AE11
V_{DD}	D16	V_{DD}	AC19	VSS	J4	V _{SS}	AE13
V_{DD}	F2	V_{DD}	AC25	VSS	K4	V _{SS}	AE23
V_{DD}	F3	V_{DD}	AC26	VSS	L3	V _{SS}	AF5
v_{DD}	F4	V_{DD}	AD5	V _{SS}	L4	V _{SS}	AF7
V_{DD}	F25	V_{DD}	AD7	V _{SS}	L24	V _{SS}	AF10
V_{DD}	H2	V_{DD}	AD10	V _{SS}	L25	V _{SS}	AF16
V_{DD}	H24	V_{DD}	AD15	V _{SS}	N23	V _{SS}	AF19
V_{DD}	H25	V_{DD}	AD19	VSS	P3	V _{SS}	AF20
V_{DD}	H26	V_{DD}	AD22	VSS	P4	V _{SS}	AF23
V_{DD}	J2	V_{DD}	AE12	VSS	P23	VSYNC0	G24
v_{DD}	K2	V _{DD}	AE18	V _{SS}	R1	VSYNC1	G23
V _{DD}	L1	V _{DD}	AF8	V _{SS}	R4	VV	C19
V _{DD}	M1	V _{DD}	AF12	VSS	T26	XPT0	K26
V _{DD}	M23	V _{DD}	AF17	VSS	U1	XPT1	L23
V _{DD}	N3	V _{DD}	AF21	VSS	U2	XPT2	R23
V_{DD}	N4						



Terminal Functions

TERMINAL	TVDET	DESCRIPTION
NAME	TYPET	LOCAL MEMORY INTERFACE
A31-A0	0	Address bus. A31 – A0 output the 32-bit byte address of the external memory cycle. The address can be multiplexed for DRAM accesses.
AS2-AS0	I	Address-shift selection. AS2 – AS0 determine how the column address appears on the address bus. Eight shift values are supported, including zero.
BS1-BS0	I	Bus-size selection. BS1 – BS0 indicate the bus size of the memory or other device being accessed, allowing dynamic bus sizing for data buses less than 64-bits wide.
CT2-CT0	I	Cycle-timing selection. CT2 – CT0 signals determine the timing of the current memory access.
D63-D0	I/O	Data bus. D63-D0 transfer up to 64 bits of data per memory cycle into or out of the 'C80.
DBEN	0	Data-buffer enable. DBEN drives the active-low output-enables of bi-directional transceivers that can be used to buffer input and output data on D63-D0.
DDIN	0	Data-direction indicator. DDIN indicates the direction of the data that passes through the transceivers. When DDIN is low, the transfer is from external memory into the 'C80.
FAULT	I	Fault. FAULT is driven low by external circuitry to inform the 'C80 that a fault has occurred on the current memory row-access.
PS3-PS0	I	Page-size indication. PS3-PS0 indicate the page size of the memory device(s) being accessed by the current cycle. The 'C80 uses this information to determine when to begin a new row-access.
READY	I	Ready. READY indicates that the external device is ready to complete the memory cycle. READY is driven low by external circuitry to insert wait states into a memory cycle.
RL	0	Row latch. The high-to-low transition of \overline{RL} can be used to latch the valid 32-bit byte address that is present on A31 – A0.
RETRY	I	Retry. RETRY is driven low by external circuitry to indicate that the addressed memory is busy. The 'C80 memory cycle is rescheduled.
STATUS5-STATUS0	0	Status code. At row time, STATUS5 – STATUS0 indicate the type of cycle being performed. At column time, they identify the processor and type of request that initiated the cycle.
UTIME	I	User-timing selection. UTIME causes the timing of RAS and CAS/DQM7-CAS/DQM0 to be modified so that custom memory timings can be generated. During reset, UTIME selects the endian mode in which the 'C80 operates.
		DRAM, VRAM, AND SDRAM CONTROL
CAS/DQM7- CAS/DQM0	0	Column-address strobes. CAS/DQM7-CAS/DQM0 drive the CAS inputs of DRAMs and VRAMs, or the DQM input of SDRAMs. The eight strobes provide byte-write access to memory.
DSF	0	Special function. DSF selects special VRAM functions such as block-write, load color register, split-register transfer, and SGRAM block write.
RAS	0	Row-address strobe. RAS drives the RAS inputs of DRAMs, VRAMs, and SDRAMs.
TRG/CAS	0	Transfer/output enable or column-address strobe. TRG/CAS is used as an output-enable for DRAMs and VRAMs, and also as a transfer-enable for VRAMs. TRG/CAS also drives the CAS inputs of SDRAMs.
\overline{w}	0	Write enable. W is driven low before CAS during write cycles. W controls the direction of the transfer during VRAM transfer cycles.

 $[\]uparrow$ I = input, O = output, Z = high impedance



Terminal Functions (Continued)

TERMINAL NAME	TYPE†	DESCRIPTION
		HOST INTERFACE
HACK	0	Host acknowledge. The 'C80 drives HACK output low following an active HREQ to indicate that it has driven the local-memory-bus signals to the high-impedance state and is relinquishing the bus. HACK is driven high asynchronously following HREQ being detected inactive, and then the 'C80 resumes driving the bus.
HREQ	I	Host request. An external device drives HREQ low to request ownership of the local-memory bus. When HREQ is high, the 'C80 owns and drives the bus. HREQ is synchronized internally to the 'C80's internal clock. Also, HREQ is used at reset to determine the power-up state of the MP. If HREQ is low at the rising edge of RESET, the MP comes up running. If HREQ is high, the MP remains halted until the first interrupt occurrence on EINT3.
REQ1, REQ0	0	Internal cycle request. REQ1 and REQ0 provide a two-bit code indicating the highest-priority memory-cycle request that is being received by the TC. External logic can monitor REQ1 and REQ0 to determine if it is necessary to relinquish the local-memory bus to the 'C80.
		SYSTEM CONTROL
CLKIN	ı	Input clock. CLKIN generates the internal 'C80 clocks to which all processor functions (except the frame timers) are synchronous.
CLKOUT	0	Local output clock. CLKOUT provides a way to synchronize external circuitry to internal timings. All 'C80 output signals (except the VC signals) are synchronous to this clock.
EINT1, EINT2, EINT3	I	Edge-triggered interrupts. EINT1, EINT2 and EINT3 allow external devices to interrupt the master processor (MP) on one of three interrupt levels (EINT1 is the highest priority). The interrupts are rising-edge triggered. EINT3 also serves as an unhalt signal. If the MP is powered-up halted, the first rising edge on EINT3 causes the MP to unhalt and fetch its reset vector (the EINT3 interrupt-pending bit is not set in this case).
LINT4	I	Level-triggered interrupt. LINT4 provides an active-low level-triggered interrupt to the MP. Its priority falls below that of the edge-triggered interrupts. Any interrupt request should remain low until it is recognized by the 'C80.
RESET	I	Reset. RESET is driven low to reset the 'C80 (all processors). During reset, all internal registers are set to their initial state and all outputs are driven to their inactive or high-impedance levels. During the rising edge of RESET, the MP reset mode and the 'C80's operating endian mode are determined by the levels of HREQ and UTIME pins, respectively.
XPT2-XPT0	I	External packet transfer. XPT2 – XPT0 are used by external devices to request a high-priority XPT by the TC.
		EMULATION CONTROL
EMU0, EMU1‡	I/O	Emulation pins. EMU0 and EMU1 are used to support emulation host interrupts, special functions targeted at a single processor, and multiprocessor halt-event communications.
тск‡	I	Test clock. TCK provides the clock for the 'C80 IEEE-1149.1 logic, allowing it to be compatible with other IEEE-1149.1 devices, controllers, and test equipment designed for different clock rates.
TDI [‡]	I	Test data input. TDI provides input data for all IEEE-1149.1 instructions and data scans of the 'C80.
TDO	0	Test data output. TDO provides output data for all IEEE-1149.1 instructions and data scans of the 'C80.
TMS [‡]	I	Test-mode select. TMS controls the IEEE-1149.1 state machine.
TRST§	ı	Test reset. TRST resets the 'C80 IEEE-1149.1 module. When low, all boundary-scan logic is disabled, allowing normal 'C80 operation.

[†] I = input, O = output, Z = high impedance ‡ This pin has an internal pullup and can be left unconnnected during normal operation. § This pin has an internal pulldown and can be left unconnnected during normal operation.

Terminal Functions (Continued)

TERMINAL	-\/+	DESCRIPTION
NAME	TYPET	VIDEO INTERFACE
CAREA0, CAREA1	0	Composite area. CAREA0 and CAREA1 define a special area such as an overscan boundary. This area represents the logical OR of the internal horizontal and vertical area signals.
		Composite blanking/vertical blanking. Each of CBLNK0/VBLNK0 and VBLNK1 provides one of two blanking functions, depending on the configuration of the CSYNC/HBLNK pin:
CBLNK0 / VBLNK0,	0	Composite blanking disables pixel display/capture during both horizontal and vertical retrace periods and is enabled when CSYNC is selected for composite sync video systems.
CBLNK1 / VBLNK1	O	Vertical blanking disables pixel display/capture during vertical retrace periods and is enabled when HBLNK is selected for separate-sync video systems.
		Following reset, CBLNK0 / VBLNK0 and CBLNK1 / VBLNK1 are configured as CBLNK0 and CBLNK1, respectively.
		Composite sync/horizontal blanking. CSYNC0 / HBLNK0 and CSYNC1 / HBLNK1 can be programmed for one of two functions:
CSYNC0 / HBLNK0, CSYNC1 / HBLNK1	I/O/Z	Composite sync is for use on composite-sync video systems and can be programmed as an input, output, or high-impedance signal. As an input, the 'C80 extracts horizontal and vertical sync information from externally generated active-low sync-pulses . As an output, the active-low composite sync pulses are generated from either external HSYNC and VSYNC signals or the 'C80's internal video timers. In the high-impedance state, the pin is neither driven nor allowed to drive circuitry.
		Horizontal blank disables pixel display/capture during horizontal retrace periods in separate-sync video systems and can be used as an output only.
		Immediately following reset, <u>CSYNC0</u> / <u>HBLNK0</u> and <u>CSYNC1</u> / <u>HBLNK1</u> are configured as high-impedance <u>CSYNC0</u> and <u>CSYNC1</u> , respectively.
FCLK0, FCLK1	I	Frame clock. FCLK0 and FCLK1 are derived from the external video system's dotclock and are used to drive the 'C80 video logic for frame timer 0 and frame timer 1.
HSYNCO, HSYNC1	I/O/Z	Horizontal sync. HSYNCO and HSYNC1 control the video system. They can be programmed as input, output, or high impedance signals. As an input, HSYNC synchronizes the video timer to externally generated horizontal sync pulses. As an output, HSYNC is an active-low horizontal sync pulse generated by the 'C80 on-chip frame timer. In the high-impedance state, the pin is not driven, and no internal synchronization is allowed to occur. Immediately following reset, HSYNCO and HSYNC1 are in the high-impedance state.
SCLK0, SCLK1	I	Serial-data clock. SCLK0 and SCLK1 are used by the 'C80 SRT controller to track the VRAM tap point when using midline reload. SCLK0 and SCLK1 should be the same signals that clock the serial register on the VRAMs controlled by frame timer 0 and frame timer 1, respectively.
VSYNC0, VSYNC1	I/O/Z	Vertical sync. VSYNC0 and VSYNC1 control the video system. They can be programmed as inputs, outputs, or high-impedance signals. As inputs, VSYNCx synchronizes the frame timer to externally generated vertical-sync pulses. As outputs, VSYNCx are active-low vertical-sync pulses generated by the 'C80 on-chip frame timer. In the high-impedance state, the pin is not driven and no internal synchronization is allowed to occur. Immediately following reset, VSYNCx is in the high-impedance state.
		POWER
V _{SS} [‡]	1	Ground. Electrical ground inputs
V _{DD} [‡]	I	Power. Nominal 3.3-V power supply inputs
		MISCELLANEOUS
No Connect		No connect serves as an alignment key and must be left unconnected.
FF2-FF1		FF2-FF1 (GF package only) are reserved for factory use and should be left unconnected.
†L – ipput O – output 7 –		

 $^{^{\}dagger}$ I = input, O = output, Z = high-impedance



 $[\]ddagger$ For proper operation, all VDD and VSS pins must be connected externally.

architecture

Figure 1 shows the major components of the 'C80: the master processor (MP), the parallel digital signal processors (PPs), the transfer controller (TC), the video controller (VC), and the IEEE-1149.1 emulation interface. Shared access to on-chip RAM is achieved through the crossbar. Crossbar connections are represented by O. Each PP can perform three accesses per cycle through its local (L), global (G), and instruction (I) ports. The MP can access two RAMs per cycle through its crossbar/data (C/D) and instruction (I) ports, and the TC can access one RAM through its crossbar interface. Up to 15 simultaneous accesses are supported in each cycle. Addresses can be changed every cycle, allowing the crossbar matrix to be changed on a cycle-by-cycle basis. Contention between processors for the same RAM in the same cycle is resolved by a round-robin priority scheme. In addition to the crossbar, a 32-bit datapath exists between the MP and the TC and VC. This allows the MP to access TC and VC on-chip registers that are memory mapped into the MP memory space.

The 'C80 has a 4G-byte address space as shown in Figure 2. The lower 32M bytes are used to address internal RAM and memory-mapped registers.

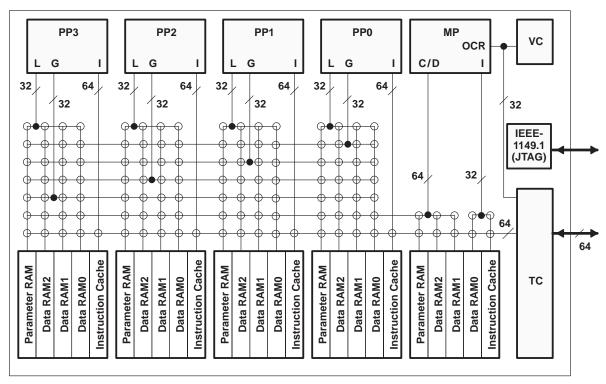


Figure 1. Block Diagram Showing Datapaths

architecture (continued)

PPO Data RAM0		700000000
PP0 Data RAM1 (2K Bytes) PP1 Data RAM0 (2K Bytes) PP1 Data RAM0 (2K Bytes) PP1 Data RAM1 (2K Bytes) PP2 Data RAM1 (2K Bytes) PP2 Data RAM0 (2K Bytes) PP2 Data RAM1 (2K Bytes) PP2 Data RAM1 (2K Bytes) PP3 Data RAM0 (2K Bytes) PP3 Data RAM0 (2K Bytes) PP3 Data RAM1 (2K Bytes) PP3 Data RAM1 (2K Bytes) PP3 Data RAM1 (2K Bytes) Reserved (16K Bytes) PP0 Data RAM2 (2K Bytes) Reserved (2K Bytes) PP1 Data RAM2 (2K Bytes) PP1 Data RAM2 (2K Bytes) Reserved (2K Bytes) PP1 Data RAM2 (2K Bytes) PP1 Data RAM2 (2K Bytes) PP1 Data RAM2 (2K Bytes) Reserved (2K Bytes) PP2 Data RAM2 (2K Bytes) Reserved (2K Bytes) PP3 Data RAM2 (2K Bytes) Reserved (2K Bytes) PP4 Data RAM2 (2K Bytes) Reserved (2K Bytes) PP4 Data RAM2 (2K Bytes) Reserved (2K Bytes) Reserved (2K Bytes) PP3 Data RAM2 (2K Bytes) PP3 Data RAM2 (2K Bytes) Reserved (2K Bytes) Reserved (2K Bytes) PP4 Parameter RAM (2K Bytes) PP5 Parameter RAM (2K Bytes) Reserved (2K Bytes) Res	PP0 Data RAM0	0x00000000
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PP1 Data RAM0 (2K Bytes) PP1 Data RAM1 (2K Bytes) PP2 Data RAM0 (2K Bytes) PP2 Data RAM0 (2K Bytes) PP2 Data RAM1 (2K Bytes) PP3 Data RAM1 (2K Bytes) PP3 Data RAM0 (2K Bytes) PP3 Data RAM0 (2K Bytes) PP3 Data RAM1 (2K Bytes) Reserved (16K Bytes) PP0 Data RAM2 (2K Bytes) PP1 Data RAM2 (2K Bytes) PP2 Data RAM2 (2K Bytes) PP3 Data RAM2 (2K Bytes) PP4 Data RAM2 (2K Bytes) PP5 Data RAM2 (2K Bytes) PP6 Data RAM2 (2K Bytes) PP7 Data RAM2 (2K Bytes) PP8 Data RAM2 (2K Bytes) PP9 Data RAM2 (2K Bytes) PP1 Data RAM2 (2K Bytes) PP2 Data RAM2 (2K Bytes) PP3 Parameter RAM (2K Bytes) PP4 Parameter RAM (2K Bytes) PP5 Parameter RAM (2K Bytes) PP7 Parameter RAM (2K Bytes) PP8 Parameter RAM (2K Bytes) PP9 Parameter RAM (2K Bytes) PP3 Parameter RAM (2K Bytes) PN5 Parameter RAM (2K Bytes)	PP0 Data RAM1	0x00000800
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(2K Bytes) PP3 Data RAM2 (2K Bytes) Reserved (16730112 Bytes) PP0 Parameter RAM (2K Bytes) Reserved (2K Bytes) Ox0000B7FF Ox0000B800 0x000FFFFFF Ox01000000 0x010007FF Ox01000800 (2K Bytes) PP1 Parameter RAM (2K Bytes) PP1 Parameter RAM (2K Bytes) Reserved (2K Bytes) Ox010017FF Ox010017FF Ox01001800 (2K Bytes) PP2 Parameter RAM (2K Bytes) PP3 Parameter RAM (2K Bytes) Reserved (2K Bytes) Ox010027FF Ox01002800 (2K Bytes) PP3 Parameter RAM (2K Bytes) Ox01002FFF Ox01003000	` , ,	-
PP3 Data RAM2 (2K Bytes) Reserved (16730112 Bytes) PP0 Parameter RAM (2K Bytes) Reserved (2K Bytes) PP1 Parameter RAM (2K Bytes) PP1 Parameter RAM (2K Bytes) PP2 Parameter RAM (2K Bytes) Reserved (2K Bytes) PP3 Parameter RAM (2K Bytes) PP4 Parameter RAM (2K Bytes) Reserved (2K Bytes) PP5 Parameter RAM (2K Bytes) PP7 Parameter RAM (2K Bytes) PP8 Parameter RAM (2K Bytes) Reserved (2K Bytes) PP9 Parameter RAM (2K Bytes) Reserved (2K Bytes) PP3 Parameter RAM (2K Bytes) PP3 Parameter RAM (2K Bytes) PP3 Parameter RAM (2K Bytes)		
(2K Bytes) Reserved (16730112 Bytes) PP0 Parameter RAM (2K Bytes) Reserved (2K Bytes) PP1 Parameter RAM (2K Bytes) PP1 Parameter RAM (2K Bytes) PP2 Parameter RAM (2K Bytes) Reserved (2K Bytes) PP2 Parameter RAM (2K Bytes) PP3 Parameter RAM (2K Bytes) PP4 Parameter RAM (2K Bytes) PP5 PARAMETER RAM (2K Bytes) Reserved (2K Bytes) Reserved (2K Bytes) PP3 Parameter RAM (2K Bytes)	`	4
Reserved		0x0000B000
Neserved	(2K Bytes)	0x0000B7FF
(16730112 Bytes) PP0 Parameter RAM (2K Bytes) Reserved (2K Bytes) PP1 Parameter RAM (2K Bytes) Ox01000FFF Ox01000800 Ox01000FFF Ox01001000 Ox010017FF Ox010017FF Ox010017FF Ox01001800 Ox01001FF Ox01001FF Ox010027FF Ox010027FF Ox01002FFF Ox01002FFF Ox01002FFF Ox01002FFF Ox01002FFF Ox01002FFF Ox01002FFF Ox01002FFF Ox01003000	Reserved	0x0000B800
Ox00FFFFF Ox01000000		
(2K Bytes) 0x010007FF Reserved 0x01000800 (2K Bytes) 0x01000FFF PP1 Parameter RAM 0x01001000 (2K Bytes) 0x010017FF Reserved 0x01001800 (2K Bytes) 0x01001FFF PP2 Parameter RAM 0x01002000 (2K Bytes) 0x010027FF Reserved 0x01002800 (2K Bytes) 0x01002FFF PP3 Parameter RAM 0x01003000		0x00FFFFFF
Reserved (2K Bytes) 0x01000800 (2K Bytes) 0x01000FFF 0x01001000 (2K Bytes) 0x010017FF 0x01001800 (2K Bytes) 0x01001FFF 0x01001FFF 0x01002000 (2K Bytes) 0x010027FF 0x01002800 (2K Bytes) 0x01002FF 0x01002800 (2K Bytes) 0x01002FFF 0x01003000		0x01000000
(2K Bytes)	(2K Bytes)	0x010007FF
PP1 Parameter RAM (2K Bytes) 0x01001000 (2K Bytes) 0x010017FF 0x01001800 (2K Bytes) 0x01001FFF 0x01002000 (2K Bytes) 0x010027FF 0x01002800 (2K Bytes) 0x01002FFF 0x01002FFF 0x01002FFF 0x01003000		0x01000800
(2K Bytes)	(2K Bytes)	0x01000FFF
Reserved (2K Bytes) 0x01001800 (2K Bytes) 0x01001FFF 0x01002000 (2K Bytes) 0x010027FF 0x01002800 (2K Bytes) 0x01002FFF 0x01003000	PP1 Parameter RAM	0x01001000
Reserved	(2K Bytes)	0x010017FF
(2K Bytes)	Reserved	
PP2 Parameter RAM (2K Bytes) 0x01002000 (2K Bytes) 0x010027FF Reserved 0x01002800 (2K Bytes) 0x01002FFF PP3 Parameter RAM 0x01003000		
(2K Bytes) 0x010027FF Reserved 0x01002800 (2K Bytes) 0x01002FFF PP3 Parameter RAM 0x01003000	` , ,	4
Reserved 0x01002800 (2K Bytes) 0x01002FFF PP3 Parameter RAM 0x01003000		1
(2K Bytes) 0x01002FFF PP3 Parameter RAM 0x01003000	`	1
PP3 Parameter RAM 0x01003000		1
(2K Butes)	` , ,	
(2K Bytes) 0x010037FF		0x01003000
	(2K Bytes)	0x010037FF

	7 0x01003800
Reserved	TOXO TOUGOUG
(51 200 Bytes)	
(0.200 Bytes)	0×04005555
MD Devementor DAM	0x0100FFFF 0x01010000
MP Parameter RAM (2K Bytes)	
(ZK Bytes)	0x010107FF
Decembed	0x01010800
Reserved	
(8327168 Bytes)	
PROL 1 1 O I	0x018017FF
PP0 Instruction Cache	0x01801800
(2K Bytes)	0x01801FFF
Reserved	0x01802000
(6K Bytes)	0x018037FF
PP1 Instruction Cache	0x01803800
(2K Bytes)	0x01803FFF
Reserved	0x01804000
(6K Bytes)	0x018057FF
PP2 Instruction Cache	0x01805800
(2K Bytes)	0x01805FFF
Reserved	0x01806000
(6K Bytes)	
` ' '	0x018077FF
PP3 Instruction Cache	0x01807800
(2K Bytes)	0x01807FFF
Reserved	0x01808000
(32K Bytes)	0x0180FFFF
MP Data Cache	0x01810000
(4K Bytes)	0x01810FFF
Reserved	0x01811000
(28K Bytes)	
(2011 2)100)	0x01817FFF
MP Instruction Cache	0x01818000
(4K Bytes)	0x01818FFF
Reserved	0x01819000
(28K Bytes)	
` '	0x0181FFFF
Memory-Mapped TC Registers	0x01820000
(512 Bytes)	0x018201FF
Memory-Mapped VC Registers	0x01820200
(512 Bytes)	0x018203FF
Reserved	0x01820400
(8327168 Bytes)	
(11 11 11 11 11 11 11 11 11 11 11 11 11	0x01FFFFF
	0x02000000
External Memory	
(4064M Bytes)	
1	1
1	0
	」 0xFFFFFFF

Figure 2. Memory Map



master processor (MP) architecture

The master processor (MP) is a 32-bit RISC processor with an integral IEEE-754 floating-point unit. The MP is designed for effective execution of C code and is capable of performing at well over 130K dhrystones/s. Major tasks which the MP typically performs are:

- Task control and user interface
- Information processing and analysis
- IEEE-754 floating point (including graphics transforms)

MP functional block diagram

Figure 3 shows a block diagram of the master processor. Key features of the MP include:

- 32-bit RISC processor
 - Load/store architecture
 - Three operand arithmetic and logical instructions
- 4K-byte instruction cache and 4K-byte data cache
 - Four-way set associative
 - LRU replacement
 - Data writeback
- 2K-byte non-cached parameter RAM
- Thirty-one 32-bit general-purpose registers
- Register and accumulator scoreboard
- 15-bit or 32-bit immediate constants
- 32-bit byte addressing
- Scalable timer
- Leftmost-one and rightmost-one logic
- IEEE-754 floating-point hardware
 - Four double-precision floating-point vector accumulators
 - Vector floating-point instructions
 Floating-point operation and parallel load or store
 Multiply and accumulate
- High performance
 - 60 million instructions per second (MIPS)
 - 120 million floating-point operations per second (MFLOPS)
 - Over 130K dhrystones/s



MP functional block diagram (continued)

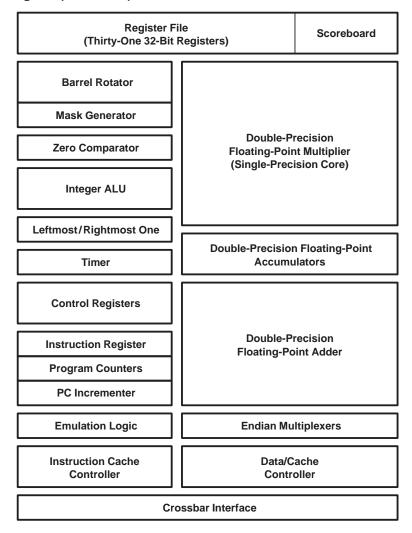


Figure 3. MP Block Diagram

MP general-purpose registers

The MP contains 31 32-bit general-purpose registers, R1-R31. Register R0 always reads as zero and writes to it are discarded. Double precision values are always stored in an even-odd register pair with the higher numbered register always holding the sign bit and exponent. The R0/R1 pair is not available for this use. A scoreboard keeps track of which registers are awaiting loads or the result of a previous instruction and stalls the instruction pipeline until the register contains valid data. As a recommended software convention, typically R1 is used as a stack pointer and R31 as a return-address link register.

Figure 4 shows the MP general-purpose registers.



MP general-purpose registers (continued)

Zero/Discard
R1
R2
R3
R4
R5
•••
R30
R31

Not Available
R2, R3
R4, R5
•••
R30, R31

32-Bit Registers

64-Bit Register Pairs

Figure 4. MP General-Purpose Registers

The 32-bit registers can contain signed-integer, unsigned-integer, or single precision floating-point values. Signed and unsigned bytes and halfwords are sign extended or zero-filled. Doublewords may be stored in a 64-bit even/odd register pair. Double-precision floating-point values are referenced using the even register number or the register pair. Figure 5 through Figure 7 show the register data formats.

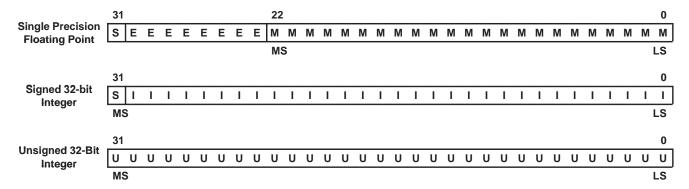
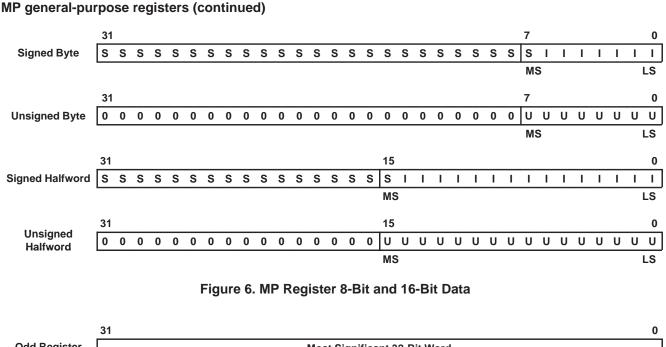


Figure 5. MP Register 32-Bit Data Formats



Odd Register Most Significant 32-Bit Word MS 31 0 **Even Register** Least Significant 32-Bit Word LS 19 0 **Double-Precision** Floating-Point S Ε Ε Ε Ε Ε Ε EEE Ε Ε M M M M M M M M M M M M M M M M M **Odd Register** MS 0 **Double-Precision** Floating-Point M M M M M M M M **Even Register**

Figure 7. MP Register 64-Bit Data

MP double-precision floating-point accumulators

There are four double-precision floating-point registers (see Figure 8) to accumulate intermediate floating-point results.

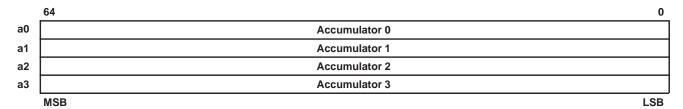


Figure 8. Double-Precision Floating-Point Accumulators



MP control registers

In addition to the general-purpose registers, there are a number of control registers that are used to represent the state of the processor. Table 1 shows the control register numbers of the accessible registers.

Table 1. Control Register Numbers

NO.	NAME	DESCRIPTION	NO.	NAME	DESCRIPTION				
0x0000	EPC	Exception Program Counter	0x0015-0x001F	_	Reserved				
0x0001	EIP	Exception Instruction Pointer	0x0020	SYSSTK	System Stack Pointer				
0x0002	CONFIG	Configuration	0x0021	SYSTMP	System Temporary Register				
0x0003	_	Reserved	0x0022-0x002F	_	Reserved				
0x0004	INTPEN	Interrupt Pending	0x0030	MPC	Emulator Exception Program Cntr				
0x0005	_	Reserved	0x0031	MIP	Emulator Exception Instruction Ptr				
0x0006	ΙE	Interrupt Enable	0x0032	_	Reserved				
0x0007	_	Reserved	0x0033	ECOMCNTL	Emulator Communication Control				
0x0008	FPST	Floating-Point Status	0x0034	ANASTAT	Emulation Analysis Status Reg				
0x0009	_	Reserved	0x0035-0x0038	_	Reserved				
0x000A	PPERROR	PP Error Indicators	0x0039	BRK1	Emulation Breakpoint 1 Reg.				
0x000B	_	Reserved	0x003A	BRK2	Emulation Breakpoint 2 Reg.				
0x000C	_	Reserved	0x003B-0x01FF	_	Reserved				
0x000D	PKTREQ	Packet Request Register	0x0200 - 0x020F	ITAG0-15	Instruction Cache Tags 0 to 15				
0x000E	TCOUNT	Current Counter Value	0x0300	ILRU	Instruction Cache LRU Register				
0x000F	TSCALE	Counter Reload Value	0x0400-0x040F	DTAG0-15	Data Cache Tags 0 to 15				
0x0010	FLTOP	Faulting Operation	0x0500	DLRU	Data Cache LRU Register				
0x0011	FLTADR	Faulting Address	0x4000	IN0P	Vector Load Pointer 0				
0x0012	FLTTAG	Faulting Tag	0x4001	IN1P	Vector Load Pointer 1				
0x0013	FLTDTL	Faulting Data (low)	0x4002	OUTP	Vector Store Pointer				
0x0014	FLTDTH	Faulting Date (high)							

MP pipeline registers

The MP uses a three-stage fetch, execute, access (FEA) pipeline. The primary pipeline registers are manipulated implicitly by branch and trap instructions and are not accessible by the user. The exception and emulation pipeline registers are user accessible as control registers. All pipeline registers are 32 bits.

		Program Execution Mode	
	Normal	Exception	Emulation
Program Counter	PC	EPC	MPC
Instruction Pointer	IP	EIP	MIP
Instruction Register	IR		

- Instruction register (IR) contains the instruction being executed.
- Instruction pointer (IP) points to the instruction being executed.
- Program counter (PC) points to the instruction being fetched.
- Exception/emulator instruction pointer (EIP/MIP) points to the instruction that would have been executed had the exception / emulation trap not occurred.
- Exception/emulator program counter (EPC/MPC) points to the instruction to be fetched on returning from the exception/emulation trap.

Figure 9. MP FEA Pipeline Registers



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configuration (CONFIG) register (0x0002)

The CONFIG register controls or reflects the state of certain options as shown in Figure 10.

31	30	0 2	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
E	F	₹ .	Т	Н	х					Re	serv	/ed						Ту	ре			Rese	rve	d	Π	Rele	ease			Rese	rvec	t

- E Endian mode; 0 = big-endian, 1 = little-endian, read only
- R PPData RAM round robin; 0 = fixed, 1 = variable, read/write
- T TC PT round robin; 0 = variable, 1 = fixed, read/write.
- H High priority MP events; 0 = disabled, 1 = enabled, read/write
- X Externally initiated packet transfers; 0 = disabled, 1 = enabled, read/write
- Type Number of PPs in device, read only

Release TMS320C80 version number

Figure 10. CONFIG Register

interrupt-enable (IE) register (0x0006)

The IE register contains enable bits for each of the interrupts/traps as shown in Figure 11. The global-interrupt-enable (ie) bit and the appropriate individual interrupt-enable bit must be set in order for an interrupt to occur.

31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
ре	х4	х3	bp	pb	рс	mi						рЗ	p2	p1	p0	io	mf		х2	х1	ti	f1	f0	fx	fu	fo		fz	fi		ie
	pe PP error p2 x4 External interrupt 4 (LINT4) p1								٠.				_	inte					f1 f0												
	x4 x3					ipt 4 ipt 3	`-						pı 0a				_	inte inte					fx			g-po					
	bp					nsfe	•	,					io			r ov	_						fu			g-po				w	
	pb	Pag	cket	tran	sfer	bus	sy						mf	Me	emo	ry fa	ult						fo	Flo	atin	g-po	oint	over	flow	,	
	рс	Pad	cket	tran	sfer	con	nple	te					x2	Ex	terr	ıal ir	nterr	upt	2 (Ē	NT2	2)		fz	Flo	atin	g-po	oint	divid	de-b	y-ze	ro
	mi	Me	ssag	ge (N	/IP s	elf) i	inter	rrup	t				x1	Ex	terr	ıal ir	nterr	upt	1 (Ē	NT1)		fi	Flo	atin	g-po	oint	inva	lid		
	рЗ	PP	3 me	ssa	ge i	inter	rup	t					ti	MI	P tin	ner i	nter	rupt	·				ie	Glo	obal	-inte	rrup	t en	able	•	

Figure 11. IE Register

interrupt-pending (INTPEN) register (0x0004)

The bits in INTPEN register show the current state of each interrupt/trap. Pending interrupts do not occur unless the ie bit and corresponding interrupt-enable bit are set. Software must write a 1 to the appropriate INTPEN bit to clear an interrupt. Figure 12 shows the INTPEN register locations.



Figure 12. INTPEN Register

floating-point status register (FPST) (0x0008)

FPST contains status and control information for the FPU as shown in Figure 13. Bits 17–21 are read/write floating-point unit (FPU) control bits. Bits 22–26 are read/write accumulated status bits. All other bits show the status of the last FPU instruction to complete and are read only.

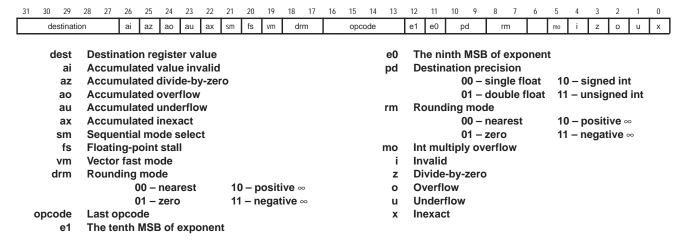


Figure 13. FPSTS Register

PP error register (PPERROR) (0x000A)

The bits in the PPERROR register reflect parallel processor errors (see Figure 14). The MP can use these when a PP error interrupt occurs to determine the cause of the error.

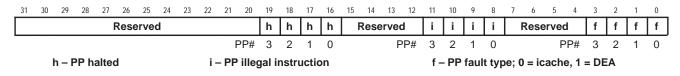


Figure 14. PPERROR Register

packet-transfer request register (PKTREQ) (0x000D)

PKTREQ controls the submission and priority of packet-transfer requests as shown in Figure 15. It also indicates that a packet transfer is currently active.

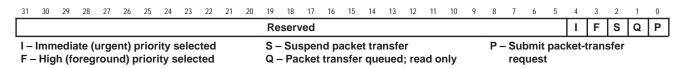


Figure 15. PKTREQ Register

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memory-fault registers

The five read-only memory-fault registers contain information about memory address exceptions, as shown in Figure 16.

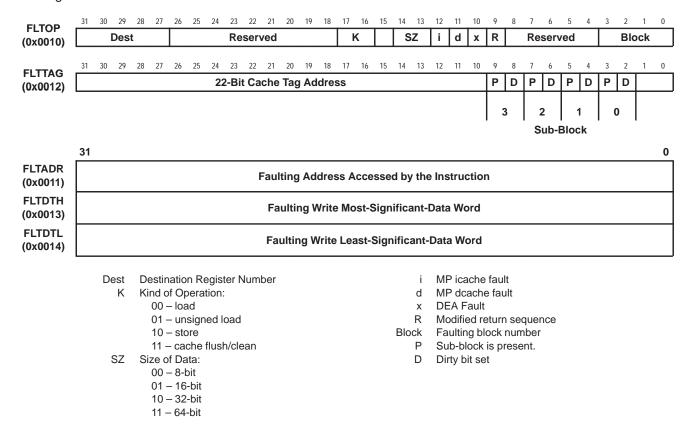


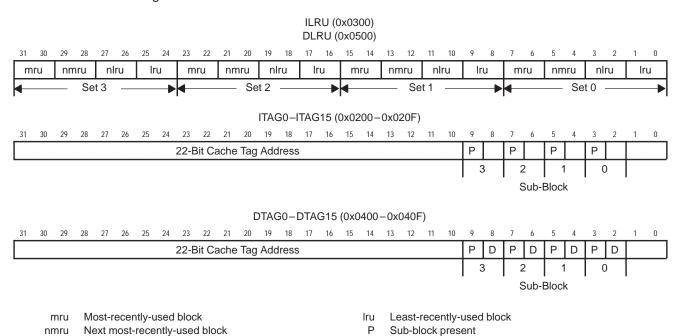
Figure 16. Memory-Fault Registers

MP cache registers

nlru

Next least-recently-used block

The ILRU and DLRU registers track least-recently-used (LRU) information for the sixteen instruction-cache and sixteen data-cache blocks. The ITAGxx registers contain block addresses and the present flags for each sub-block. DTAGxx registers are identical to ITAGxx registers but include dirty bits for each sub-block. Figure 17 shows the cache registers.



mru, nmru, nlru, and lru have the value 0, 1, 2, or 3 representing the block number and are mutually exclusive for each set.

Figure 17. Cache Registers

D

Sub-block dirty

MP cache architecture

The MP contains two four-way set-associative, 4K caches for instructions and data. Each cache is divided into four sets with four blocks in each set. Each block represents 256 bytes of contiguous instructions or data and is aligned to a 256-byte address boundary. Each block is partitioned into four sub-blocks that each contain sixteen 32-bit words and are aligned to 64-byte boundaries within the block. Cache misses cause one sub-block to be loaded into cache. Figure 18 shows the cache architecture for one of the four sets in each cache. Figure 19 shows how addresses map into the cache using the cache tags and address bits.

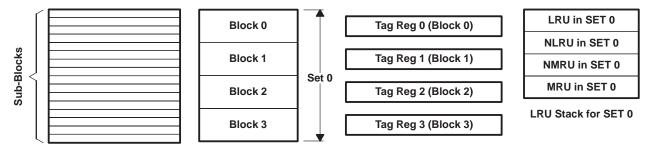


Figure 18. MP Cache Architecture (x4 Sets)

32-Bit Logical Address 17 16 15 14 21 Т S S W W W В Т Т Т Т Т On-Chip MP 2K Cache RAMS Bank 0 Bank 1 Set 0 Set 2 Set 1 Set 3 11 10 9 8 7 6 5 4 3 2 1 0 S S A A S S W W W W B B Address in On-Chip Cache Bank T - Tag Address Bits s - Sub-Block (within block) Select (0-3) B - Byte (within word) Select (0-3) S - Set Select Bits (0-3) W - Word (within sub-block) Select (0-15) A - Block Select (which tag matched) (0-3)

Figure 19. MP Cache Addressing

MP parameter RAM

The parameter RAM is a noncachable, 2K-byte, on-chip RAM which contains MP-interrupt vectors, MP-requested TC task buffers, and a general-purpose area. Figure 20 shows the parameter RAM address map.

0x01010000-0x0101007F	Suspended PT Parameters (128 Bytes)		XPT7/SOF0 Linked List Start Add. XPT6/SAM0 Linked List Start Add.	0x010100E0 0x010100E4
0x01010080-0x010100DF	Reserved (96 Bytes)		XPT5/SOF1 Linked List Start Add.	0x010100E4 0x010100E8
	XPT Linked List Start Addresses	ľ	XPT4/SAM1 Linked List Start Add.	0x010100EC
0x010100E0-0x010100FB	(28 Bytes)		XPT3 Linked List Start Add.	0x010100F0
	MP Linked List Start Address		XPT2 Linked List Start Add.	0x010100F4
0x010100FC-0x010100FF			XPT1 Linked List Start Add.	0x010100F8
0x01010100-0x0101017F	Off-Chip to Off-Chip PT Buffer (128 Bytes)			•
0x01010180-0x0101021F	Interrupt and Trap Vectors (160 Bytes)			
0x01010220-0x0101029F	XPT Off-Chip to Off-Chip PT Buffer (128 Bytes)			
0x010102A0-0x010107FF	General-Purpose RAM (1376 Bytes)			

Figure 20. MP Parameter RAM

MP interrupt vectors

Table 2 and Table 3 show the MP interrupts and traps and their vector addresses.

Table 2. Maskable Interrupts

IE BIT (TRAP#)	NAME	VECTOR ADDRESS	MASKABLE INTERRUPT
0	ie	0x01010180	
2	fi	0x01010188	Floating-point invalid
3	fz	0x0101018C	Floating-point divide-by-zero
5	fo	0x01010194	Floating-point overflow
6	fu	0x01010198	Floating-point underflow
7	fx	0x0101019C	Floating-point inexact
8	f0	0x010101A0	Frame timer 0
9	f1	0x010101A4	Frame timer 1
10	ti	0x010101A8	MP timer
11	x1	0x010101AC	External interrupt 1 (EINT1)
12	x2	0x010101B0	External interrupt 2 (EINT2)
14	mf	0x010101B8	Memory fault
15	io	0x010101BC	Integer overflow
16	p0	0x010101C0	PP0 message
17	p1	0x010101C4	PP1 message
18	p2	0x010101C8	PP2 message
19	р3	0x010101CC	PP3 message
25	mi	0x010101E4	MP message
26	рс	0x010101E8	Packet transfer complete
27	pb	0x010101EC	Packet transfer busy
28	bp	0x010101F0	Bad packet transfer
29	х3	0x010101F4	External interrupt 3 (EINT3)
30	x4	0x010101F8	External interrupt 4 (LINT4)
31	ре	0x010101FC	PP error

Table 3. Nonmaskable Traps

TRAP NO.	NAME	VECTOR ADDRESS	NONMASKABLE TRAP
32	e1	0x01010200	Emulator trap1 (reserved)
33	e2	0x01010204	Emulator trap2 (reserved)
34	e3	0x01010208	Emulator trap3 (reserved)
35	e4	0x0101020C	Emulator trap4 (reserved)
36	fe	0x01010210	Floating-point error
37		0x01010214	Reserved
38	er	0x01010218	Illegal MP instruction
39		0x0101021C	Reserved
72 to 415		0x010102A0 to 0x010107FC	System or user defined



MP opcode formats

The three basic classes of MP instruction opcodes are; short immediate, three register, and long immediate. Figure 21 shows the opcode structure for each class of instruction.

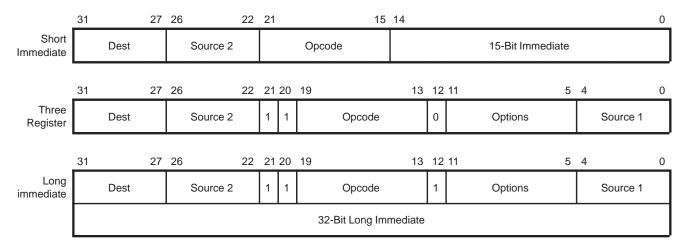


Figure 21. MP Opcode Formats

MP opcode summary

Table 4 through Table 6 show the opcode formats for the MP. Table 7 summarizes the master processor instruction set.

Table 4. Short-Immediate Opcodes

	31 30 29 28 27	26 25 24 23 22	21	20	19	18	17	16	15	14	13	12	11	10	9 8 7 6 5	4 3 2 1 0
illop0	Dest	Source	0	0	0	0	0	0	0						Unsigned Immediate	
trap	E		0	0	0	0	0	0	1	Г				U	nsigned Trap Numbe	er
cmnd			0	0	0	0	0	1	0						Unsigned Immediate	
rdcr	Dest		0	0	0	0	1	0	0				Uns	sign	ed Control Register N	lumber
swcr	Dest	Source	0	0	0	0	1	0	1				Uns	sign	ed Control Register N	lumber
brcr			0	0	0	0	1	1	0				Uns	sign	ed Control Register N	lumber
shift.dz	Dest	Source	0	0	0	1	0	0	0	-	_	_	i	n	Endmask	Rotate
shift.dm	Dest	Source	0	0	0	1	0	0	1	-	-	-	i	n	Endmask	Rotate
shift.ds	Dest	Source	0	0	0	1	0	1	0	-	-	-	i	n	Endmask	Rotate
shift.ez	Dest	Source	0	0	0	1	0	1	1	-	-	-	i	n	Endmask	Rotate
shift.em	Dest	Source	0	0	0	1	1	0	0	-	-	-	i	n	Endmask	Rotate
shift.es	Dest	Source	0	0	0	1	1	0	1	-	-	-	i	n	Endmask	Rotate
shift.iz	Dest	Source	0	0	0	1	1	1	0	-	-	-	i	n	Endmask	Rotate
shift.im	Dest	Source	0	0	0	1	1	1	1	_	_	_	i	n	Endmask	Rotate
and.tt	Dest	Source2	0	0	1	0	0	0	1						Unsigned Immediate	
and.tf	Dest	Source2	0	0	1	0	0	1	0						Unsigned Immediate	
and.ft	Dest	Source2	0	0	1	0	1	0	0						Unsigned Immediate	
xor	Dest	Source2	0	0	1	0	1	1	0						Unsigned Immediate	
or.tt	Dest	Source2	0	0	1	0	1	1	1						Unsigned Immediate	
and.ff	Dest	Source2	0	0	1	1	0	0	0						Unsigned Immediate	
xnor	Dest	Source2	0	0	1	1	0	0	1						Unsigned Immediate	
or.tf	Dest	Source2	0	0	1	1	0	1	1						Unsigned Immediate	
or.ft	Dest	Source2	0	0	1	1	1	0	1						Unsigned Immediate	
or.ff	Dest	Source2	0	0	1	1	1	1	0						Unsigned Immediate	
ld	Dest	Base	0	1	0	0	М	s	Z						Signed Offset	
ld.u	Dest	Base	0	1	0	1	М	s	Z						Signed Offset	
st	Source	Base	0	1	1	0	М	s	Z						Signed Offset	
dcache	F	Source2	0	1	1	1	М	0	0						Signed Offset	
bsr	Link		1	0	0	0	0	0	Α						Signed Offset	
jsr	Link	Base	1	0	0	0	1	0	Α						Signed Offset	
bbz	BITNUM	Source	1	0	0	1	0	0	Α						Signed Offset	
bbo	BITNUM	Source	1	0	0	1	0	1	Α						Signed Offset	
bcnd	Cond	Source	1	0	0	1	1	0	Α	Signed Offset						
cmp	Dest	Source2	1	0	1	0	0	0	0						Signed Immediate	
add	Dest	Source2	1	0	1	1	0	0	U							
sub	Dest	Source2	1	0	1	1	0	1	U						Signed Immediate	

Reserved bit (code as 0)

M Modify, write modified address back to register

n Rotate sense for shifting

SZ Size (0 = byte, 1 = halfword, 2 = word, 3 = doubleword)

U Unsigned form



A Annul delay slot instruction if branch taken

E Emulation trap bit

F Clear present flags

i Invert endmask

MP opcode summary (continued)

Table 5. Long-Immediate and Three-Register Opcodes

	31 30 29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4 3 2 1 0
trap		_	Е	_	-	_	_	-	1	1	0	0	0	0	0	0	1	ı	_	_	_	_	_	_	_	IND TR
cmnd		-	-	_	_	_	_	_	1	1	0	0	0	0	0	1	0	Ι	_	_	_	_	_	_	_	Source1
rdcr	Des	st		_	-	-	_	_	1	1	0	0	0	0	1	0	0	1	-	_	_	_	_	_	_	IND CR
swcr	Des	st			Sc	urc	е		1	1	0	0	0	0	1	0	1	ı	_	_	_	_	_	_	_	IND CR
brcr		_	-	-	_	_	_	-	1	1	0	0	0	0	1	1	0	Ι	_	_	_	_	_	-	_	IND CR
shift.dz	Des	st			Sc	ourc	е		1	1	0	0	0	1	0	0	0	0	i	n		En	dma	ısk		Rotate
shift.dm	Des	st			Sc	ourc	е		1	1	0	0	0	1	0	0	1	0	i	n		En	dma	ısk		Rotate
shift.ds	Des	st			Sc	ourc	е		1	1	0	0	0	1	0	1	0	0	i	n		En	dma	ısk		Rotate
shift.ez	Des	st			Sc	ourc	е		1	1	0	0	0	1	0	1	1	0	i	n		En	dma	ısk		Rotate
shift.em	Des	st			Sc	ourc	е		1	1	0	0	0	1	1	0	0	0	i	n		En	dma	sk		Rotate
shift.es	Des	st			Sc	urc	е		1	1	0	0	0	1	1	0	1	0	i	n		En	dma	ısk		Rotate
shift.iz	Des	st			Sc	urc	е		1	1	0	0	0	1	1	1	0	0	i	n		En	dma	ısk		Rotate
shift.im	Des	st			Sc	urc	е		1	1	0	0	0	1	1	1	1	0	i	n		En	dma	sk		Rotate
and.tt	Des	st			So	urce	2		1	1	0	0	1	0	0	0	1	ı	-	-	-	-	-	-	-	Source1
and.tf	Des	st			So	urce	2		1	1	0	0	1	0	0	1	0	1	-	-	-	-	-	-	-	Source1
and.ft	Des	st			So	urce	2		1	1	0	0	1	0	1	0	0		-	_	-	_	-	_	-	Source1
xor	Des	st			So	urce	2		1	1	0	0	1	0	1	1	0		-	_	-	_	-	_	-	Source1
or.tt	Des	st			So	urce	2		1	1	0	0	1	0	1	1	1	1	-	_	-	_	-	_	-	Source1
and.ff	Des	st			So	urce	2		1	1	0	0	1	1	0	0	0	1	-	_	-	_	-	_	-	Source1
xnor	Des	st			So	urce	2		1	1	0	0	1	1	0	0	1	1	-	_	-	_	-	_	-	Source1
or.tf	Des	st			So	urce	2		1	1	0	0	1	1	0	1	1	1	-	-	-	-	-	-	-	Source1
or.ft	Des	st			So	urce	2		1	1	0	0	1	1	1	0	1	1	-	_	-	_	-	_	-	Source1
or.ff	Des	st			So	urce	2		1	1	0	0	1	1	1	1	0	1	_	_	_	_	_	_	_	Source1
ld	Des	st			В	ase			1	1	0	1	0	0	М	S	Z	1	S	D	-	_	-	_	-	Offset
ld.u	Des	st			В	ase	!		1	1	0	1	0	1	М	S	Z	1	s	D	-	_	_	_	_	Offset
st	Sour	се			В	ase			1	1	0	1	1	0	М	S	Z	ı	S	D	_	_	_	_	_	Offset
dcache		-	F		So	urce	2		1	1	0	1	1	1	М	0	0	1	0	0		_	_	_	_	Source1
bsr	Link	<		-	-	-	-	-	1	1	1	0	0	0	0	0	Α	1	-	_	-	_	-	_	-	Offset
jsr	Link	<			В	ase			1	1	1	0	0	0	1	0	Α	ı	_	_	_	_	_	_	_	Offset
bbz	BITNU	JM			Sc	ourc	е		1	1	1	0	0	1	0	0	Α	1	-	_	-	_	-	_	-	Target
bbo	BITNU	JM			Sc	ourc	е		1	1	1	0	0	1	0	1	Α	1	-	_	_	_	_	_	_	Target
bcnd	Con	d			Sc	ourc	е		1	1	1	0	0	1	1	0	Α	ı	_	_	_	_	_	_	_	Target
cmp	Des	st			So	urce	2		1	1	1	0	1	0	0	0	0	ı	_	_	_	_	_	_	_	Source1
add	Des	st			So	urce	2		1	1	1	0	1	1	0	0	U	ı	-	-	-	_	_	-	-	Source1
sub	Des	st			So	urce	2		1	1	1	0	1	1	0	1	U	I	_	_	_	_	_	_	_	Source1

Reserved bit (code as 0)

D Direct external access bit

E Emulation trap bit

F Clear present flags

i Invert endmask

Long immediate

M Modify, write modified address back to register

n Rotate sense for shifting

S Scale offset by data size

SZ Size (0 = byte, 1 = halfword, 2 = word, 3 = doubleword

MP opcode summary (continued)

Table 6. Miscellaneous Instruction Opcodes

	31 30 29 28 27	26 25 24 23 22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4 3 2 1 0
vadd	Mem Src/Dst	Source2/Dest	1	1	1	1	0	_	0	0	0	1	-	m	Р	-	d	m	S	Source1
vsub	Mem Src/Dst	Source2/Dest	1	1	1	1	0	_	0	0	1		-	m	Р	-	d	m	s	Source1
vmpy	Mem Src/Dst	Source2/Dest	1	1	1	1	0	_	0	1	0		-	m	Р	-	d	m	s	Source1
vmsub	Mem Src/Dst	Dest	1	1	1	1	0	а	0	1	1	ı	а	m	Р	Z	_	m	_	Source1
vrnd(FP)	Mem Src/Dst	Dest	1	1	1	1	0	а	1	0	0	ı	а	m	Р	Р	D	m	s	Source1
vrnd(Int)	Mem Src/Dst	Dest	1	1	1	1	0	_	1	0	1	ı		m	Р	_	d	m	s	Source1
vmac	Mem Src/Dst	Source2	1	1	1	1	0	а	1	1	0	ı	а	m	Р	Z	_	m	_	Source1
vmsc	Mem Src/Dst	Source2	1	1	1	1	0	а	1	1	1	ı	а	m	Р	Z	_	m	_	Source1
fadd	Dest	Source2	1	1	1	1	1	0	0	0	0	Т	-	PI	D	P	2	Р	1	Source1
fsub	Dest	Source2	1	1	1	1	1	0	0	0	1		-	PI	D	P	2	P	1	Source1
fmpy	Dest	Source2	1	1	1	1	1	0	0	1	0	ı	-	PI	D	P	2	Р	1	Source1
fdiv	Dest	Source2	1	1	1	1	1	0	0	1	1		-	PI	D	P	2	P	1	Source1
frndx	Dest		1	1	1	1	1	0	1	0	0	ı	-	PI	D	RI	М	Р	1	Source1
fcmp	Dest	Source2	1	1	1	1	1	0	1	0	1	ı	-	-	-	P	2	Р	1	Source1
fsqrt	Dest		1	1	1	1	1	0	1	1	1	ı	_	PI	D	-	-	Р	1	Source1
lmo	Dest	Source	1	1	1	1	1	1	0	0	0	-	-	_	_	_	_	_	_	
rmo	Dest	Source	1	1	1	1	1	1	0	0	1	–	–	-	-	-	-	_	_	
estop			1	1	1	1	1	1	1	1	0	-	-	_	-	-	-	_	=	
illopF			1	1	1	1	1	1	1	1	1	С	_	_	_	_	_	_	_	

- Reserved bit (code as 0)
- a Floating-point accumulator select
- C Constant operands rather than register
- d Destination precision for vector (0 = sp, 1 = dp)
- Long immediate 32-bit data
- m Parallel memory operation specifier
- Mem Src/Dst Vector store or load source/dst register
 - Dest Destination register

- P Dest precision for parallel load/store (0 = single, 1 = double)
- P1 Precision of source1 operand
- P2 Precision of source2 operand
- PD Precision of destination result
- RM Rounding Mode (0 = N, 1 = Z, 2 = P, 3 = M)
 - s Scale offset by data size
- Z Use 0 rather than accumulator

MP opcode summary (continued)

Table 7. Summary of MP Opcodes

INSTRUCTION	DESCRIPTION	INSTRUCTION	DESCRIPTION
add	Signed integer add	or.ff	Bitwise OR with 1s complement
and.tt	Bitwise AND	or.ft	Bitwise OR with 1s complement
and.ff	Bitwise AND with 1s complement	or.tf	Bitwise OR with 1s complement
and.ft	Bitwise AND with 1s complement	rdcr	Read control register
and.tf	Bitwise AND with 1s complement	rmo	Rightmost one
bbo	Branch bit one	shift.dz	Shift, disable mask, zero extend
bbz	Branch bit zero	shift.dm	Shift, disable mask, merge
bcnd	Branch conditional	shift.ds	Shift, disable mask, sign extend
br	Branch always	shift.ez	Shift, enable mask, zero extend
brcr	Branch control register	shift.em	Shift, enable mask, merge
bsr	Branch and save return	shift.es	Shift, enable mask, sign extend
cmnd	Send command	shift.iz	Shift, invert mask, zero extend
cmp	Integer compare	shift.im	Shift, invert mask, merge
dcache	Flush data cache sub-block	st	Store register into memory
estop	Emulation stop	sub	Signed integer subtract
fadd	Floating-point add	swcr	Swap control register
fcmp	Floating-point compare	trap	Trap
fdiv	Floating-point divide	vadd	Vector floating-point add
fmpy	Floating-point multiply	vmac	Vector floating-point multiply and add to accumulator
frndx	Floating-point convert/round	vmpy	Vector floating-point multiply
fsqrt	Floating-point square root	vmsc	Vector floating-point multiply and subtract from accumulator
fsub	FLoating-point subtract	vmsub	Vector floating-point subtract accumulator from source
illop	Illegal operation	vrnd(FP)	Vector round with floating-point input
jsr	Jump and save return	vrnd(Int)	Vector round with integer input
ld	Load signed into register	vsub	Vector floating-point subtract
ld.u	Load unsigned into register	xnor	Bitwise exclusive NOR
Imo	Leftmost one	xor	Bitwise exclusive OR
or.tt	Bitwise OR		

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PP architecture

The parallel processor (PP) is a 32-bit integer DSP optimized for imaging and graphics applications. Each PP can execute in parallel; a multiply, ALU operation, and two memory accesses within a single instruction. This internal parallelism allows a single PP to achieve over 500 million operations per second for certain algorithms. The PP has a three-input ALU that supports all 256 three input Boolean combinations and many combinations of arithmetic and Boolean functions. Data-merging and bit-to-byte, bit-to-word, and bit-to-halfword translations are supported by hardware in the input data path to the ALU. Typical tasks performed by a PP include:

- Pixel-intensive processing
 - Motion estimation
 - Convolution
 - PixBLTs
 - Warp
 - Histogram
 - Mean square error
- Domain transforms
 - DCT
 - FFT
 - Hough
- Core graphics functions
 - Line
 - Circle
 - Shaded fills
 - Fonts
- Image Analysis
 - Segmentation
 - Feature extraction
- Bit-stream encoding/decoding
 - Data merging
 - Table look-ups



PP functional block diagram

Figure 22 shows a block diagram of a parallel processor. Key features of the PP include:

- 64-bit instruction word (supports multiple parallel operations)
- Three-stage pipeline for fast instruction cycle
- Numerous registers
 - 8 data, 10 address, 6 index registers
 - 20 other user-visible registers
- Data Unit
 - 16x16 integer multiplier (optional dual 8x8)
 - Splittable 3-input ALU
 - 32-bit barrel rotator
 - Mask generator
 - Multiple-status flag expander for translations to/from 1 bit-per-pixel space.
 - Conditional assignment of data unit results
 - Conditional source selection
 - Special processing hardware
 Leftmost one / rightmost one
 Leftmost bit change / rightmost bit change
- Memory addressing
 - Two address units (global & local) provide up to two 32-bit accesses in parallel with data unit operation.
 - 12 addressing modes (immediate and indexed)
 - Byte, halfword, and word addressability
 - Scaled indexed addressing
 - Conditional assignment for loads
 - Conditional source selection for stores
- Program flow
 - Three hardware loop controllers
 Zero overhead looping / branching
 Nested loops
 Multiple loop endpoints
 - Instruction cache management
 - PC mapped to register file
 - Interrupts for messages and context switching
- Algebraic assembly language



PP functional block diagram (continued)

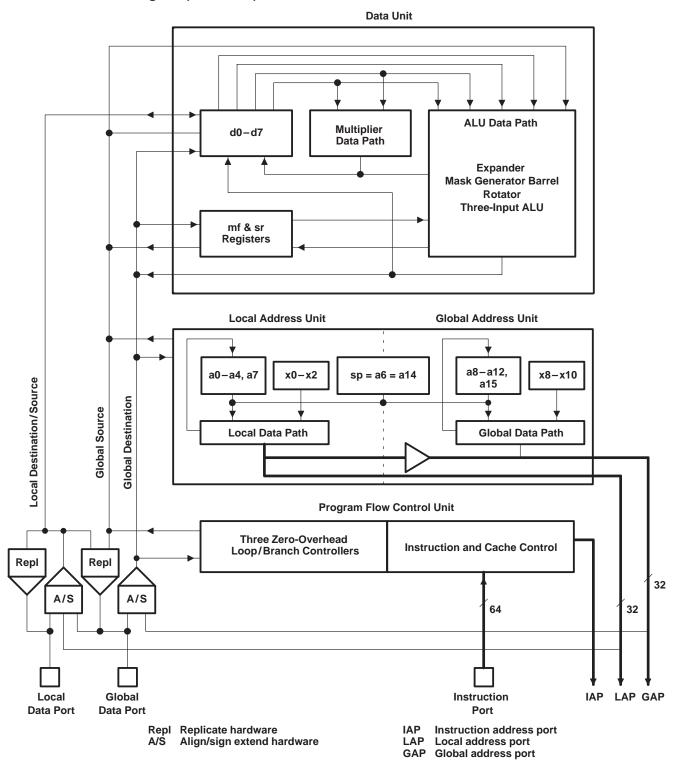


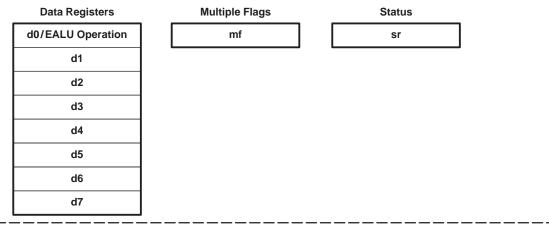
Figure 22. PP Block Diagram



PP registers

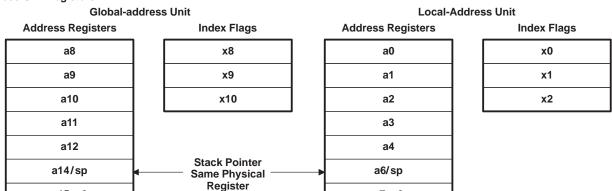
The PP contains many general-purpose registers, status registers, and configuration registers. All PP registers are 32-bit registers. Figure 23 shows the accessible registers of the PP blocks.

Data-Unit Registers



a7 = 0

Address-Unit Registers



PFC-Unit Registers

a15 = 0

PC-Related Registers	Loop Addresses	Loop Counts	Communications
pc (br, call)	ls0	lr0	comm
iprs	ls1	lr1	Interrupts
ipa (read only)	ls2	lr2	Intflg
ipe (read only)	le0	lc0	inten
Cache Tags	le1	lc1	
tag0 (read only)	le2	lc2	
tag1 (read only)			
tag2 (read only)	Loop Control		
tag3 (read only)	lctl		

Figure 23. PP Registers

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PP data-unit registers

The data unit contains eight 32-bit general-purpose data registers (d0–d7) referred to as the D registers. The d0 register also acts as the control register for EALU operations.

d0 register

Figure 24 shows the format when d0 is used as the EALU control register.

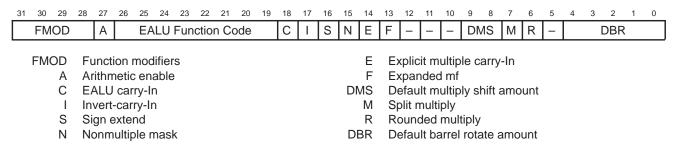


Figure 24. d0 Format for EALU Operations

multiple flags (mf) register

The mf register records status information from each split ALU segment for multiple arithmetic operations. The mf register may be expanded to generate a mask for the ALU. Figure 25 shows the mf register format.

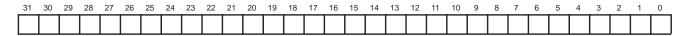


Figure 25. mf Register Format

status register (sr)

The sr contains status and control bits for the PP ALU. Figure 26 shows the sr register format.

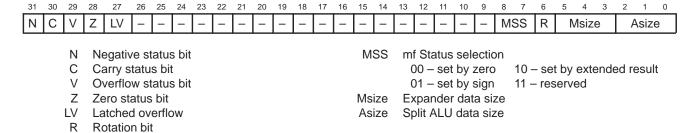


Figure 26. sr Format

PP address-unit registers

address registers

The address unit contains ten 32-bit address registers which contain the base address for address computations or which can be used for general-purpose data. The registers a0 – a4 are used for local address computations and registers a8–a12 are used for global-address computations.



index registers

The six 32-bit index registers contain index values for use with the address registers in address computations or they can be used for general-purpose data. Registers x0-x2 are used by the local-address unit and registers x8-x10 are used by the global-address unit.

stack pointer (sp)

The sp contains the address of the bottom of the PP's system stack. The stack pointer is addressed as a6 by the local-address unit and as a14 by the global-address unit. Figure 27 shows the sp register format.

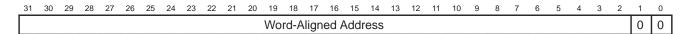


Figure 27. sp Register Format

zero register

The zero registers are read-as-zero address registers for the local address unit (a7) and global-address unit (a15). Writes to the registers are ignored and can be specified when operational results are to be discarded. Figure 28 shows the zero register format.

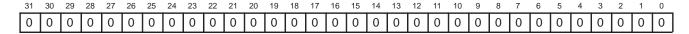


Figure 28. zero Registers

PP program flow control (PFC) unit registers

loop registers

The loop registers control three levels of zero-overhead loops. The 32-bit loop start registers (Is0 - Is2) and loop-end registers (Is0 - Is2) contain the starting and ending addresses for the loops. The loop-counter registers (Is0 - Is2) contain the number of repetitions remaining in their associated loops. The Is0 - Is2 registers are loop reload registers used to support nested loops. The format for the loop-control (Is0 - Is2) register is shown in Figure 29. There are also six special write-only mappings of the loop-reload registers. The Is0 - Is2 codes are used for fast initialization of Isn, Isn, and Isn registers for multi-instruction loops while the Iss0 - Iss2 codes are used for single instruction-loop fast initialization.

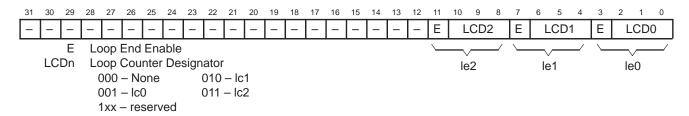


Figure 29. Ictl Register

pipeline registers

The PFC unit contains a pointer to each stage of the PP pipeline. The pc contains the program counter which points to the instruction being fetched. The ipa points to the instruction in the address stage of the pipeline and the ipe points to the instruction in the execute stage of the pipeline. The instruction pointer return-from-subroutine (iprs) register contains the return address for a subroutine call. Figure 30 shows the variable pipeline register format.



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Figure 30. Pipeline Registers

interrupt registers

The interrupt-enable (inten) register allows individual interrupts to be enabled and configures the interrupt flag (intflg) register operation. The intflg register contains the interrupt flag bits. Interrupt priority increases moving from left to right on intflg. Figure 31 shows the PP-interrupt register format.

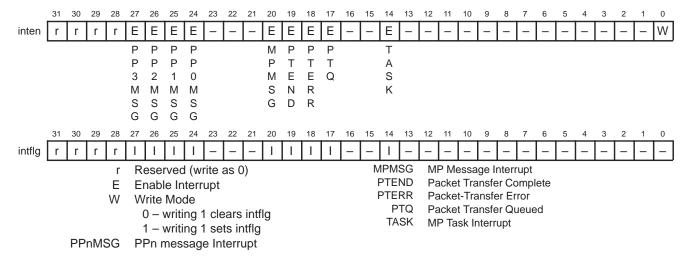


Figure 31. PP-Interrupt Registers

communication (comm) register

The comm register contains the packet-transfer handshake bits and PP indicator bits. Figure 32 shows the comm register format.

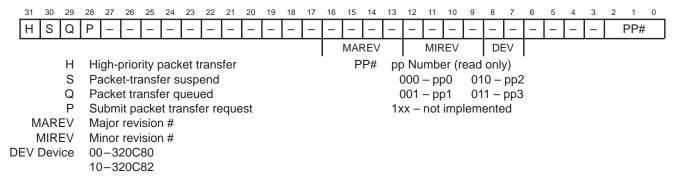


Figure 32. comm Register

cache-tag registers

The tag0 – tag3 registers contain the tag address and sub-block present bits for each cache block. Figure 33 shows the cache tag registers.

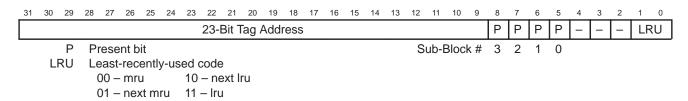


Figure 33. Cache Tag Registers

PP cache architecture

Each PP has its own 2K-byte instruction cache. Each cache is divided into four blocks and each block is divided into four sub-blocks containing 16 64-bit instructions each. Cache misses cause one sub-block to be loaded into cache. Figure 34 shows the cache architecture for one of the four sets in each cache. Figure 35 shows how addresses map into the cache using the cache tags and address bits.

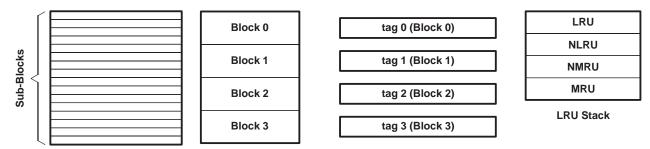


Figure 34. PP Cache Architecture

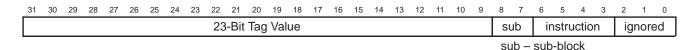


Figure 35. pc Register Cache-Address Mapping



PP parameter RAM

The parameter RAM is a, 2K-byte, on-chip RAM which contains PP-interrupt vectors, PP-requested TC task buffers, and a general-purpose area. The parameter RAM does not use the cache memory. Figure 36 shows the parameter RAM address map.

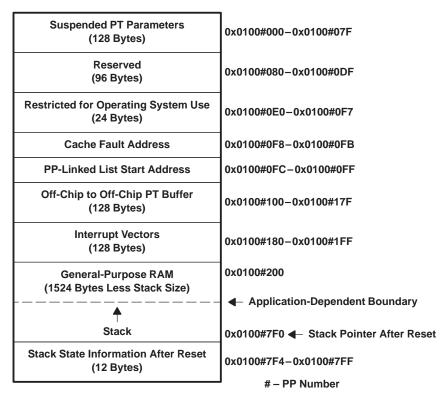


Figure 36. PP Parameter RAM

PP interrupt vectors

The PP interrupts and their vector addresses are shown in Table 8.

Table 8. PP-Interrupt Vectors

NAME	VECTOR ADDRESS	INTERRUPT
TASK	0x0100#1B8	Task Interrupt
PTQ	0x0100#1C4	Packet Transfer Queued
PTERR	0x0100#1C8	Packet-Transfer Error
PTEND	0x0100#1CC	Packet-Transfer End
MPMSG	0x0100#1D0	MP Message
PP0MSG	0x0100#1E0	PP0 Message
PP1MSG	0x0100#1E4	PP1 Message
PP2MSG	0x0100#1E8	PP2 Message
PP3MSG	0x0100#1EC	PP3 Message

PP data-unit architecture

The data unit has independent data paths for the ALU and the multiplier, each with its own set of hardware functions. The multiplier data path includes a 16×16 multiplier, a halfword swapper, and rounding hardware. The ALU data path includes a 32-bit three-input ALU, a barrel rotator, mask generator, mf expander, left/rightmost one and left/rightmost bit-change logic, and several multiplexers. Figure 37 shows the data-unit block diagram.

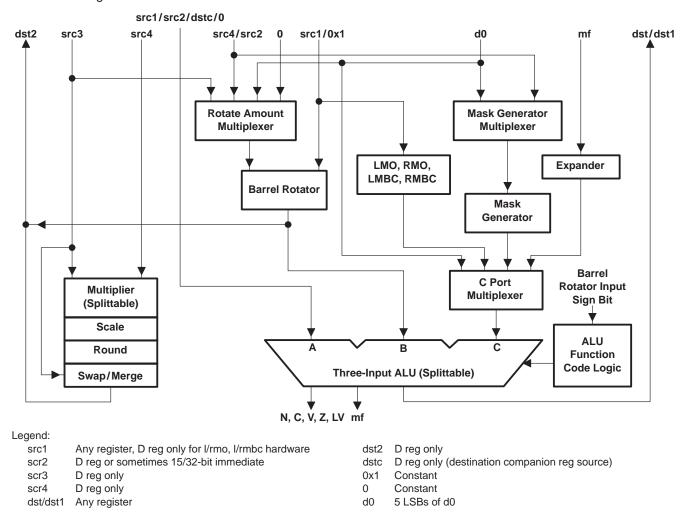


Figure 37. Data Unit Block Diagram

The PP's ALU can be split into one 32-bit ALU, two 16-bit ALUs, or four 8-bit ALUs. Figure 38 shows the multiple arithmetic data flow for the case of a four 8-bit split of the ALU (called multiple-byte arithmetic). The ALU operates as independent parallel ALUs where each ALU receives the same function code.

PP data-unit architecture (continued)

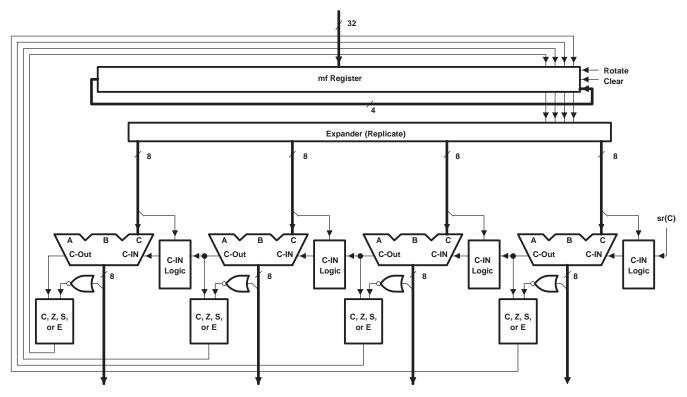


Figure 38. Multiple-Byte Arithmetic Data Flow

PP multiplier

The PP's hardware multiplier can perform one 16x16 multiply with a 32-bit result or two 8x8 multiplies with two 16-bit results in a single cycle. A 16x16 multiply can use signed or unsigned operands as shown in Figure 39.



Figure 39. 16 x 16 Multiplier Data Formats

When performing two simultaneous 8x8 split multiplies, the first input word contains unsigned byte operands and the second input word contains signed or unsigned byte operands. These formats are shown in Figure 40 and Figure 41.



PP multiplier (continued) 18 15 14 13 12 11 10 Χ Χ Χ Χ Χ Unsigned Input 1b Unsigned Input 1a Χ Χ Χ Χ Χ Χ $X \mid X$ Χ Χ Χ 23 22 21 17 16 14 13 12 11 10 9 30 26 25 24 20 19 18 15 Χ X Χ Χ Χ Χ Χ Χ Χ Χ S S Χ Χ Χ Χ Χ Χ Signed Input 2b Signed Input 2a $30 \quad 29 \quad 28 \quad 27 \quad 26 \quad 25 \quad 24 \quad 23 \quad 22 \quad 21 \quad 20 \quad 19 \quad 18 \quad 17 \quad 16 \quad 15 \quad 14 \quad 13 \quad 12 \quad 11 \quad 10 \quad 9 \quad 8 \quad 7 \quad 6$ S 1b × 2b Signed Result S 1a × 2a Signed Result Figure 40. Signed Split Multiply Data Formats 18 17 16 15 14 13 12 11 10 9 22 21 19 Χ Χ Χ Χ Χ Χ Χ Χ Χ $X \mid X \mid X$ Χ Χ $X \mid$ Χ Unsigned Input 1b Unsigned Input 1a 23 22 18 16 15 14 13 12 11 10 9 Χ Χ Χ Χ Χ Χ Χ Χ Χ Χ $X \mid X$ Χ Χ Χ Χ Unsigned Input 2b Unsigned Input 2a 26 25 24 23 22 21 20 19 18 17 16 15 14 13 12 11 10 9 1b × 2b Unsigned Result 1a × 2a Unsigned Result

Figure 41. Unsigned Split Multiply Data Formats

PP program-flow-control unit architecture

The PP has a three-stage fetch, address, execute (FAE) pipeline as shown in Figure 42. The pc, ipa, and ipe registers point to the address of the instruction in each stage of the pipeline. On each cycle in which the pipeline advances, ipa is copied into ipe, pc is copied into ipa, and the pc is incremented by one instruction (8 bytes).

The program-flow-control (pfc) unit performs instruction fetching and decoding, loop control, and handshaking with the transfer controller. The pfc unit architecture is shown in Figure 43.

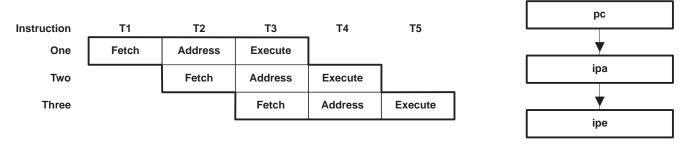


Figure 42. FAE-Instruction Pipeline

PP program-flow-control unit architecture (continued)

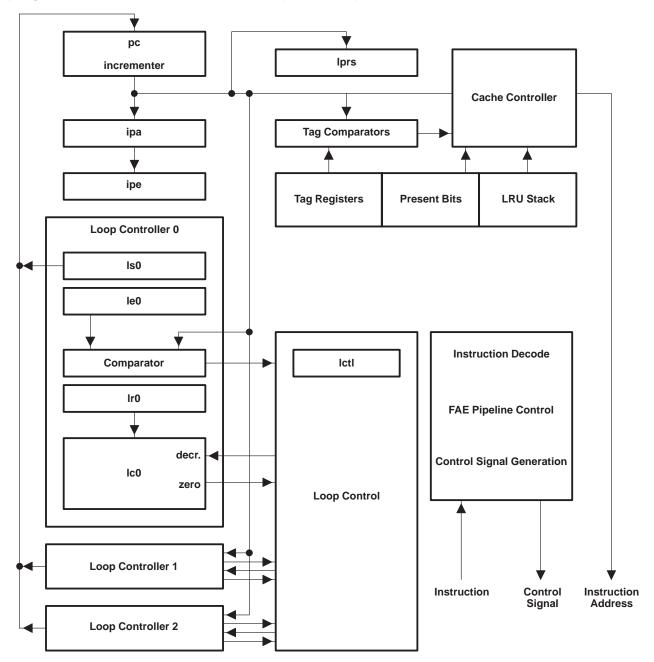


Figure 43. Program-Flow-Control Unit Block Diagram

PP address-unit architecture

The PP has both a local- and global-address unit which operate independently of each other. The address units support twelve different addressing modes. In place of performing a memory access, either or both of the address units can perform an address computation that is written directly to a PP register instead of being used for a memory access. This address-unit arithmetic provides additional arithmetic operation to supplement the data unit during compute-intensive algorithms. Figure 44 shows the address-out architecture.



PP address-unit architecture (continued)

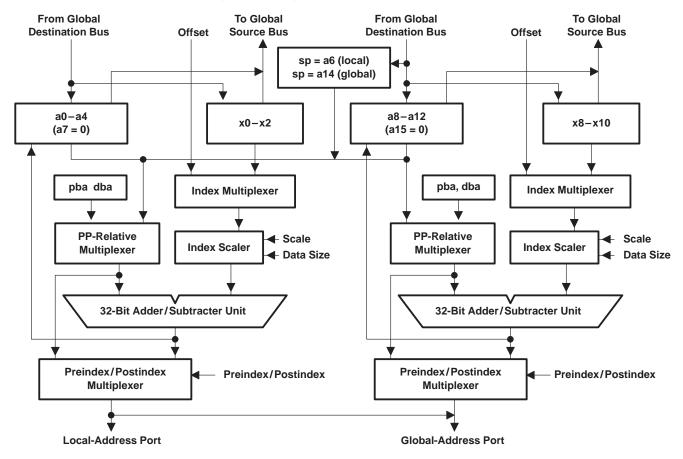


Figure 44. Address-Unit Architecture

PP instruction set

PP instructions are represented by algebraic expressions for the operations performed in parallel by the multiplier, ALU, global-address unit, and local-address unit. The expressions use the || symbol to indicate operations that are to be performed in parallel. The PP ALU operator syntax is shown in Table 9. The data unit operations (multiplier and ALU) are summarized in Table 10 and the parallel transfers (global and local) are summarized in Table 11.

PP instruction set (continued)

Table 9. PP Operators by Precedence

OPERATOR	FUNCTION					
src1 [n] src1-1	Select odd (n=true) or even (n=false) register of D register pair based on negative condition code					
()	Subexpression delimiters					
@mf	Expander operator					
%	Mask generator					
%%	Nonmultiple mask generator (EALU only)					
%!	Modified mask generator (0xFFFFFFF output for 0 input)					
%%!	Nonmultiple shift right mask generator (EALU only)					
\\	Rotate left					
<<	Shift left (pseudo-op for rotate and mask)					
>>u	Unsigned shift right					
>> or >>s	Signed shift right					
&	Bitwise AND					
۸	Bitwise XOR					
1	Bitwise OR					
+	Addition					
_	Subtraction					
=[cond]	Conditional assignment					
=[cond.pro]	Conditional assignment with status protection					
=	Equate					

PP instruction set (continued)

Table 10. Summary of Data-Unit Operations

Operation	Base set ALUs
Description	Perform an ALU operation specifying ALU function, 2 src and 1 dest operand, and operand routing. ALU function is one of 256 three-input Boolean operations or one of 17 arithmetic operations combined with one of 15 function modifiers.
Syntax	dst = [fmod] [[[cond [.pro]]]] ALU_EXPRESSION
Examples	d6 = (d6 ^ d4) & d2 d3 = [nn.nv] d1 -1
Operation	EALU ROTATE
Description	Perform an extended ALU (EALU) operation (specified in d0) with one of two data routings to the ALU and optionally write the barrel rotator output to a second dest register. ALU Function is one of 256 Boolean or 256 arithmetic.
Syntax	dst1 = [[[cond [.pro]]]] ealu (src2, [dst2 =] [[[cond]] src1 [[[n]] src1-1] \\ src3, [%] src4) dst1 = [fmod] [[[cond [.pro]]]] ealu (label:EALU_EXPRESSION [dst2 = [[cond]] src1 [[[n]] src1-1] \\ src3])
Examples	$d7 = [nn] \ ealu(d2, d6 = [nn] \ d3\d1, \d4)$ $d3 = mzc \ ealu(mylabel: d4 + (d5\d6 & \d7) d1 = d5\d6)$
Operation	MPY ADD
Description	Perform a 16x16 multiply with optional parallel add or subtract. Condition code applies to both multiply and add.
Syntax	dst2 = [sign] [[[cond]]] src3 * src4 [dst = [[[cond[.pro]]]] src2 + src1 [[[n]] src1 -1]] dst2 = [sign] [[[cond]]] src3 * src4 [dst = [[[cond[.pro]]]] src2 - src1 [[[n]] src1 -1]]
Example	d7 = u d6 * d5 d5 = d4 - d1
Operation	MPY SADD
Description	Perform a 16x16 multiply with a parallel right-shift and add or subtract. Condition code applies to multiply, shift, and add.
Syntax	dst2 = [sign] [[[cond]]] src3 * src4 dst = [[[cond [.pro]]]] src2 + src1 [[[n]] src1 -1] >> -d0 dst2 = [sign] [[[cond]]] src3 * src4 dst = [[[cond [.pro]]]] src2 - src1 [[[n]] src1 -1] >> -d0
Examples	d7 = u d6 * d5 d5 = d4 - d1 >> -d0
Operation	MPY EALU
Description	Perform a multiply and an optional parallel EALU. Multiply can use rounding, scaling, or splitting features.
Syntax	Generic Form: dst2 = [sign] [[[cond]]] src3 * src4 dst = [[[cond [.pro]]]] ealu[f] (src2, src1 [[[n]] src1 -1] \\ d0, %d0) dst2 = [sign] [[[cond]]] src3 * src4 ealu() Explicit Form: dst2 = [sign] [opt] [[[cond]]] src3 * src4 [< <dms] (label)<="" (label:="" *="" [="" [.pro]="" [<<dms]="" [[cond="" [[cond]]="" [opt]=""]=""]]="" dst1="[fmod]" dst2="[sign]" ealu="" ealu_expression)="" src3="" src4="" td="" =""></dms]>
Examples	$d7 = [p] d5 * d3 d2 = [p] ealu(d1, d6 \ d0, %d0) ; generic form d2 = m d4 * d7 d3 = ealu (mylabel: d3 + d2 >> 9) ; explicit form$
Operation	divi
Description	Perform one iteration of unsigned divide algorithm. Generates one quotient bit per execution using iterative subtraction.
Syntax	dst1 = [[[cond [.pro]]]] divi (src2, dst2 = [[cond]] src1 [[[n]] src1 -1])
Examples	d3 = divi (d1, d2 = d2) d3 = divi (d1, d2 = d3[n]d2)

Legend:

[]	Optional parameter extension	cond	Condition code
[[]]	Square brackets ([]) must be used	fmod	Function modifier
pro	Protect status bits	dms	Default multiply shift amount
f	Use 1s compliment of d0	sign	u = unsigned, s = signed



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PP instruction set (continued)

Table 10. Summary of Data-Unit Operations (Continued)

Misc. Operations	dint; eint; nop; dloop; eloop; qwait
Description	Globally disable interrupts; globally enable interrupts; do nothing in the data unit; globally enable looping; globally disable looping; wait until comm register Q bit is zero.
Syntax	dint dloop eint eloop nop qwait

Legend:

[]	Optional parameter extension	cond	Condition code
[[]]	Square brackets ([]) must be used	fmod	Function modifier
	B	dec.	Defends and Calculate

pro Protect status bits dms Default multiply shift amount f Use 1s compliment of d0 sign u = unsigned, s = signed

PP instruction set (continued)

Table 11. Summary of Parallel Transfers

Operation	Load
Description	Transfer from memory into PP register
Syntax	dst = [sign] [size] [[[cond]]]* addrexp dst = [sign] [size] [[[cond]]]* an.element
Examples	d3 = uh[n]* (a9++=[2]) d1 = * a2.sMY_ELEMENT
Operation	Store
Description	Transfer from PP register into memory
Syntax	* addrexp = [size] src [[[n]] src-1] * an.element = [size] src [[[n]] src-1]
Examples	*a2 = d3 *a9.sMY_ELEMENT = a3
Operation	Address unit arithmetic
Description	Compute address and store in PP register
Syntax	dst = [size] [[[cond]]] & * addrexp dst = [size] [[[cond]]] & * an.element
Examples	d2 = &*(a3 + x0) a1 = &*a9.sMY_ELEMENT
Operation	Move
Description	Transfer from PP register to PP register
Syntax	dst = [g] [[[cond]]] src
Examples	x2 = mf d1 = g d3
Operation	Field extract move
Description	Transfer from PP register to PP register extracting and right-aligning one byte or halfword
Syntax	dst = [sign] [size item]
Example	d3 = ub2 d1
Operation	Field replicate move
Description	Transfer from PP register to PP register replicating the LSbyte or LShalfword to 32 bits
Syntax	dst = r [size] [[cond]] src
Example	d7 = rh d3

Legend:

[]	Optional parameter extension	cond	Condition code
[[]]	Square brackets ([]) must be used	sign	u = unsigned, s = signed
g	Use global unit	size	b = byte, h = halfword, w = word (default)
item	0 = byte0/halfword0, 1 = byte1/halfword1, 2 = byte2, 3 = byte3		



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PP opcode formats

A PP instruction uses a 64-bit opcode. The opcode is divided essentially into a data unit portion and a parallel transfer portion. There are five data unit opcode formats comprising bits 38–63 of the opcode. Bits 0–38 of the opcode specify one of 10 parallel transfer formats. An alphabetical list of the mnemonics used in Figure 45 for the data unit and parallel transfer portions of the opcode are shown in Table 12 and Table 13, respectively.

Data Unit Formats

6		5 9		5 5 5 6 5 4		5 4 4 0 9 8	4 4 4 7 6 5	4 4	4 3 2					3 3 2 1 0 9	3 2 1 0	
0	1 1	ор	er	src3	dst2	dst1	src1	sr	c4	src2		F	Paralle	el Transfer	Ş	A. Six-Operand (MPYIIADD, etc.)
1	class	Α	Al	ALU Operation dst src1 0 imm. src2			Parallel Transfers			,, S ((B. Base Set ALU (5-Bit Immediate)					
1	class	Α	Al	LU Opera	ation	dst	src1	1 0 - src2		Parallel Transfers		,, S	C. Base Set ALU (Register src2)			
1	class	Α	Al	LU Opera	ation	dst	src1	1 '	1 d	lstbank	s1bnk	CC	ond	32-Bit	Immediate	D. Base Set ALU (32-Bit Immediate)
1	0 0 0	0 1 - 0 - 0 - 0 - 0 - 0 0 Operation Parallel Transfe							el Transfer	S 	E. Miscellaneous					
0	0 Reserved								((
0	1 0 Reserved							((

Transfer Formats

9 8 7 6 5 4 3 2 1 0 8 7 6 5 4 3 2 1 0 9 8 7 6 5 4 3 2 0 9 8 7 6 5 4 3 2 Gim/X L Obank Gmode size Lim/X 1. Double Parallel reg Lmode size Lrm 0 0 0 0 dst Lim/X La dstbank srcbank 2. Move II Local 0 0 0 1 e size D d La Lrm dstbank dst Lim/X 3. Field Move II Local Lmode size src 0 0 Lmode reg size La Lrm bank Local Long Offset / X 4. Local (Long Offset) 0 0 Global Long Offset /X bank Gmode reg size s Ga Grm 5. Global (Long Offset) 0 0 1 size s La Adstbank 6. Non-D DU II Local Lmode d Lrm As1bank Lim/X 0 0 0 0 0 0 cond g N C V Z dstbank src srcbank dst 7. Conditional DU II Conditional Mode 0 0 cond r g N C V Z 0 itm dstbank 0 0 0 src size D dst 8. Conditional DU II Conditional Field Move 0 g N C V Z Grm 9. Conditional DU II Conditional Global 0 cond r Gim/X bank Gmode reg е size Ga 0 cond NCVZAdstbank 0 0 1 As1bank 10. Conditional Non-D DU

Figure 45. PP Opcode Formats

Table 12. Data Unit Mnemonics

MNEMONIC	FUNCTION
А	A = 1 selects arithmetic operations, A = 0 selects Boolean operations
ALU Operation	For Boolean operation (A = 0) select the 8 ALU function signals. For arithmetic operation (A = 1), odd bits specify the ALU function and even bits define the ALU function modifiers.
class	Operation class, determines routing of ALU operands
cond	condition code
dst	D register destination or lower 3 bits of non-D register code
dst1	ALU dest. for MPY ADD, MPY EALU, or EALU ROTATE operation. D register or lower 3 bits of non-D register code
dst2	Multiply dest. for MPY ADD or MPY EALU operation or rotate dest. for EALU ROTATE operation. D register
dstbank	ALU register bank
imm.src2	5-bit immediate for src2 of ALU operation
32-Bit Immediate	32-bit immediate for src2 of ALU operation
oper	Six-operand data unit operation (MPY ADD, MPY SADD, MPY EALU, EALU ROTATE, divi)
Operation	Miscellaneous operation
src1	ALU source 1 register code (D register unless srcbank or s1bank is used)
src2	D register used as ALU source 2
src3	D register for multiplier source (MPY ADD or MPY EALU) or rotate amount (EALU ROTATE)
src4	D reg for ALU C port operand or EALU ROTATE mask generator input or multiplier source 2 for MPY ADD, MPY EALU
s1bnk	Bits 5-3 of src1 register code (bit 6 assumed to be 0)

Table 13. Parallel Transfer Mnemonics

MNEMONIC	FUNCTION
0bank	Bits 5–3 of global transfer source/destination register code (bit 6 assumed to be 0)
Adstbnk	Bits 6–3 of ALU destination register code
As1bank	Bits 6–3 of ALU source 1 register code
bank	Bits 6–3 of global (or local) store source or load destination
С	Conditional choice of D register for src1 operand of the ALU
С	Protect status register's carry bit
cond	Condition code
d	D register or lower 3 bits of register code for local transfer source/destination
D	Duplicate least significant data during moves
dst	The three lowest bits of the register code for move or field move destination
dstbank	Bits 6–3 of move destination register code
е	Sign extend local (bit 31), sign extend global (bit 9)
g	Conditional global transfer
Ga	Global address register for load, store, or address unit arithmetic
Gim / X	Global address unit immediate offset or index register
Gmode	Global unit addressing mode
Grm	Global PP-relative addressing mode
itm	Number of item selected for field extract move
L	L = 1 selects load operation, L = 0 selects store/address unit arithmetic operation
La	Local address register for load, store, or address unit arithmetic
Lim / X	Local address unit immediate offset or index register
Lmode	Local unit addressing mode
Lrm	Local PP-relative addressing mode
N	Protect status register's negative bit
r	Conditional write of ALU result
reg	Register number used with bank or 0bank for global load, store, or address unit arithmetic
s	Enable index scaling. Additional index bit for byte accesses or arithmetic operations (bit 28, local; bit 6, global)
size	Size of data transfer (bits 30-29, local; bits 8-7, global)
src	Three lowest bits of register code for register-register move source or non-field moves. D register source for field move
srcbank	Bits 6–3 of register code for register-register move source
V	Protect status register's overflow bit
Z	Protect status register's zero bit
_	Unused bit (fill with 0)

Table 14 summarizes the supported parallel-transfer formats, their formats, and whether the transfers are local or global. It also lists the allowed ALU operations and states whether conditions and status protection are supported.

Table 14. Parallel-Transfer Format Summary

ALU		_U			GLC	BAL TR	L TRANSFER			LOCAL TRANSFER			
FORMAT	OPERANDS				Move	Load/Store/AUA			Load/Store/AUA			١	
TORMAT	dst1	src1	Cond	Status Protection	$\operatorname{src} o \operatorname{dst}$	s/d	Index	Rel	s/d	Index	Rel	Port	
Double parallel	D	D	No	No	_	Lower	X/short	No	D	X/short	No	Local	
Move Local	D	D	No	No	Any→Any	_	-	—	D	X/short	Yes	Local	
Field move Local	D	D	No	No	D→Any	_	-	—	D	X/short	No	Local	
Global (long offset)	D	D	No	No	_	Any	X/long	Yes	_	-	_	_	
Local (long offset)	D	D	No	No	_	_	-	—	Any	X/long	Yes	Global	
Non-D DU Local	Any	Any	No	No	_	_	-	—	D	X/short	Yes	Global	
Conditional move	D	D	Yes	Yes	Any→Any	_	-	—	_	-	_	_	
Conditional field move	Conditional field move D		Yes	Yes	D→Any	_	_	_	_	_	_	_	
Conditional global	D	D	Yes	Yes	_	Any	X/short	Yes	_	_	_	_	
Conditional non-D DU	Any	Any	Yes	Yes	_	_	_	_	_	_	_	_	
32-bit imm. base ALU	Any	Lower	Yes	No	_								

Legend:

DU Data unit

AUA Address unit arithmetic s/d Source/destination register Rel Relative addressing support

Table 15 shows the encoding used in the opcodes to specify particular PP registers. A 3-bit register field contains the three LSBs. The register codes are used for the src, src1, src2, src3, src4, dst, dst1, dst2, d, reg, Ga, La, Gim/X, and Lim/X opcode fields. The four MSBs specify the register bank which is concatenated to the register field for the full 7-bit code. The register bank codes are used for the dstbank, s1bnk, srcbank, 0bank, bank, Adstbnk, and As1bank opcode fields. When no associated bank is specified for a register field in the opcode, the D register bank is assumed. When the MSB of the bank code is not specified in the opcode (as in Obank and s1bnk) it is assumed to be 0, indicating a lower register.

Table 15. PP Register Codes

	LOWER REGISTERS (MSB OF BANK = 0)							
COD	NG	REGISTER	COD	ING	DEGICTED			
BANK	REG	REGISTER	BANK	REG	REGISTER			
0000	000	a0	0100	000	d0			
0000	001	a1	0100	001	d1			
0000	010	a2	0100	010	d2			
0000	011	а3	0100	011	d3			
0000	100	a4	0100	100	d4			
0000	101	reserved	0100	101	d5			
0000	110	a6 (sp)	0100	110	d6			
0000	111	a7 (zero)	0100	111	d7			
0001	000	a8	0101	000	reserved			
0001	001	a9	0101	001	sr			
0001	010	a10	0101	010	mf			
0001	011	a11	0101	011	reserved			
0001	100	a12	0101	100	reserved			
0001	101	reserved	0101	101	reserved			
0001	110	a14 (sp)	0101	110	reserved			
0001	111	a15 (zero)	0101	111	reserved			
0010	000	х0	0110	000	reserved			
0010	001	x1	0110	001	reserved			
0010	010	x2	0110	010	reserved			
0010	011	reserved	0110	011	reserved			
0010	100	reserved	0110	100	reserved			
0010	101	reserved	0110	101	reserved			
0010	110	reserved	0110	110	reserved			
0010	111	reserved	0110	111	reserved			
0011	000	x8	0111	000	pc/call			
0011	001	x9	0111	001	ipa/br			
0011	010	x10	0111	010	ipe #			
0011	011	reserved	0111	011	iprs			
0011	100	reserved	0111	100	inten			
0011	101	reserved	0111	101	intflg			
0011	110	reserved	0111	110	comm			
0011	111	reserved	0111	111	lctl			

UPPER REGISTERS (MSB OF BANK = 1)							
COD	NG	DEGISTED	COD	ING	DEGISTED		
BANK	REG	REGISTER	BANK	REG	REGISTER		
1000	000	reserved	1100	000	lc0		
1000	001	reserved	1100	001	lc1		
1000	010	reserved	1100	010	lc2		
1000	011	reserved	1100	011	reserved		
1000	100	reserved	1100	100	lr0		
1000	101	reserved	1100	101	lr1		
1000	110	reserved	1100	110	lr2		
1000	111	reserved	1100	111	reserved		
1001	000	reserved	1101	000	Irse0		
1001	001	reserved	1101	001	Irse1		
1001	010	reserved	1101	010	Irse2		
1001	011	reserved	1101	011	reserved		
1001	100	reserved	1101	100	lrs0		
1001	101	reserved	1101	101	lrs1		
1001	110	reserved	1101	110	lrs2		
1001	111	reserved	1101	111	reserved		
1010	000	reserved	1110	000	ls0		
1010	001	reserved	1110	001	ls1		
1010	010	reserved	1110	010	ls2		
1010	011	reserved	1110	011	reserved		
1010	100	reserved	1110	100	le0		
1010	101	reserved	1110	101	le1		
1010	110	reserved	1110	110	le2		
1010	111	reserved	1110	111	reserved		
1011	000	reserved	1111	000	reserved		
1011	001	reserved	1111	001	reserved		
1011	010	reserved	1111	010	reserved		
1011	011	reserved	1111	011	reserved		
1011	100	reserved	1111	100	tag0#		
1011	101	reserved	1111	101	tag1#		
1011	110	reserved	1111	110	tag2#		
1011	111	reserved	1111	111	tag3#		



[#]Read only

data unit operation code

For data unit opcode format A, a 4-bit operation code specifies one of 16 six-operand operations and an associated data path, as shown in Table 16.

Table 16. Six Operand Format Operation Codes

	oper FIE	LD BIT		
60	59	58	57	OPERATION TYPE
0	u	0	S	MPY ADD
0	u	1	f	MPYU EALU
1	0	f	k	EALU ROTATE
1	0	1	0	divi
1	1	u	s	MPY SADD

Legend:

- u Unsigned
- f 1s complement EALU function code
- s Subtract
- k Use mask or mf expander

operation class code

The base set ALU opcodes (formats B, C, D) use an operation class code to specify one of eight different routings to the A, B, and C ports of the ALU, as shown in Table 17.

Table 17. Base Set ALU Class Summary

CLASS	DESTINATION	A PORT		B PORT		C PORT
000	dst	src2	src1			@mf
001	dst	dstc	src1	\\	d0	src2
010	dst	dstc	src1			%src2
011	dst	dstc	src1	\\	src2	%src2
100	dst	src2	src1	\\	d0	%d0
101	dst	src2	src1	\\	d0	@mf
110	dst	dstc	src1			src2
111	dst	src1	1	\\	src2	src2

Legend:

\\ Rotate left
@mf Expand function
% Mask generation
dstc Companion D reg

dstc Companion D reg
dst Destination Dreg or any reg if dstbank or Adstbnk is used with destination.

src2 Source D reg or immediate

srd1 Source D reg or any if As1bank is used or any lower reg if s1bnk is used



ALU-operation code

For base-set ALU Boolean opcodes (A=0), the ALU function is formed by a sum of Boolean products selected by the ALU operation opcode bits as shown in Table 18. For base-set arithmetic opcodes (A=1), the four odd ALU operation bits specify an arithmetic operation as described in Table 19 while the four even bits specify one of the ALU function modifiers as shown in Table 20.

Table 18. Base-Set ALU Boolean Function Codes

OPCODE BIT	PRODUCT TERM
58	A & B & C
57	~A & B & C
56	A & ~B & C
55	~A & ~B & C
54	A & B & ~C
53	~A & B & ~C
52	A & ~B & ~C
51	~A & ~B & ~C

Table 19. Base-Set Arithmetics

OF	PCODE BITS CARRY		CARRY	AL OFFINALO DEGODIRATION	NATURAL	MODIFIED FUNCTION (IF DIFFERENT FROM	
57	55	53	51	IN	ALGEBRAIC DESCRIPTION	FUNCTION	NATURAL FUNCTION)
0	0	0	0	х			
0	0	0	1	1	A – (B C)	A – B <1<	
0	0	1	0	0	A + (B & ~C)	A + B <0<	
0	0	1	1	1	A – C	A – C	
0	1	0	0	1	A – (B ~C)	A – B >1>	(A – (B & C)) if sign=0
0	1	0	1	1	A – B	A – B	
0	1	1	0	C(n)	A – (B & @mf –B & ~@mf)	A + B / A – B	if class 0 or 5
				1/0	A + B	A + B / A – B	if class 1–4 or 6–7, A–B if sign=1
0	1	1	1	1	A – (B & C)	A – B>0>	
1	0	0	0	0	A + (B & C)	A + B>0>	
1	0	0	1	~C(n)	A + (B & @mf -B & ~@mf)	A – B / A + B	if class 0 or 5
				0/1	A – B	A – B / A + B	if class 1–4 or 6–7, A+B if sign=1
1	0	1	0	0	A + B	A + B	
1	0	1	1	0	A + (B ~C)	A + B >1>	(A + (B & C)) if sign=0
1	1	0	0	0	A + C	A + C	
1	1	0	1	1	A – (B & ~C)	A – B <0<	
1	1	1	0	0	A + (B C)	A + B <1<	
1	1	1	1	0	(A & C) + (B & C)	field A + B	

Legend:

C(n) LSB of each part of C port register

>0> Zero-extend shift right<0< Zero-extend shift left>1> One-extend shift right

<1< One-extend shift left



ALU-operation code (continued)

Table 20. Function Modifier Codes

FUNCTION MODIFIER BITS		-	MODIFICATION PERFORMED				
58	56	54	52				
0	0	0	0	Normal operation			
0	0	0	1	cin			
0	0	1	0	%! if maskgen instruction, Imo if not maskgen			
0	0	1	1	%! and cin if maskgen instruction, rmo if not maskgen			
0	1	0	0	A port = 0			
0	1	0	1	A port = 0 and cin			
0	1	1	0	A port = 0 and %! if maskgen, Imbc if not maskgen			
0	1	1	1	A port = 0, %! and cin if maskgen, rmbc if not maskgen			
1	0	0	0	mf bit(s) set by carry out(s). (mc)			
1	0	0	1	mf bit(s) set based on status register MSS field. (me)			
1	0	1	0	Rotate mf by Asize, mf bit(s) set by carry out(s). (mrc)			
1	0	1	1	Rotate mf by Asize, mf bit(s) set based on status register MSS field. (mre)			
1	1	0	0	Clear mf, mf bit(s) set by carry out(s). (mzc)			
1	1	0	1	Clear mf, mf bit(s) set based on status register MSS field. (mze)			
1	1	1	0	No setting of bits in mf register. (mx)			
1	1	1	1	Reserved			

Legend:

 cin
 Carry in from sr(C)
 %!
 Modified mask generator

 Imbc
 Leftmost-bit change
 rmbc
 Rightmost-bit change

 Imo
 Leftmost one
 rmo
 Rightmost one

miscellaneous operation code

For data-unit opcode format E, the operation field selects one of the miscellaneous operations codes as shown in Table 21.

Table 21. Miscellaneous Operation Codes

	OPCODE BITS			,	MNEMONIC	OPERATION
43	42	41	40	39	MINEMONIC	OPERATION
0	0	0	0	0	nop	No data-unit operation. Status not modified
0	0	0	0	1	qwait	Wait until comm Q bit is clear
0	0	0	1	0	eint	Global-interrupt enable
0	0	0	1	1	dint	Global-interrupt disable
0	0	1	0	0	eloop	Global loop enable
0	0	1	0	1	dloop	Global loop disable
0	0	1	1	х	reserved	
0	1	Х	Х	х	reserved	
1	Х	Х	Х	х	reserved	

addressing-mode codes

The Lmode (bits 35–38) and Gmode (bits 13–16) of the opcode specify the local and global transfer for various parallel transfer opcode formats (Lmode in formats 1, 2, 3, 4, and 6 and Gmode in formats 1, 5, and 9). Table 22 shows the coding for the addressing-mode fields.

Table 22. Addressing-Mode Codes

CODING	EXPRESSION	DESCRIPTION
00xx		Nop (nonaddressing mode operation)
0100	*(an ++= xm)	Postaddition of index register, with modify
0101	*(an= xm)	Postsubtraction of index register, with modify
0110	*(an ++= imm)	Postaddition of immediate, with modify
0111	*(an= imm)	Postsubtraction of immediate, with modify
1000	*(an + xm)	Preaddition of index register
1001	*(an – xm)	Presubtraction of index register
1010	*(an + imm)	Preaddition of immediate
1011	*(an – imm)	Presubtraction of immediate
1100	*(an += xm)	Preaddition of index register, with modify
1101	*(an -= xm)	Presubtraction of index register, with modify
1110	*(an += imm)	Preaddition of immediate, with modify
1111	*(an -= imm)	Presubtraction of immediate, with modify

Legend:

an Address register in I/g address unit

imm Immediate offset

xm Index register in same unit as an register

L, e codes

The L and e bits combine to specify the type of parallel transfer performed, as shown in Table 23. For the local transfer, L and e are bits 21 and 31, respectively. For the global transfer, L and e are bits 17 and 9, respectively.

Table 23. Parallel Transfer Type

L	е	PARALLEL TRANSFER
1	0	Zero-extend load
1	1	Sign-extend load
0	0	Store
0	1	Address unit arithmetic

size codes

The size code specifies the data transfer size. For field moves (parallel transfer format 3), only byte and halfword data sizes are valid, as shown in Table 24.

Table 24. Transfer Data Size

CODING	DATA SIZE
00	Byte (8 bits)
01	Halfword (16 bits)
10	Word (32 bits)
11	Reserved



relative-addressing mode codes

The Lrm and Grm opcode fields allow the local-address or global-address units, respectively, to select PP-relative addressing as shown in Table 25.

Table 25. Relative-Addressing Mode Codes

CODING	RELATIVE-ADDRESSING MODE
00	Normal (absolute addressing)
01	Reserved
10	PP-relative dba
11	PP-relative pba

Legend

dba – Data RAM 0 base is base address

pba - Paramater RAM base is base address

condition codes

In the four conditional parallel transfer opcodes (formats 7–10), the condition code field specifies one of 16 condition codes to be applied to the data-unit operation source, data-unit result, or global transfer based on the setting of the c, r, and g bits, respectively. Table 26 shows the condition codes. For the 32-bit immediate data unit opcode (format D), the condition applies to the data-unit result only.

Table 26. Condition Codes

CONDITION BITS		MNEMONIC	DESCRIPTION	STATUS BIT COMBINATION		
35	34	33	32			
0	0	0	0	u	Unconditional (default)	None
0	0	0	1	р	Positive	~N & ~Z
0	0	1	0	ls	Lower than or same	~C Z
0	0	1	1	hi	Higher than	C & ~Z
0	1	0	0	lt	Less than	(N & ~V) (~N & V)
0	1	0	1	le	Less than or equal	(N & ~V) (~N & V) Z
0	1	1	0	ge	Greater than or equal	(N & V) (~N & ~V)
0	1	1	1	gt	Greater than	(N & V & ~Z) (~N & ~V & ~Z)
1	0	0	0	hs, c	Higher than or same, carry	С
1	0	0	1	lo, nc	Lower than, no carry	~C
1	0	1	0	eq, z	Equal, zero	Z
1	0	1	1	ne, nz	Not equal, not zero	~Z
1	1	0	0	V	Overflow	V
1	1	0	1	nv	No overflow	~V
1	1	1	0	n	Negative	N
1	1 1 1 1 nn		nn	Nonnegative	~N	

EALU operations

Extended ALU (EALU) operations allow the execution of more advanced ALU functions than those specified in the base set ALU opcodes. The opcode for EALU instructions contains the operands for the operation while the d0 register extends the opcode by specifying the EALU operation to be performed. The format of d0 for EALU operations is shown in Figure 24.

EALU Boolean functions

EALU operations support all 256 Boolean ALU functions plus the flexibility to add 1 or a carry-in to Boolean sum. The Boolean function performed by the ALU are shown below and in Table 27.

```
      (F0 & (~A & ~B & ~C))
      (F1 & (A & ~B & ~C))
      (F2 & (~A & B & ~C))

      (F3 & (A & B & ~C))
      (F4 & (~A & ~B & C))
      (F5 & (A & ~B & C))

      (F6 & (~A & B & C))
      (F7 & (A & B & C))
      [+1 | +cin]
```

Table 27. EALU Boolean Function Codes

d0 BIT	ALU FUNCTION SIGNAL	PRODUCT TERM
26	F7	A & B & C
25	F6	~A & B & C
24	F5	A & ~B & C
23	F4	~A & ~B & C
22	F3	A & B & ~C
21	F2	~A & B & ~C
20	F1	A & ~B & ~C
19	F0	~A & ~B & ~C

EALU arithmetic functions

EALU operations support all 256 arithmetic functions provided by the three-input ALU plus the flexibility to add 1 or a carry-in to the result. The arithmetic function performed by the ALU is:

$$f(A,B,C) = A \& f1(B,C) + f2(B,C) [+1 | cin]$$

f1(B,C) and f2(B,C) are independent Boolean combinations of the B and C ALU inputs. The ALU function is specified by selecting the desired f1 and f2 subfunction and then XORing the f1 and f2 code from Table 28 to create the ALU function code for bits 19–26 of d0. Additional operations such as absolute values and signed shifts can be performed using d0 bits which control the ALU function based on the sign of one of the inputs.

Table 28. ALU f1(B,C) and f2(B,C) Subfunctions

f1 CODE	f2 CODE	SUBFUNCTION	COMMON USAGE
00	00	0	Zero the term
AA	FF	- 1	-1 (All 1s)
88	CC	В	В
22	33	–B −1	Negate B
A0	F0	С	С
0A	0F	−C −1	Negate C
80	C0	B & C	Force bits in B to 0 where bits in C are 0
2A	3F	–(B & C) – 1	Force bits in B to 0 where bits in C are 0 and negate
A8	FC	B C	Force bits in B to 1 where bits in C are 1
02	03	–(B C) – 1	Force bits in B to 1 where bits in C are 1 and negate
08	0C	B & ~C	Force bits in B to 0 where bits in C are 1
A2	F3	−(B & ~C) −1	Force bits in B to 0 where bits in C are 1 and negate
8A	CF	B ~C	Force bits in B to 1 where bits in C are 0
20	30	–(B ~C) −1	Force bits in B to 1 where bits in C are 0 and negate
28	3C	(B & ~C) ((–B – 1) & C)	Choose B if C = all 0s and -B if C = all 1s
82	C3	(B & C) ((-B - 1) & ~C)	Choose B if C = all 1s and -B if C = all 0s



video controller architecture

The video controller (VC) provides a method for handling the video or graphics capture, or display portions of a TMS320C80 system. It provides simultaneous control over two independent capture or display systems and frame grabber or frame buffer image storage.

VC functional block diagram

Figure 46 shows a functional block diagram of the video controller. Key features of the VC include:

- Dual-frame timers
 - Independent or locked operation
 - Programmable horizontal and vertical timing
 - Separate or composite sync and blanking control
 - Synchronization to external timing signals
 - Interlaced or noninterlaced frame control
 - Virtually limitless screen resolutions
- Programmable timing and control registers
- Programmable line interrupt to MP
- Shift register transfer (SRT) controller
 - Generates VRAM serial register transfer requests to the TC
 - Tracks VRAM tap point and schedules midline reloads
 - Generates packet-transfer requests for DRAM-based buffer updates
 - Supports two display or capture buffers

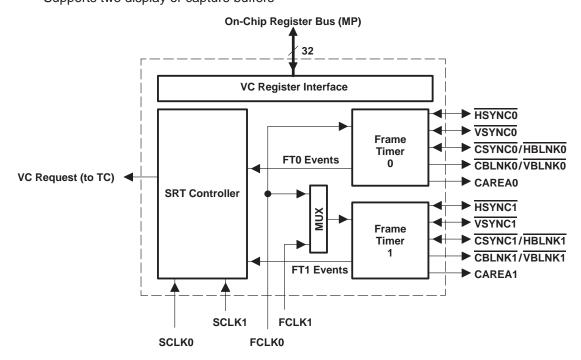


Figure 46. VC Block Diagram



frame-timer registers

Each frame timer has twenty-one 16-bit registers to control its horizontal and vertical timing signals. The registers are on-chip memory-mapped registers accessible by the MP only. Each horizontal/vertical register pair can be accessed as a single 32-bit quantity. The register map for Frame-Timer 0 is shown in Figure 47. The Frame-Timer 1 register map is shown in Figure 48.

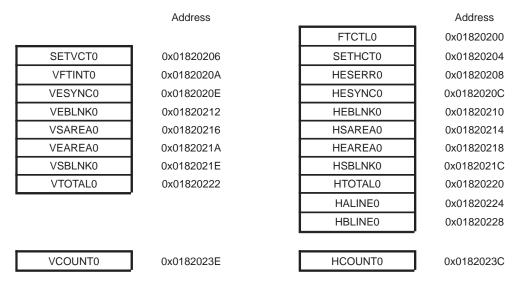


Figure 47. Frame-Timer 0 Register Map

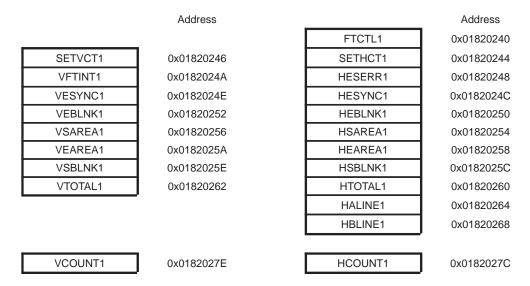


Figure 48. Frame-Timer 1 Register Map

frame-timer register programming

The register format for the frame-timer control registers is shown in Figure 49. All other registers are 16-bit values. For programming details, see the *TMS320C80 Video Controller User's Guide* (literature number SPRU111).



frame-timer control (FTCTLx) register

The FTCTLx register contains mode bits to determine frame-timer behavior.

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0		
FTE	IFD	IIM				SSE	FLE			CF	PM	VF	VPM		PM HPI		PM
											_						
	FTE	Frame	-timer er	able					VPM	VSYN	C Pin Mo	de					
	IFD	Interlaced frame disable								00 – Hi-Z 10 – Output							
	IIM	Interla	ce interru	ıpt mode						01 - Input 11 - Reserved							
	SSE	Set syı	nchroniz	ation ena	ıble				HPM	HSYN	C Pin Mo	de					
	FLE	Frame lock enable 00						00 –	Hi-Z		10 - Out	put					
	CPM	CSYNC/HBLNK pin mode								01 –	Input		11 - Res	erved			
	$00 - \overline{\text{CSYNC}}$ Hi-Z $10 - \overline{\text{CSYNC}}$ output																
01 – CSYNC input 11 – HBLNK output																	

Figure 49. FTCTLx Register

SRT controller registers

The SRT controller has two sets of 32-bit registers, one for each of the supported frame memory regions. The location of these registers in on-chip memory-mapped register space is shown in Figure 50.

	Address		Address
FMEMCTL0	0x01820300	FMEMCTL1	0x01820340
F1STADR0	0x01820304	F1STADR1	0x01820344
F0STADR0	0x01820308	F0STADR1	0x01820348
LINEINC0	0x0182030C	LINEINC1	0x0182034C
SAMMASK0	0x01820310	SAMMASK1	0x01820350
NEXTADR0	0x01820314	NEXTADR1	0x01820354
	_		_
CRNTADR0	0x0182033C	CRNTADR1	0x0182037C

Figure 50. SRT Controller Register Map

SRT controller register programming

The register format for the frame memory control registers is shown in Figure 51. All other registers are 32-bit values. For programming details, see the *TMS320C80 Video Controller User's Guide* (literature number SPRU111).

FMEMCTLx Register

The frame memory control (FMEMCTLx) register contains mode bits to determine operation of the associated frame memory.

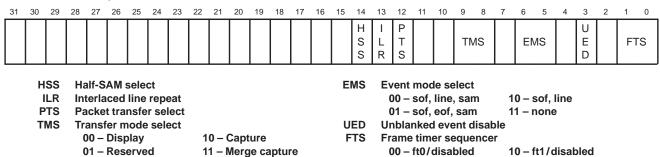


Figure 51. FMEMCTLx Register

01 - ft0/enabled

11 - ft1/enabled



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TC architecture

The transfer controller (TC) is a combined memory controller and DMA (direct memory access) machine. It handles the movement of data within the 'C80 system as requested by the master processor, parallel processors, video controller, and external devices. The transfer controller performs the following data movement and memory control functions:

- MP and PP instruction cache fills
- MP data cache fills and dirty block write-back
- MP and PP direct external accesses (DEAs)
- MP and PP packet transfers
- Externally initiated packet transfers (XPTs)
- VC packet transfers (VCPTs)
- VC shift register transfers (SRTs)
- DRAM/SDRAM refresh
- Host bus request

TC functional block diagram

Figure 52 shows a functional block diagram of the transfer controller. Key features of the TC include:

- Crossbar interface
 - 64-bit data path
 - Single-cycle access
- External memory interface
 - 4G-Byte address range
 - Dynamically configurable memory cycles

8-, 16-, 32-, or 64-bit bus size Selectable memory page size Selectable address multiplexing Selectable cycle timing

- Big- or little-endian operation
- Cache, VRAM, refresh controller
 - Programmable refresh rate
 - VRAM block write support
- Independent Src and Dst addressing
 - Autonomous addressing based on packet-transfer parameters
 - Data read and write at different rates
 - Numerous data merging and alignment functions performed during transfer
- Intelligent request prioritization



TC functional block diagram (continued)

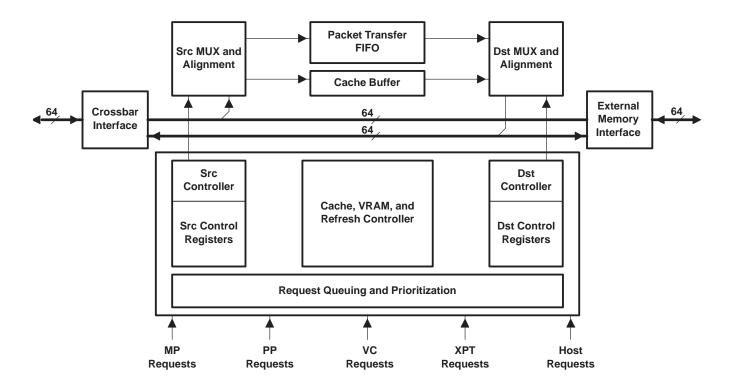


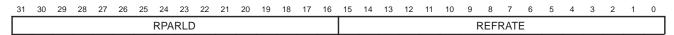
Figure 52. TC Block Diagram

TC registers

The TC contains four on-chip memory-mapped registers accessible by the MP. TC registers are shown in Figure 53.

refresh control (REFCNTL) register (0x01820000)

The REFCNTL register controls refresh cycles.



RPARLD Refresh Pseudo-Address Reload Value

REFRATE Refresh Interval (in clock cycles)

Figure 53. REFCNTL Register

packet-transfer minimum (PTMIN) register (0x01820004)

The PTMIN register determines the minimum number of cycles that a packet transfer executes before being suspended by a higher priority packet transfer. Figure 54 shows the PTMIN register.



Figure 54. PTMIN Register



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PT maximum (PTMAX) register (0x01820008)

The PTMAX register determines the maximum number of cycles after PTMIN has elapsed that a packet transfer executes before timing out. Figure 55 showns the format of the PTMAX register.



Figure 55. PTMAX Register

fault status (FLTSTS) register (0x0182000C)

The FLTSTS register indicates the cause of a memory access fault. Fault status bits are cleared by writing a 1 to the appropriate bit. Figure 56 shows the format of the fault status (FLTSTS) register.

31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
				Р	Р	Р	Р					Р	Р	Р	Р										VDT						
				С	С	С	С					Р	Р	Р	Р										XPT						M
_																															
		Р	P #	3	2	1	0			Р	P#	3	2	1	0																
		РС	PI	⊃х С	ache	e / DI	EA F	ault								Х	(PT	Fa	aultir	ng XI	PΤ										
		PP	PI	Рх Р	acke	t-Tra	ansfe	er Fa	ult								M			_	t-Trai	nsfe	r Fau	ult							

Figure 56. FLTSTS Register

packet-transfer parameters

The most efficient method for data movement in a TMS320C80 system is through the use of packet transfers (PTs). Packet transfers allow the TC to move blocks of data autonomously between a specified src and dst memory region. Requests for the TC to execute a packet transfer may be made by the MP, PPs, VC, or external devices. A packet-transfer parameter table describing the data packet and how it is to be transferred must be programmed in on-chip memory before the transfer is requested. The parameter table formats for long-form and short-form packet transfers are shown in Figure 57.

packet-transfer parameters (continued)

Byte Address	Long-Form P	arameter Table	0	Word Number					
PT	Next Enti	0							
PT+4	PT O	ptions		1					
PT+8	Src Star	t Address		0					
PT+12	Dst Star	t Address		1					
PT+16	Src B Count	Src A Count		0					
PT+20	Dst B Count	Dst A Count		1					
PT+24	Src C	0							
PT+28	Dst C	1							
PT+32	Src E	3 Pitch		0					
PT+36	Dst E	3 Pitch		1					
PT+40	Src (C Pitch		0					
PT+44	Dst 0	C Pitch		1					
†PT+48	Transparenc	Transparency/Color Word 0							
†PT+52	Transparenc	1†							
PT+56	Don'	0							
PT+60	Don'	1							

Byte Address	Short-Form F	Short-Form Parameter Table 0								
PT	Next Ent	Next Entry Address								
PT+4	PT Options	Count		1						
PT+8	Src Star	Src Start Address								
PT+12	PT+12 Dst Start Address									

PT - 16-byte aligned on-chip starting address of parameter table.

Figure 57. Packet-Transfer Parameter Table

PT - 64-byte aligned on-chip starting address of parameter table.

[†] These words are swapped in big-endian mode.

01 - Suspended

Reverse Addressing

Stop Bit

RA

PT-options field

The PT-options field of the parameter table controls the type of src and dst transfer that the TC performs. The formats of the options field for long-form and short-form packet transfers are shown in Figure 58.

Long-Form PT Options 18 17 16 14 13 12 11 10 30 29 28 25 24 23 22 21 20 19 15 9 R R R R S S C S B S PTS D D PAM STM DTM DUM Χ F В S Stop Bit PAM PT Access Mode PTS PT Status 000 - Normal 100 - 8-Bit Transparency 001 - PDT 00 - Active 10 - Fault on Src 101 – 16-Bit Transparency 01 - Suspended 11 - Fault on Dst 010 - Block Write 110 - 32-Bit Transparency Stop Bit 011 - SRT 111 - 64-Bit Transparency RDC Reverse Dst C Addressing STM/DTM Src/Dst Transfer Mode RDB Reverse Dst B Addressing 000 - Dimensioned 100 - Variable, Delta-Guided 101 - Variable, RA Reverse A Addressing 001 - Fill (Src Only) Reverse Src C Addressing Offset-Guided RSC **RSB** Reverse Src B Addressing 010 - Reserved 110 - Fixed, Delta-Guided SF Short Form 011 - LUT (Src Only) 111 - Fixed, Offset-Guided Exchange Src and Dst Parameters SUM/DTM X Src/Dst Update Mode 00 - None 01 - Add C Pitch 01 – Add B Pitch 11 - Add C Pitch/Reverse **Short-Form PT Options** 18 17 16 15 14 13 12 11 10 9 30 29 27 23 22 21 20 19 3 2 1 0 26 S S PTS PAM Count S Stop Bit RA Reverse Addressing PTS PT Status Exchange Src & Dst Parameters Χ 00 - Active 10 - Fault on Src PAM PT Access Mode

Figure 58. PT-Options Field

000 - Normal

010 - Reserved

001 - PDT

011 - SRT

100 - Reserved

101 - Reserved

110 - Reserved

111 - Reserved

11 - Fault on Dst

LOCAL MEMORY INTERFACE

status codes

Status codes are output on STATUS[5:0] to describe the cycle being performed. During row time, the STATUS[5:0] pins indicate the type of cycle being performed. The cycle type can be latched using \overline{RL} or \overline{RAS} and used by external logic to perform memory bank decoding or to enable special hardware features. During column time, the STATUS[5:0] pins indicate the requesting processor or special column information. See Table 29 for a listing of the Row-time status codes and Table 30 for a listing of column-time status codes.

Table 29. Row-Time Status Codes

	ST	ΑΤΙ	JS	5:0)]	CYCLE TYPE	
0	0	0	0	0	0	Normal Read	1
0	0	0	0	0	1	Normal Write	1
0	0	0	0	1	0	Refresh	1
0	0	0	0	1	1	SDRAM DCAB	1
0	0	0	1	0	0	Peripheral Device PT Read	1
0	0	0	1	0	1	Peripheral Device PT Write	1
0	0	0	1	1	0	Reserved	1
0	0	0	1	1	1	Reserved	1
0	0	1	0	0	0	Reserved	1
0	0	1	0	0	1	Block Write PT	1
0	0	1	0	1	0	Reserved	1
0	0	1	0	1	1	Reserved	1
0	0	1	1	0	0	SDRAM MRS	1
0	0	1	1	0	1	Load Color Register	1
0	0	1	1	1	0	Reserved	1
0	0	1	1	1	1	Reserved	1
0	1	0	0	0	0	Frame 0 Read Transfer	1
0	1	0	0	0	1	Frame 0 Write Transfer	1
0	1	0	0	1	0	Frame 0 Split Read Transfer	1
0	1	0	0	1	1	Frame 0 Split Write Transfer	1
0	1	0	1	0	0	Frame 1 Read Transfer	1
0	1	0	1	0	1	Frame 1 Write Transfer	1
0	1	0	1	1	0	Frame 1 Split Read Transfer	1
0	1	0	1	1	1	Frame 1 Split Write Transfer	1
0	1	1	0	0	0	Reserved	1
0	1	1	0	0	1	Reserved	1
0	1	1	0	1	0	Reserved	1
0	1	1	0	1	1	Reserved	1
0	1	1	1	0	0	PT Read Transfer	1
0	1	1	1	0	1	PT Write Transfer	1
0	1	1	1	1	0	Reserved	1
0	1	1	1	1	1	Idle	1

	ST	ΑTI	JS	5:0]	CYCLE TYPE							
1	0	0	0	0	0	Reserved							
1	0	0	0	0	1	Reserved							
1	0	0	0	1	0	Reserved							
1	0	0	0	1	1	Reserved							
1	0	0	1	0	0	XPT1 Read							
1	0	0	1	0	1	XPT1 Write							
1	0	0	1	1	0	XPT1 PDPT Read							
1	0	0	1	1	1	XPT1 PDPT Write							
1	0	1	0	0	0	XPT2 Read							
1	0	1	0	0	1	XPT2 Write							
1	0	1	0	1	0	XPT2 PDPT Read							
1	0	1	0	1	1	XPT2 PDPT Write							
1	0	1	1	0	0	XPT3 Read							
1	0	1	1	0	1	XPT3 Write							
1	0	1	1	1	0	XPT3 PDPT Read							
1	0	1	1	1	1	XPT3 PDPT Write							
1	1	0	0	0	0	XPT4/SAM1 Read							
1	1	0	0	0	1	XPT4/SAM1 Write							
1	1	0	0	1	0	XPT4/SAM1 PDPT Read							
1	1	0	0	1	1	XPT4/SAM1 PDPT Write							
1	1	0	1	0	0	XPT5/SOF1 Read							
1	1	0	1	0	1	XPT5/SOF1 Write							
1	1	0	1	1	0	XPT5/SOF1 PDPT Read							
1	1	0	1	1	1	XPT5/SOF1 PDPT Write							
1	1	1	0	0	0	XPT6/SAM0 Read							
1	1	1	0	0	1	XPT6/SAM0 Write							
1	1	1	0	1	0	XPT6/SAM0 PDPT Read							
1	1	1	0	1	1	XPT6/SAM0 PDPT Write							
1	1	1	1	0	0	XPT7/SOF0 Read							
1	1	1	1	0	1	XPT7/SOF0 Write							
1	1	1	1	1	0	XPT7/SOF0 PDPT Read							
1	1	1	1	1	1	XPT7/SOF0 PDPT Write							

status codes (continued)

Table 30. Column-Time Status Codes

T;	STA	ΛTL	JS[5:0]	CYCLE TYPE
0	0	0	0	0	0	PP0 Low Priority Packet Transfer
0	0	0	0	0	1	PP0 High Priority Packet Transfer
0	0	0	0	1	0	PP0 Instruction Cache
0	0	0	0	1	1	PP0 DEA
0	0	0	1	0	0	PP1 Low Priority Packet Transfer
0	0	0	1	0	1	PP1 High Priority Packet Transfer
0	0	0	1	1	0	PP1 Instruction Cache
0	0	0	1	1	1	PP1 DEA
0	0	1	0	0	0	PP2 Low Priority Packet Transfer
0	0	1	0	0	1	PP2 High Priority Packet Transfer
0	0	1	0	1	0	PP2 Instruction Cache
0	0	1	0	1	1	PP2 DEA
0	0	1	1	0	0	PP3 Low Priority Packet Transfer
0	0	1	1	0	1	PP3 High Priority Packet Transfer
0	0	1	1	1	0	PP3 Instruction Cache
0	0	1	1	1	1	PP3 DEA
0	1	0	0	0	0	MP Low Priority Packet Transfer
0	1	0	0	0	1	MP High Priority Packet Transfer
0	1	0	0	1	0	MP Urgent Packet Transfer (Low)
0	1	0	0	1	1	MP Urgent Packet Transfer (High)
0	1	0	1	0	0	XPT/VCPT in Progress
0	1	0	1	0	1	XPT/VCPT Complete
0	1	0	1	1	0	MP Instruction Cache (Low)
0	1	0	1	1	1	MP Instruction Cache (High)
0	1	1	0	0	0	MP DEA (Low)
0	1	1	0	0	1	MP DEA (High)
0	1	1	0	1	0	MP Data Cache (Low)
0	1	1	0	1	1	MP Data Cache (High)
0	1	1	1	0	0	Frame 0
0	1	1	1	0	1	Frame 1
0	1	1	1	1	0	Refresh
0	1	1	1	1	1	Idle

	ST	ΑΤΙ	JSĮ	5:0]	CYCLE TYPE
1	0	0	0	0	0	Reserved
1	0	0	0	0	1	Reserved
1	0	0	0	1	0	Reserved
1	0	0	0	1	1	Reserved
1	0	0	1	0	0	Reserved
1	0	0	1	0	1	Reserved
1	0	0	1	1	0	Reserved
1	0	0	1	1	1	Reserved
1	0	1	0	0	0	Reserved
1	0	1	0	0	1	Reserved
1	0	1	0	1	0	Reserved
1	0	1	0	1	1	Reserved
1	0	1	1	0	0	Reserved
1	0	1	1	0	1	Reserved
1	0	1	1	1	0	Reserved
1	0	1	1	1	1	Reserved
1	1	0	0	0	0	Reserved
1	1	0	0	0	1	Reserved
1	1	0	0	1	0	Reserved
1	1	0	0	1	1	Reserved
1	1	0	1	0	0	Reserved
1	1	0	1	0	1	Reserved
1	1	0	1	1	0	Reserved
1	1	0	1	1	1	Reserved
1	1	1	0	0	0	Reserved
1	1	1	0	0	1	Reserved
1	1	1	0	1	0	Reserved
1	1	1	0	1	1	Reserved
1	1	1	1	0	0	Reserved
1	1	1	1	0	1	Reserved
1	1	1	1	1	0	Reserved
1	1	1	1	1	1	Write Drain / SDRAM DCAB

Low – MP operating in low (normal) priority mode High – MP operating in high priority mode



address multiplexing

To support various RAM devices, the TMS320C80 can provide multiplexed row and column addresses on its address bus. A full 32-bit address is always output at row time. The alignment of column addresses is configured by the value input on the AS[2:0] pins at row time (see Figure 59).

18 17 16 15 14 13 12 11 10 23 22 21 20 19 30 17 16 15 14 13 12 11 28 27 26 25 24 23 22 21 20 19 18 10 9 8 7 6 5 4 **Row Time**

A[31:0] Pins

AS [2:0]	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
000	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
001	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	х	Х	х	х	Х	2	1	0
010	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	х	х	Х	х	х	Х	2	1	0
011	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	х	х	х	Х	х	х	Х	2	1	0
100	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	х	х	х	х	Х	х	х	х	2	1	0
101	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	х	х	х	х	х	х	х	х	х	2	1	0
110	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	х	х	х	х	х	х	х	х	х	х	2	1	0
111	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	х	х	х	х	х	х	х	х	х	х	х	2	1	0

Column Time

Figure 59. Address Multiplexing

dynamic bus sizing

The 'C80 supports data bus sizes of 8, 16, 32, or 64 bits as shown in Table 31. The value input on the BS[1:0] pins at row time indicates the bus size of the addressed memory. This determines the maximum number of bytes which the 'C80 can transfer during each column access. If the number of bytes to be transferred exceeds the bus size, multiple accesses are performed automatically to complete the transfer.

Table 31. Bus Size Selection

BS[1:0]	BUS SIZE
0 0	8 bits
0 1	16 bits
1 0	32 bits
11	64 bits

The selected bus size also determines which portion of the data bus is used for the transfer. For 64-bit memory, the entire data bus is used. For 32-bit memory, D[31:0] are used in little-endian mode and D[63:32] are used in big-endian mode. 16-bit buses use D[15:0] and D[63:48] and 8-bit buses use D[7:0] and D[63:56] for little-and big-endian modes, respectively. The 'C80 always aligns data to the proper portion of the bus and activates the appropriate CAS/DQM strobes to ensure that only valid bytes are transferred.

cycle time selection

The 'C80 supports eight basic sets of memory timings to support various memory types directly. The cycle timing is selected by the value input on the CT[2:0] and UTIME pins at row time. The selected timing remains in effect until the next row access. See Table 32 for Cycle-timing selections.

Table 32. Cycle-Timing Selection

UTIME	(T[2:0	0]	MEMORY TIMING
0	0	0	0	Reserved
0	0	0 0 1 8		SDRAM: burst length 1, read latency 4
0	0	1	0	Reserved
0	0	1	1	SDRAM: burst length 2, read latency 4
0	1	0	0	User timed DRAM: pipelined 1 cycle/column
0	1	0	1	User timed DRAM: 1 cycle/column
0	1	1	0	User timed DRAM: 2 cycle/column
0	1	1	1	User timed DRAM: 3 cycle/column
1	0	0	0	SDRAM: burst length 1, read latency 2
1	0	0	1	SDRAM: burst length 1, read latency 3
1	0	1	0	SDRAM: burst length 2, read latency 2
1	0	1	1	SDRAM: burst length 2, read latency 3
1	1	0	0	DRAM: pipelined 1 cycle/column
1	1	0	1	DRAM: 1 cycle/column
1	1	1	0	DRAM: 2 cycle/column
1	1	1	1	DRAM: 3 cycle/column

page sizing

Whenever an external memory access occurs, the TC records the 26 most significant bits of the address in its internal LASTPAGE register. The address of each subsequent (column) access is compared to this value. The page size value input on the PS[3:0] pins determines which bits of LASTPAGE are used for this comparison. If a difference exists between the enabled LASTPAGE bits and the corresponding bits of the next access then the page has changed and the next memory access begins with a new row-address cycle (see Table 33).

page sizing (continued)

Table 33. Page-Size Selection

PS[3:0]	ADDRESS BITS COMPARED	PAGE SIZE (BYTES)
0 0 0 0	A(31:6)	64
0 0 0 1	A(31:7)	128
0 0 1 0	A(31:8)	256
0 0 1 1	A(31:9)	512
0 1 0 0	A(31:10)	1K
0 1 0 1	A(31:18)	256K
0 1 1 0	A(31:19)	512K
0 1 1 1	A(31:20)	1M
1 0 0 0	A(31:0)	1–8†
1 0 0 1	A(31:11)	2K
1 0 1 0	A(31:12)	4K
1 0 1 1	A(31:13)	8K
1 1 0 0	A(31:14)	16K
1 1 0 1	A(31:15)	32K
1 1 1 0	A(31:16)	64K
1 1 1 1	A(31:17)	128K

[†] PS[3:0] = 1000 disables page-mode cycles so that the effective page size is the same as the bus size

block write support

The TMS320C80 supports three modes of VRAM block write. The block-write mode is dynamically selectable so that software may specify block writes without knowing what type of block write the addressed memory supports. Block writes are supported only for 64-bit buses. During block-write and load-color-register cycles, the BS[1:0] inputs determine which block mode will be used (see Table 34).

Table 34. Block-Write Selection

BS[1:0]	BLOCK-WRITE MODE
0 0	Simulated
0 1	Reserved
1 0	4x
1 1	8x

SDRAM support

The TMS320C80 provides direct support for synchronous DRAM (SDRAM), VRAM (SVRAM), and graphics RAM (SGRAM). During 'C80 power-up refresh cycles, the external system must signal the presence of these memories by inputting a CT2 value of 0. This causes the 'C80 to perform special deactivate (DCAB) and mode register set (MRS) commands to initialize the synchronous RAMs. Figure 60 shows the MRS value generated by the 'C80. Note that read latency 4 timing programs the mode register for a read latency of 3. See Figure 60 for a listing of MRS values.

SDRAM support (continued)

SDRAM Mode Register Bit	11	10	9	8	7	6	5	4	3	2	1	0
Meaning			WB	0	0		Read Laten	су	S/I	Bu	rst Le	ngth
Value	0	0	0	0	0	!(UTIME)	UTIME	UTIME&CT0	0	0	0	CT1

UTIME, CT0, CT1 values as input at the start of the MRS cycle

Figure 60. MRS Value

Because the MRS register is programmed through the SDRAM address inputs, the alignment of the MRS data to the 'C80 logical-address bits is adjusted for the bus size (see Figure 61). The appearance of the MRS bits on the 'C80 physical-address bus is dependent on the address multiplexing as selected by the AS[2:0] inputs.

		'C80 LOGICAL ADDRESS BITS														
BS[1:0]	A15	A14	A13	A12	A11	A10	A9	A8	Α7	A6	A5	A4	А3	A2	A 1	A0
0 0	Х	Х	Х	Χ	11	10	9	8	7	6	5	4	3	2	1	0
0 1	Х	Х	Х	11	10	9	8	7	6	5	4	3	2	1	0	Х
1 0	Х	Х	11	10	9	8	7	6	5	4	3	2	1	0	Х	Х
1 1	Х	11	10	9	8	7	6	5	4	3	2	1	0	Х	Х	Х

Figure 61. MRS Value Alignment

memory cycles

TMS320C80 external memory cycles are generated by the TC's external memory controller. The controller's state machine generates a sequence of states which define the transition of the memory interface signals. The state sequence is dependent on the cycle timing selected for the memory access being performed as shown in Figure 62. Memory cycles consist of row states and the column pipeline (see Figure 62).



memory cycles (continued)

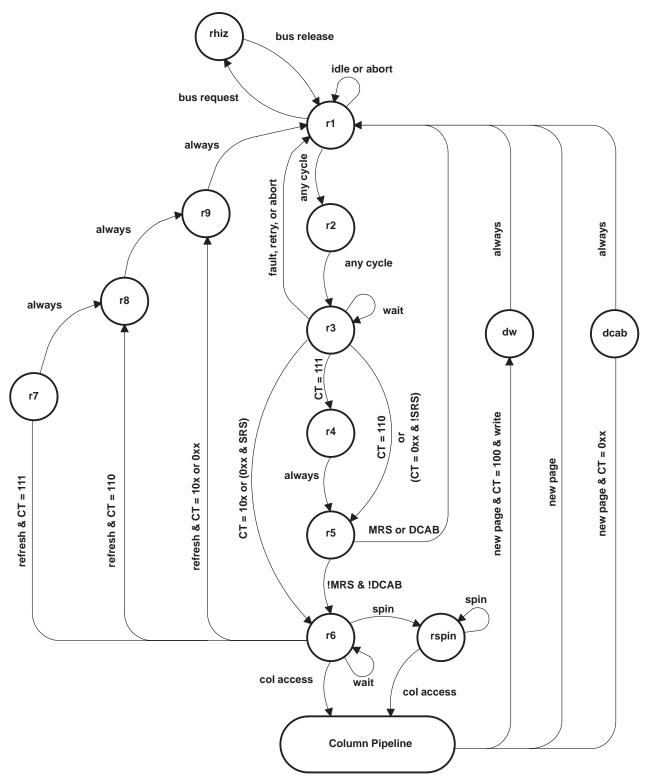


Figure 62. Memory Cycle State Diagram



row states

The row states make up the row time of each memory access. They occur when each new page access begins. The transition indicators determine the conditions that cause transitions to another state. See Table 35 and Table 36.

Table 35. Row States

STATE	DESCRIPTION
r1	Beginning state for all memory accesses. Outputs row address (A[31:0]) and cycle type (STATUS[5:0]) and drives control signals to their inactive state
r2	Common to all memory accesses. Asserts RL and drives DDIN according to the data transfer direction. AS[2:0], BS[1:0], CT[2:0], PS[3:0] and UTIME inputs are sampled
r3	Common to all memory accesses. DBEN is driven to its active level. For non-SDRAM, W, TRG/CAS, and DSF are driven to their active levels and for non-SDRAM refreshes, all CAS/DQM strobes are activated. FAULT, READY, and RETRY inputs are sampled.
r4	Inserted for 3 cycle/column accesses (CT=111) only. No signal transitions occur. RETRY input is sampled.
r5	Common to SDRAM and 2 or 3 cycle/column accesses (CT=0xx or 11x). RAS is driven low. W is driven low for DCAB and MRS cycles and TRG/CAS is driven low for MRS and SDRAM refresh cycles.
r6	Common to all memory accesses. For SDRAM cycles, RAS, TRG/CAS, and W are driven high. For non-SDRAM, RAS is driven low (if not already) and W, TRG / CAS, and DSF are driven to their appropriate levels. DBEN is driven low and READY and RETRY are sampled.
rspin	Additional state to allow TC column time pipeline to load. No signal transitions occur. RETRY is sampled. The rspin state can, on occasion, repeat multiple times.
r7	Common to 2 and 3 cycle / column refreshes (CT=11x). Processor activity code is output on STATUS[5:0]. RETRY input is sampled.
r8	For 3 cycle / column refreshes only (CT=111). No signal transitions occur. RETRY input is sampled.
r9	Common to all refresh cycles. Processor activity code is output on STATUS[5:0] and RETRY input is sampled.
dw	Occurs for pipelined 1 cycle/column writes only. All CAS/DQM strobes are activated.
dcab	Occurs for SDRAM cycles (CT = 0xx). \overline{RAS} and \overline{W} are activated to perform a DCAB command.
rhiz	High impedance state. Occurs during host requests and repeats until bus is released by the host

Table 36. State Transition Indicators

INDICATOR	DESCRIPTION
any cycle	Continuation of current cycle
CT=xxx	State change occurs for indicated CT[2:0] value (as latched in r2 state)
abort	Current cycle aborted by TC in favor of higher priority cycle
fault	FAULT input sampled low (in r3 state), memory access faulted
retry	RETRY input sampled low (in r3 state), row-time retry
wait	READY input sampled low (in r3, r6, or last column state) repeat current state
spin	Internally generated wait state to allow TC pipeline to load
new page	The next access requires a page change (new row access).

external memory timing examples

The following sections contain descriptions of the 'C80 memory cycles and illustrate the signal transitions for those cycles. Memory cycles may be separated into two basic categories; DRAM-type cycles for use with DRAM-like devices, SRAM, and peripherals, and SDRAM-type cycles for use with SDRAM-like devices.



DRAM-type cycles

The DRAM-type cycles are page-mode accesses consisting of a row access followed by one or more column accesses. Column accesses may be one, two, or three clock cycles in length with two and three cycle accesses allowing the insertion of wait states to accommodate slow devices. Idle cycles can occur after necessary column accesses have completed or between column accesses due to "bubbles" in the TC data-flow pipeline. The pipeline diagrams in Figure 63 show the pipeline stages for each access type and when the CAS/DQM signal corresponding to the column access is activated.

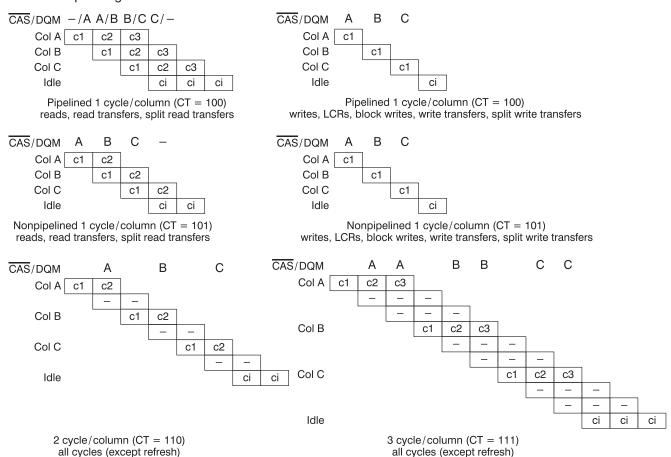


Figure 63. DRAM Cycle Column Pipelines

read cycles

Read cycles transfer data or instructions from external memory to the <u>'C80</u>. The cycles can occur as a result of a packet transfer, cache request, or DEA request. During the cycle, \overline{W} is held high, $\overline{TRG}/\overline{CAS}$ is driven low after \overline{RAS} to enable memory output drivers and \overline{DDIN} is low so that data transceivers drive into the 'C80. The TC places D[63:0] in high impedance allowing it to be driven by the memory and latches input data during the appropriate column state. The TC always reads 64 bits and extracts and aligns the appropriate bytes. Invalid bytes for bus sizes of less than 64 bits are discarded. During peripheral device packet transfers, \overline{DBEN} remains high. Read cycles are shown in Figure 64 through Figure 67.

DDIN

UTIME XX

RAS

CAS/DQM[7:0]

For user-modified timing:

read cycles (continued) State col col c2 col c3 col col col Col A с1 c₃ Col B с1 c2 Col C с1 c2 c3 Col D с1 c2 c3 **CLKOUT** CT[2:0] AS[2:0] BS[1:0] PS[3:0] UTIME FAULT READY RETRY STATUS[5:0] Cycle Type PAC PAC PAC PAC Idle RL A[31:0] Col A Col B Col C Col D Row RAS B/C C/D D/-A/B -/A CAS/DQM[7:0] DSF TRG/CAS D[63:0] DBEN 0 For Normal Reads, 1 For PDPT Reads

Figure 64. Pipelined 1 Cycle/Column Read-Cycle Timing

-/A

A/B

B/C

C/D

D/-



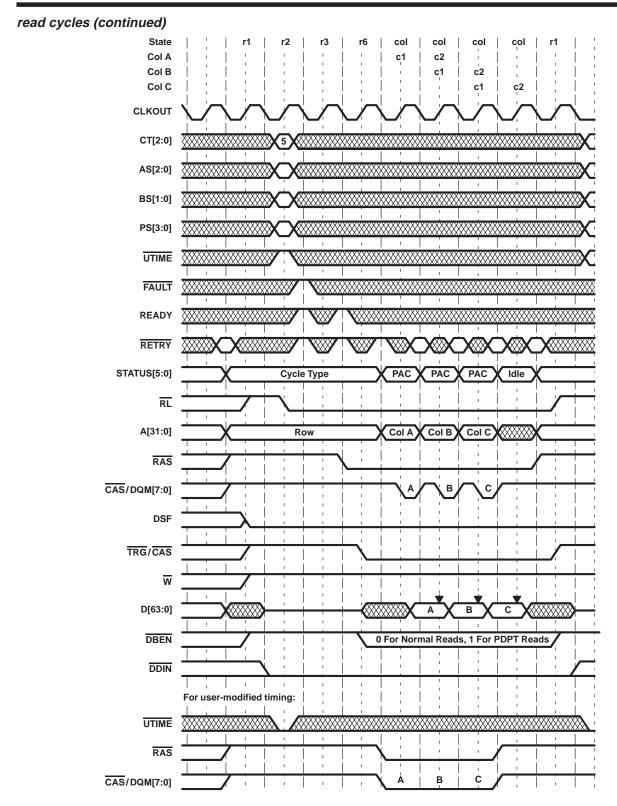
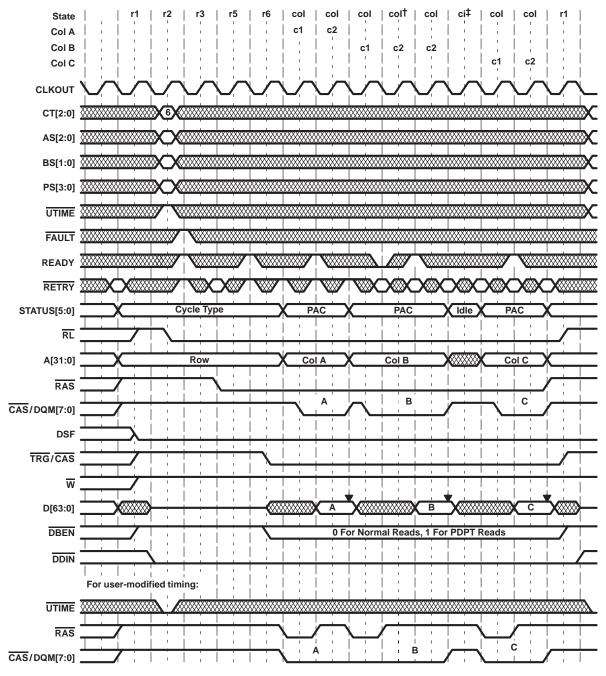


Figure 65. Nonpipelined 1 Cycle/Column Read-Cycle Timing



read cycles (continued)

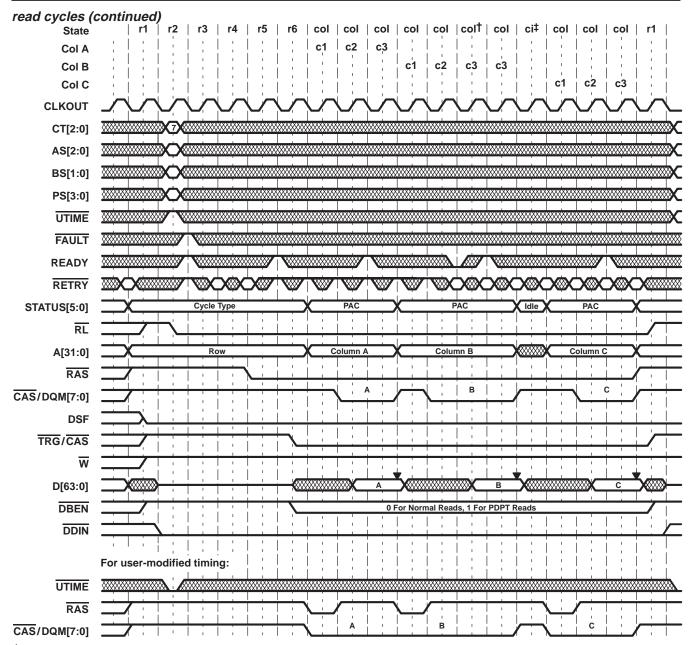


[†] Wait state inserted by external logic (example)

Figure 66. 2 Cycles/Column Read-Cycle Timing



[‡] Internally generated pipeline bubble (example)



[†] Wait state inserted by external logic (example)

Figure 67. 3 Cycles/Column Read-Cycle Timing

write cycles

Write cycles transfer data from the 'C80 to external memory. These cycles can occur as a result of a packet transfer, a DEA request, or an MP data cache write-back. During the cycle $\overline{TRG}/\overline{CAS}$ is held high, \overline{W} is driven low after the fall of \overline{RAS} to enable early-write cycles, and \overline{DDIN} is high so that data transceivers drive toward memory. The TC drives data out on D[63:0] and indicates valid bytes by activating the appropriate \overline{CAS}/DQM strobes. During peripheral device packet transfers, \overline{DBEN} remains high and D[63:0] is placed in high impedance so that the peripheral device can drive data into the memory. Write cycles are shown in Figure 68 through Figure 71.



[‡] Internally generated pipeline bubble (example)

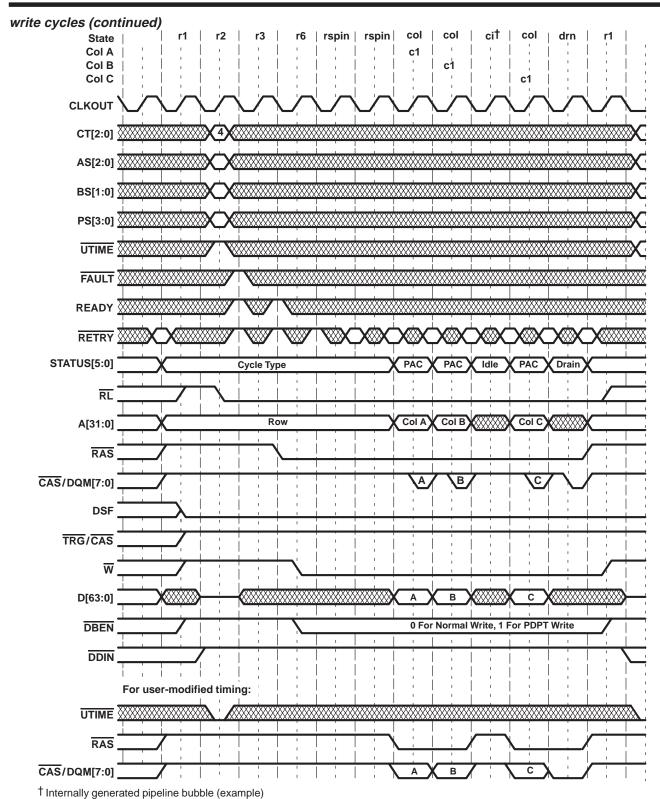


Figure 68. Pipelined 1 Cycle/Column Write-Cycle Timing



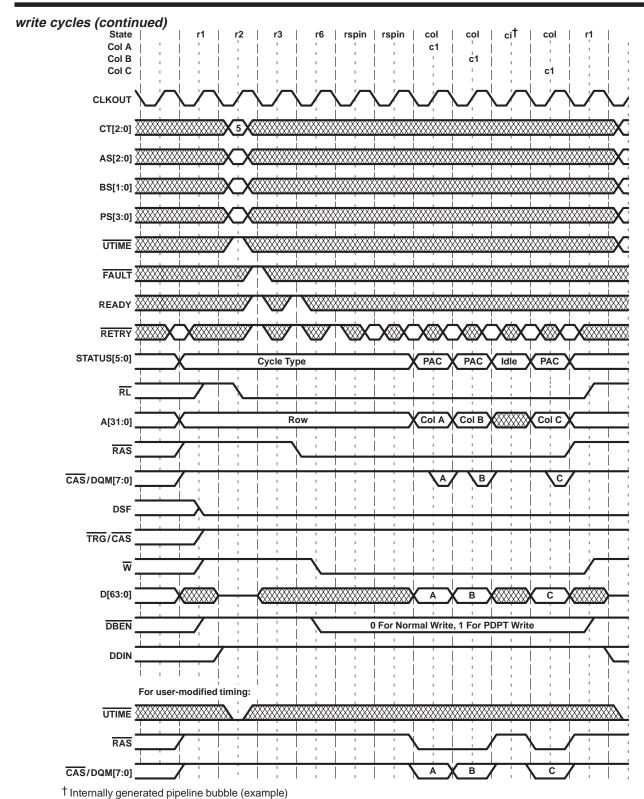
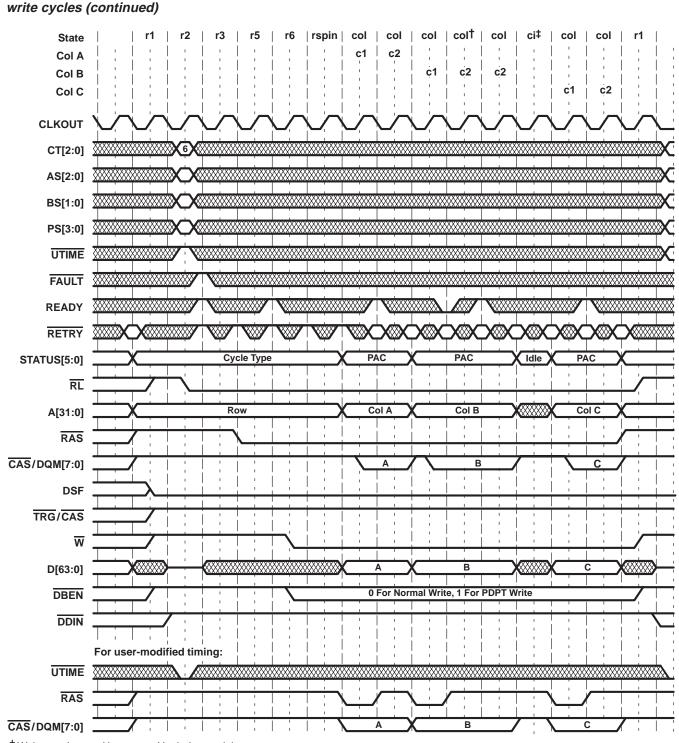


Figure 69. Nonpipelined 1 Cycle/Column Write-Cycle Timing



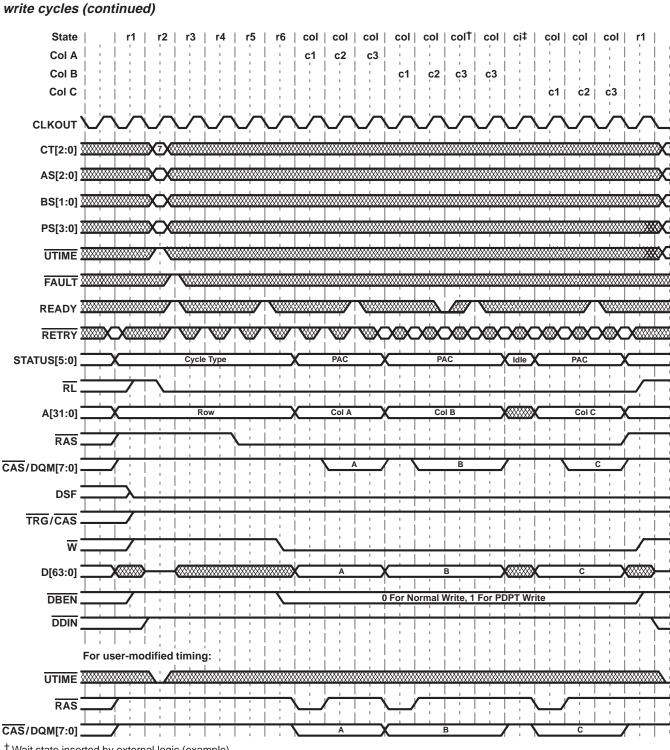


[†]Wait state inserted by external logic (example)

Figure 70. 2 Cycles/Column Write-Cycle Timing



[‡] Internally generated pipeline bubble (example)



[†] Wait state inserted by external logic (example)

Figure 71. 3 Cycles/Column Write-Cycle Timing



[‡] Internally generated pipeline bubble (example)

TMS320C80 DIGITAL SIGNAL PROCESSOR

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load-color-register cycles

Load-color-register (LCR) cycles are used to load a VRAM's color register prior to performing a block write. LCR cycles are supported only on 64-bit data buses. An LCR cycle closely resembles a normal write cycle because it writes into a VRAM. The difference is that the DSF output is high at both the fall of \overline{RAS} and the fall of \overline{CAS}/DQM . Also, because the VRAM color register is a single location, only one column access occurs.

The row address that is output by the TC is used for bank decode only. Normally all VRAM banks should be selected during an LCR cycle because another LCR cycle will not occur when a block-write memory page change occurs. The column address that is output during an LCR is likewise irrelevant because the VRAM color register is the only location written. All \overline{CAS}/DQM strobes are active during an LCR cycle.

The RETRY input is sampled during LCR column states and must be valid high or low. Asserting RETRY at column time has no effect, however, because only one column access is performed.

If the BS[1:0] inputs indicate that the addressed memory supports only simulated block writes, the LCR cycle will be changed into a normal write cycle at the start of the simulated block write. Load color register cycles timing is shown in Figure 72 through Figure 75.



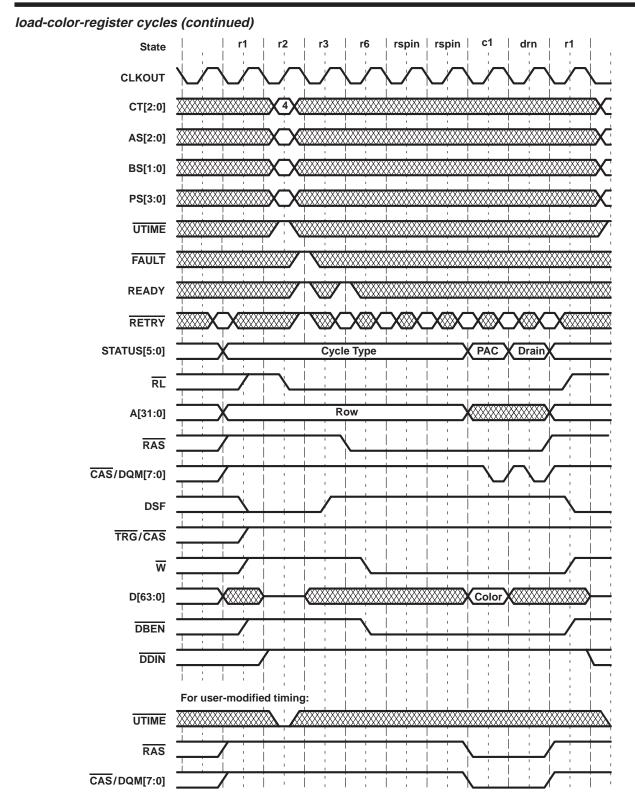


Figure 72. Pipelined 1 Cycle/Column Load-Color-Register-Cycle Timing



load-color-register cycles (continued)

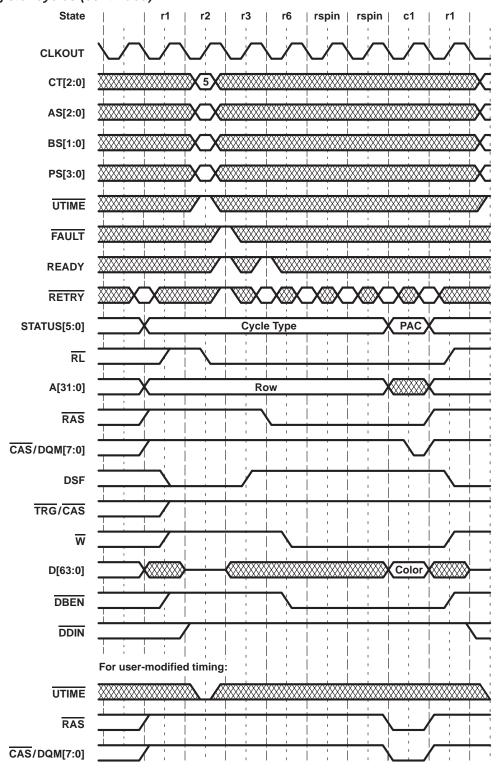


Figure 73. Nonpipelined 1 Cycle/Column Load-Color-Register-Cycle Timing



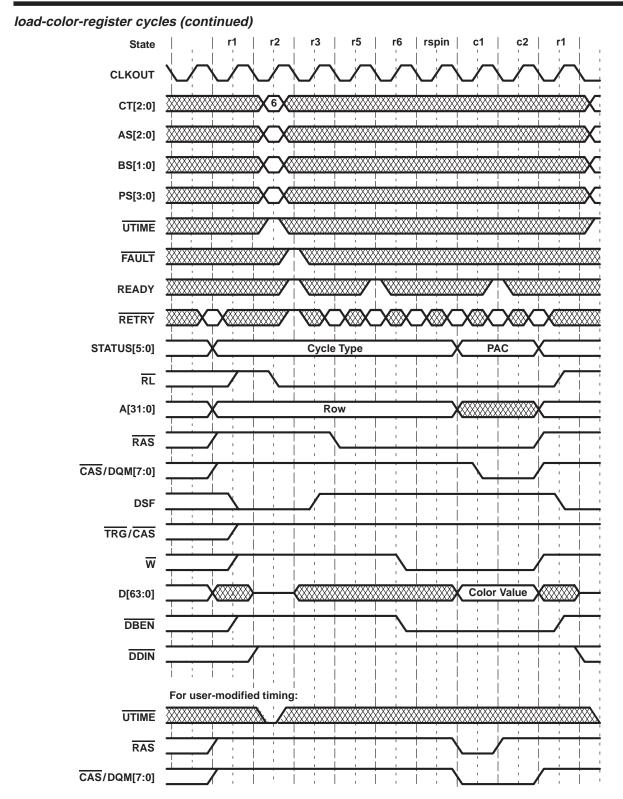


Figure 74. 2 Cycles/Column Load-Color-Register-Cycle Timing



load-color-register cycles (continued)

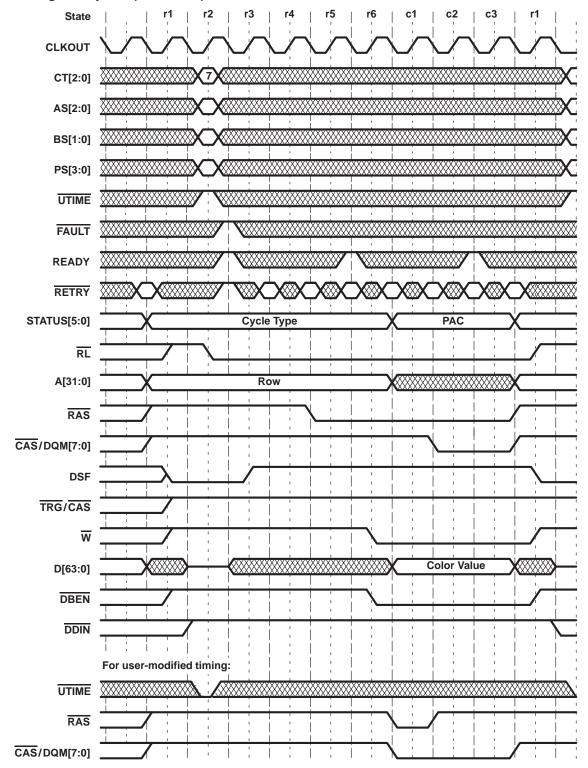


Figure 75. 3 Cycles/Column Load-Color-Register-Cycle Timing



block-write cycles

Block-write cycles cause the data stored in the VRAM color registers to be written to the memory locations enabled by the appropriate data bits output on the D[63:0] bus. This allows up to a total of 64 bytes (depending on the type of block write being used) to be written in a single-column access. This cycle is identical to a standard write cycle with the following exceptions:

- DSF is active (high) at the fall of CAS, enabling the block-write function within the VRAMs.
- Only 64-bit bus sizes are supported during block write; therefore, BS[1:0] inputs are used to indicate the type of block write that is supported by the addressed VRAMs, rather than the bus size.
- The two or three LSBs (depending on the type of block write) of the column address are ignored by the VRAMs because these column locations are specified by the data inputs.
- The values output by the TC on D[63:0] represent the column locations to be written to, using the color-register value. Depending on the type of block write supported by the VRAM, all of the data bits are not necessarily used by the VRAMs.
- Block writes always begin with a row access. Upon completion of a block write, the memory interface returns to state r1 to await the next access.

See Figure 76 through Figure 79 for block-write cycle timing.



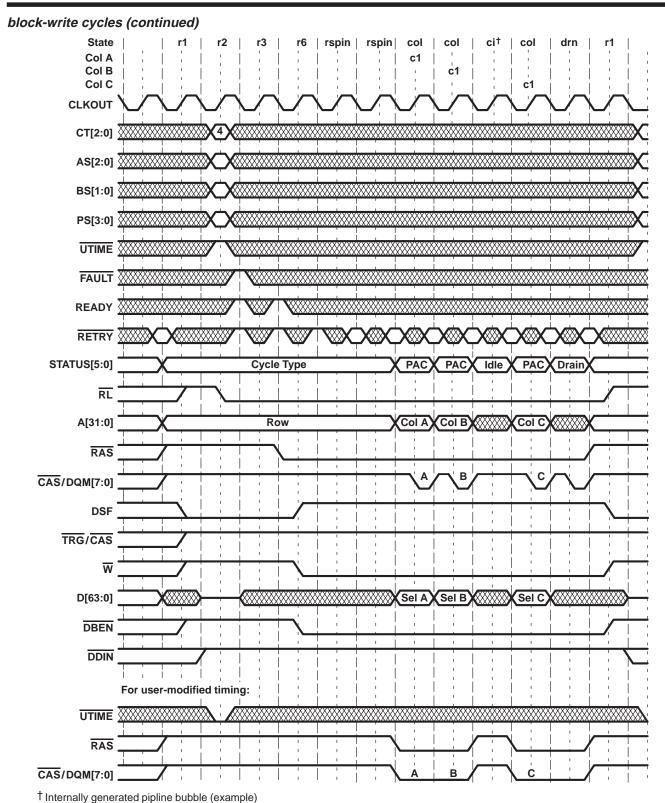


Figure 76. Pipelined 1 Cycle/Column Block-Write-Cycle Timing



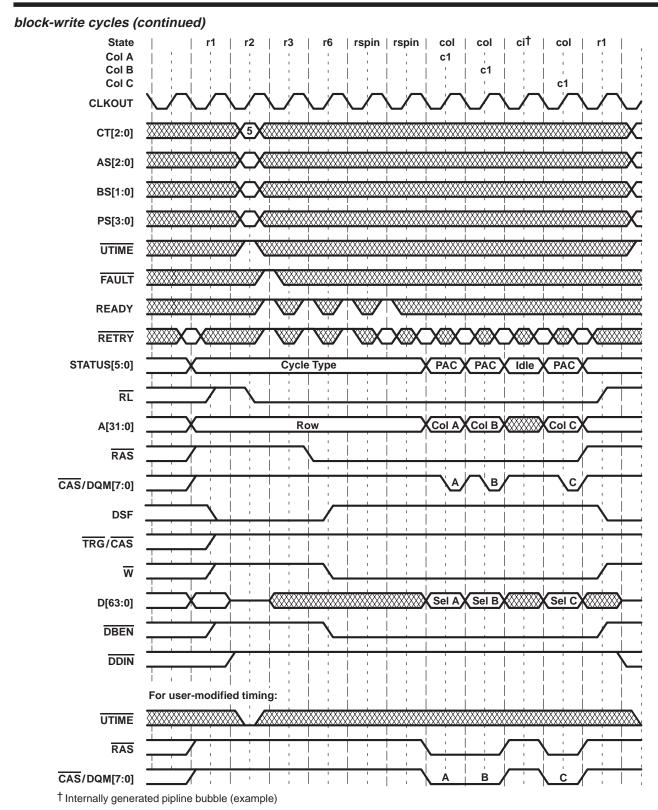
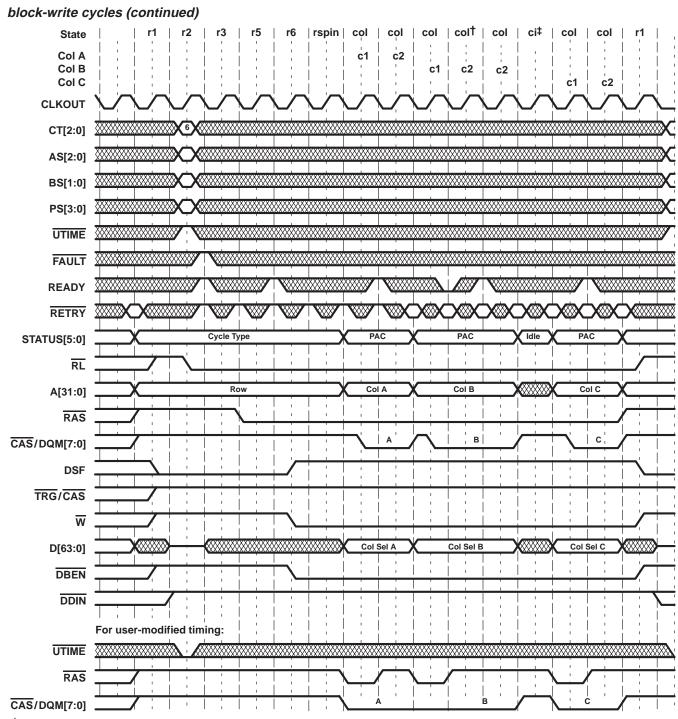


Figure 77. Nonpipelined 1 Cycle/Column Block-Write-Cycle Timing



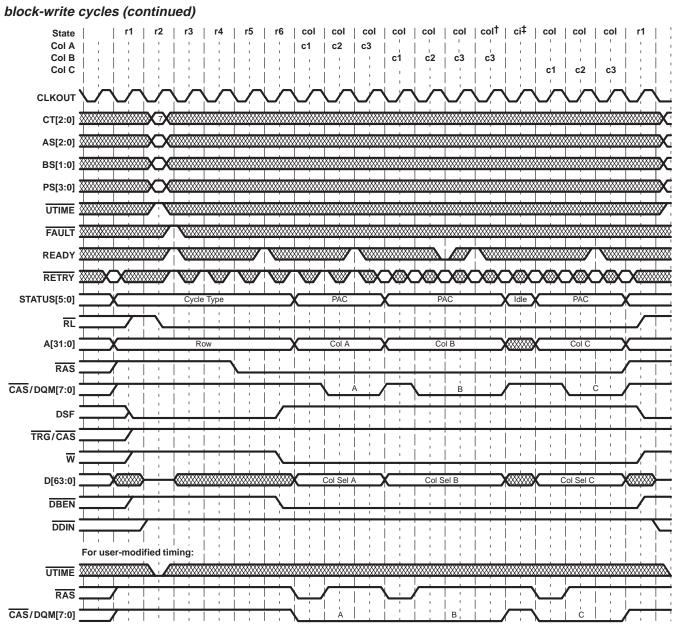


[†] Wait state inserted by external logic (example)

Figure 78. 2 Cycles/Column Block-Write-Cycle Timing



[‡] Internally generated pipeline bubble (example)



[†]Wait state inserted by external logic (example)

Figure 79. 3 Cycles/Column Block-Write-Cycle Timing

[‡] Internally generated pipeline bubble (example)

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transfer cycles

Read-transfer (memory-to-register) cycles transfer a row from the VRAM memory array into the VRAM shift register (SAM). This causes the entire SAM (both halves of the split SAM) to be loaded with the array data.

Split-register read-transfer (memory-to-split-register) cycles also transfer data from a row in the memory array to the SAM. However, these transfers cause only half of the SAM to be written. Split-register read transfers allow the inactive half of the SAM to be loaded with the new data while the other active half continues to shift data in or out.

Write-transfer (register-to-memory) cycles transfer data from the SAM into a row of the VRAM array. This transfer causes the entire SAM (both halves of the split SAM) to be written into the array.

Split-register write-transfer (split-register-to-memory) cycles also transfer data from the SAM to a row in the memory array. However, these transfers write only half of the SAM into the array. Split-register write transfers allow the inactive half of the SAM to be transferred into memory while the other (active) half continues to shift serial data in or out.

Read and split-read transfers resemble a standard read cycle. Write and split-write transfers resemble a standard write cycle. The $\overline{TRG}/\overline{CAS}$ output is driven low prior to the fall of \overline{RAS} to indicate a transfer cycle. Only a single column access is performed so \overline{RETRY} , while required to be at a valid level, has no effect if asserted at column time. The value output on A[31:0] at column time represents the SAM tap point (see Figure 80 through Figure 86 for transfer cycle timing.



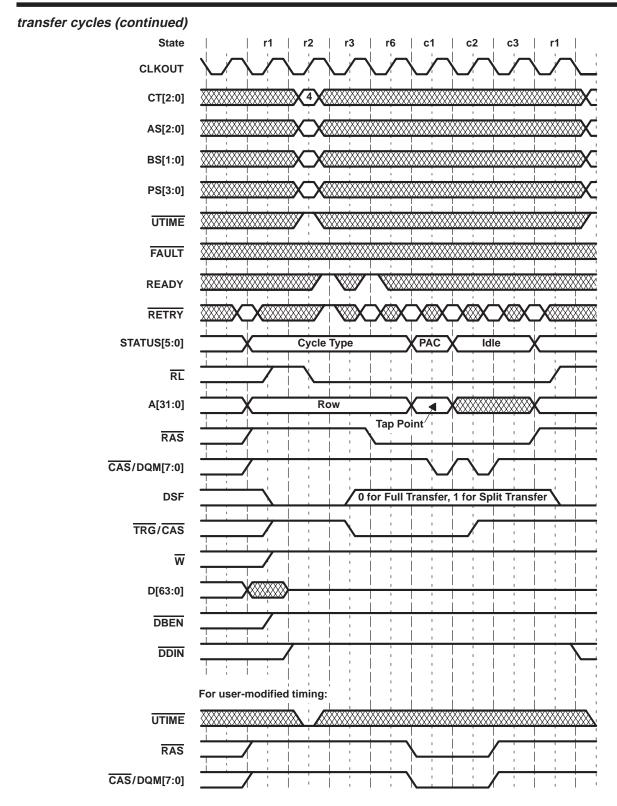


Figure 80. Pipelined 1 Cycle/Column Read-Transfer and Split-Register Read-Transfer-Cycle Timing



transfer cycles (continued)

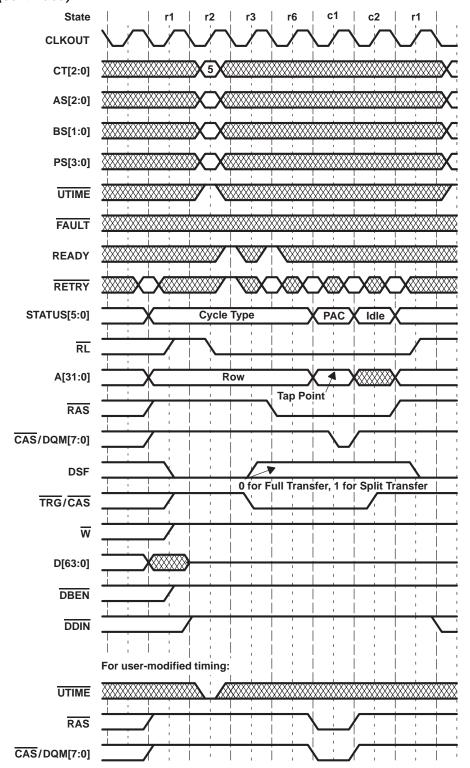


Figure 81. Nonpipelined 1 Cycle/Column Read-Transfer and Split-Register Read-Transfer-Cycle Timing



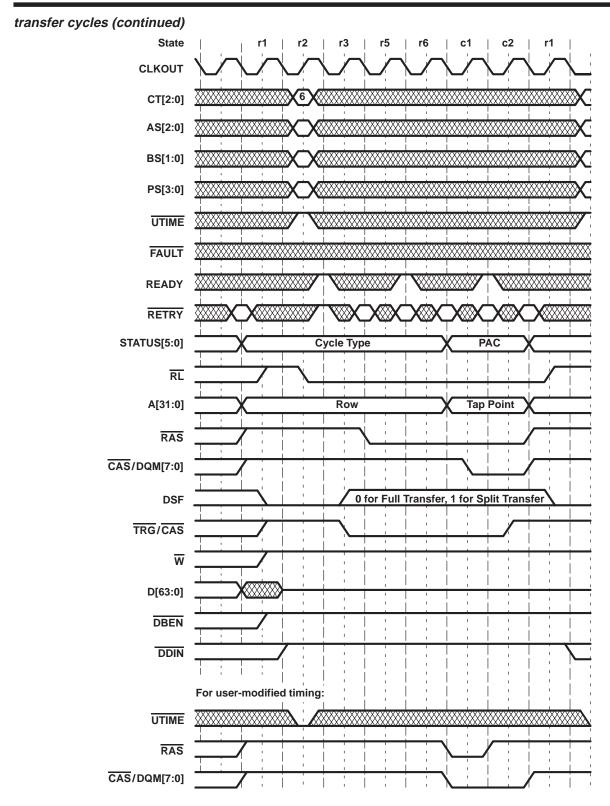


Figure 82. 2 Cycles/Column Read-Transfer and Split-Register Read-Transfer-Cycle Timing



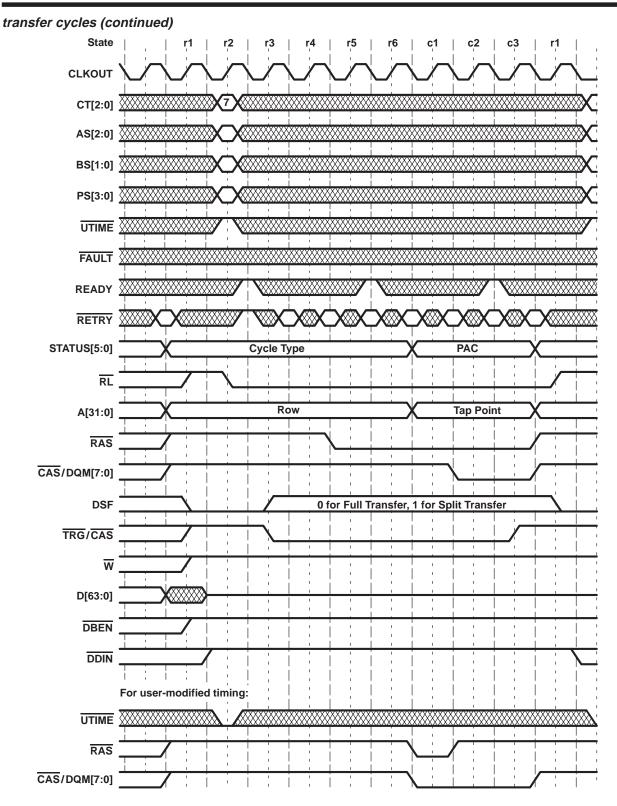


Figure 83. 3 Cycles/Column Read-Transfer and Split-Register Read-Transfer-Cycle Timing



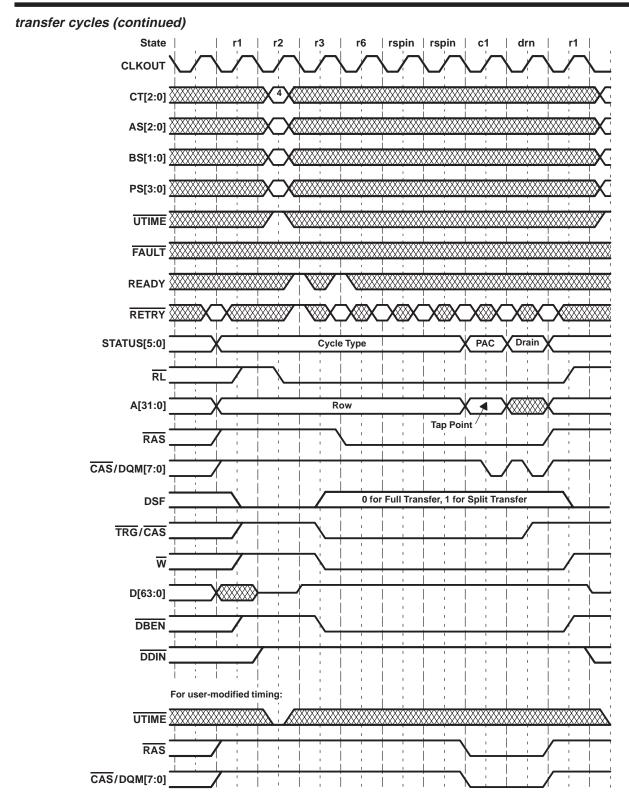


Figure 84. Pipelined 1 Cycle/Column Write-Transfer and Split-Register Write-Transfer-Cycle Timing



DDIN

UTIME XX

RAS

CAS/DQM[7:0]

For user-modified timing:

transfer cycles (continued) State r2 r3 r6 rspin rspin **CLKOUT** CT[2:0] XX RETRY STATUS[5:0] PAC Cycle Type RL Row 1 A[31:0] Tap Point RAS CAS/DQM[7:0] 0 for Full Transfer, 1 for Split Transfer DSF TRG/CAS W D[63:0] DBEN

Figure 85. Nonpipelined 1 Cycle/Column Write-Transfer and Split-Register Write-Transfer-Cycle Timing



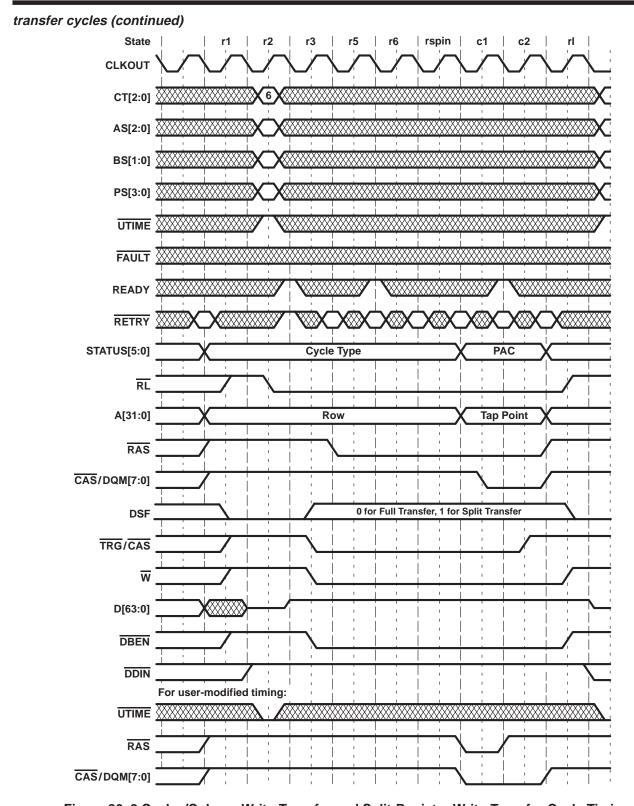


Figure 86. 2 Cycles/Column Write-Transfer and Split-Register Write-Transfer-Cycle Timing



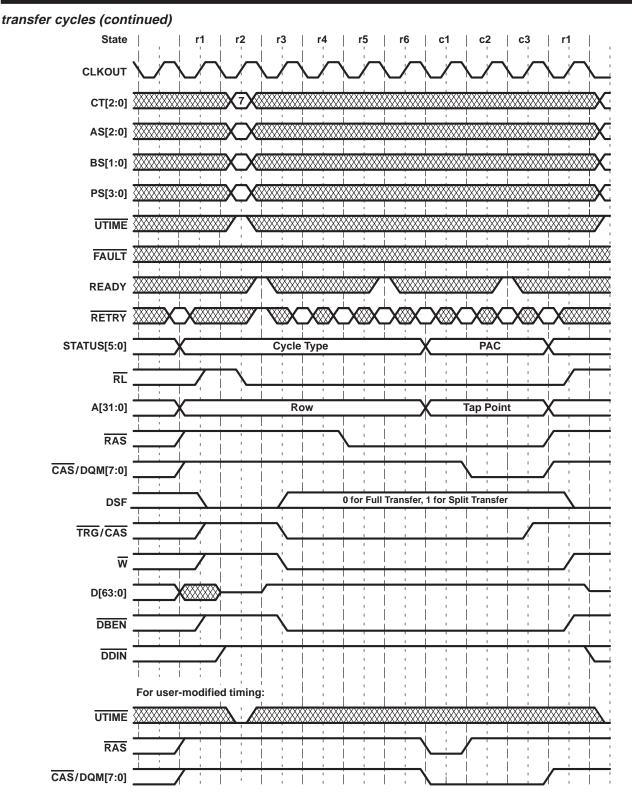


Figure 87. 3 Cycles/Column Write-Transfer and Split-Register Write-Transfer-Cycle Timing



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refresh cycles

Refresh cycles are generated by the TC at the programmed refresh interval. They are characterized by the following signal activity:

- CAS falls prior to RAS.
- All CAS pins (CAS/DQM[7:0]) are active.
- TRG, W, and DBEN all remain inactive (high) because no data transfer occurs.
- DSF remains inactive (low).
- The data bus is driven to the high-impedance state.
- The upper half of the address bus (A[31:16]) contains the refresh pseudo-address and the lower half (A[15:0]) is driven to all zeros.
- If RETRY is asserted at any sample point during the cycle, the cycle timing is not modified. Instead, the pseudo-address and backlog counters are simply not decremented.
- Selecting user-modified timing has no effect on the cycles.
- Upon completion of the refresh cycle, the memory interface returns to state r1 to await the next access.

See Figure 88 through Figure 90 for refresh cycle timing.

refresh cycles (continued)

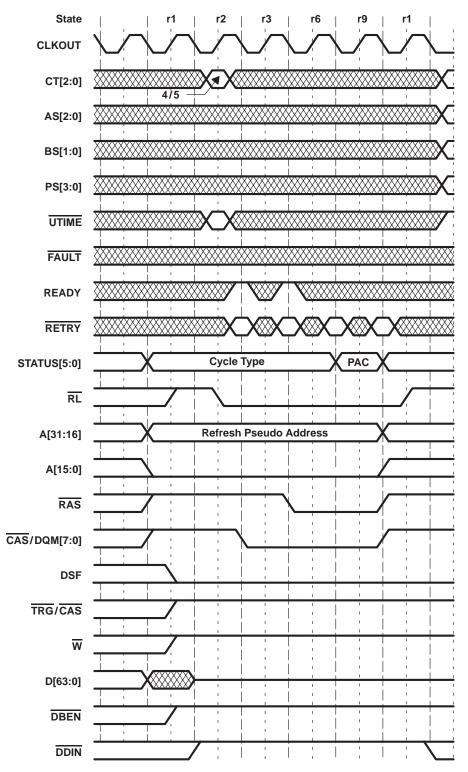


Figure 88. 1-Cycle/Column Refresh-Cycle Timing



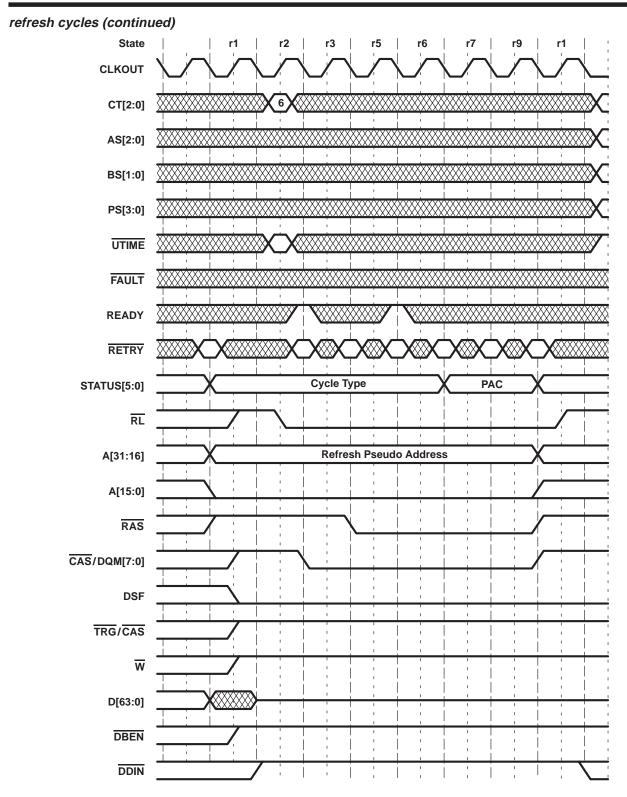


Figure 89. 2 Cycles/Column Refresh-Cycle Timing



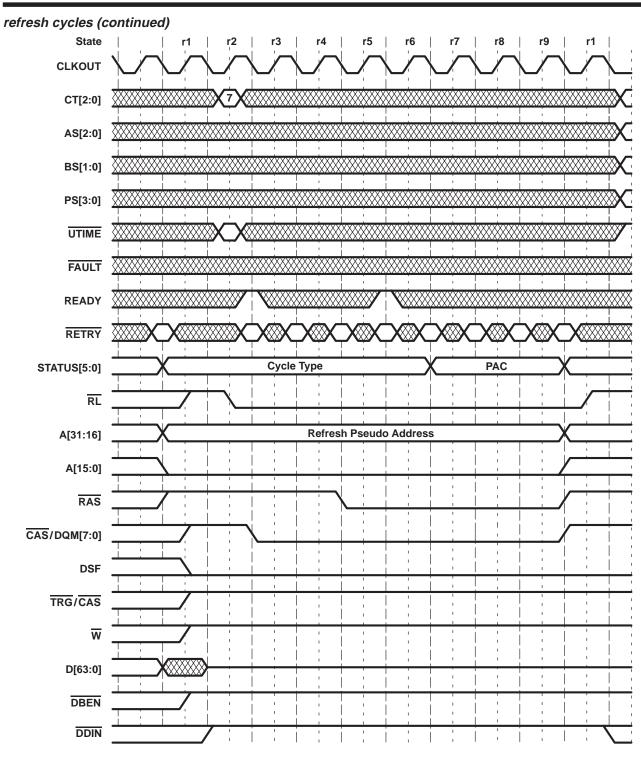


Figure 90. 3 Cycles/Column Refresh-Cycle Timing



SDRAM type cycles

The SDRAM type cycles support the use of SDRAM, SGRAM, or SVRAM devices for single-cycle memory accesses. While SDRAM cycles use the same state sequences as DRAM cycles, the memory-control signal transitions are modified to perform SDRAM command cycles. The supported SDRAM commands are:

DCAB Deactivate (precharge) all banks

ACTV Activate the selected bank and select the row

READ Input starting column address and start read operation WRT Input starting column address and start write operation

MRS Set SDRAM mode register

REFR Auto-refresh cycle with internal address

SRS Set special register (color register)

BLW Block write

SDRAM cycles begin with an activate (ACTV) command followed by the requested column accesses. When a memory-page change occurs, the selected bank is deactivated with a DCAB command.

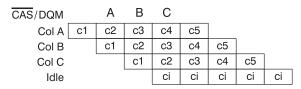
The TMS320C80 supports read latencies of 2, 3, or 4 cycles and burst lengths of 1 or 2. These are selected by the CT code and UTIME value input at the start of the access.

The column pipelines for SDRAM accesses are shown in Figure 91. Idle cycles can occur after necessary column accesses have completed or between column accesses due to "bubbles" in the TC data flow pipeline. The pipeline diagrams show the pipeline stages for each access type and when the \overline{CAS}/DQM signal corresponding to the column access is activated.

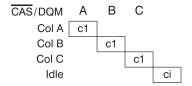
SDRAM type cycles (continued)

CAS/DQM	Α	В	С			
Col A	c1	c2	сЗ			
Col B		c1	c2	сЗ		
Col C			c1	c2	сЗ	
Idle				ci	ci	ci

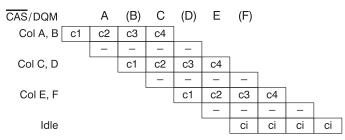
Burst-length 1, 2 cycle latency reads, read transfers, split-read transfers



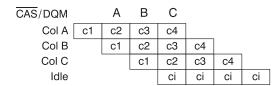
Burst-length 1, 4 cycle latency reads, read transfers, split-read transfers.



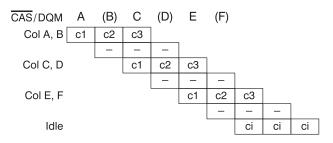
Burst-length 1 writes, block writes, SRSs, write transfers, split-write transfers



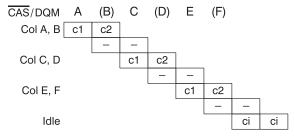
Burst-length 2, 3 cycle latency reads, read transfers, split-read transfers



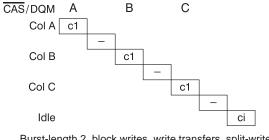
Burst-length 1, 3 cycle latency reads, read transfers, split-read transfers

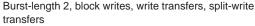


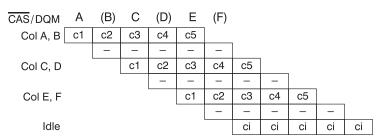
Burst-length 2, 2 cycle latency reads, read transfers, split-read transfers



Burst-length 2, writes







Burst-length 2, 4 cycle latency reads, read transfers, split-read transfers.

Figure 91. SDRAM Column Pipelines



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special SDRAM cycles

To initialize the SDRAM properly, the TMS320C80 performs two special SDRAM cycles after reset. The 'C80 first performs a deactivate cycle on all banks (DCAB) and then initializes the SDRAM mode register with a mode register set (MRS) cycle. The CT code input at the start of the MRS cycle determines the burst length and latency that is programmed into the SDRAM mode register (see Figure 92 and Figure 93).

special SDRAM cycles (continued) r3 r5 State CLKOUT 0xx PS[3:0] UTIME READY RETRY Cycle Type STATUS[5:0]

RL A[31:0] RAS CAS/DQM[7:0] DSF TRG/CAS w D[63:0] DBEN DDIN Command **DCAB** Figure 92. SDRAM Power-Up Deactivate Cycle Timing



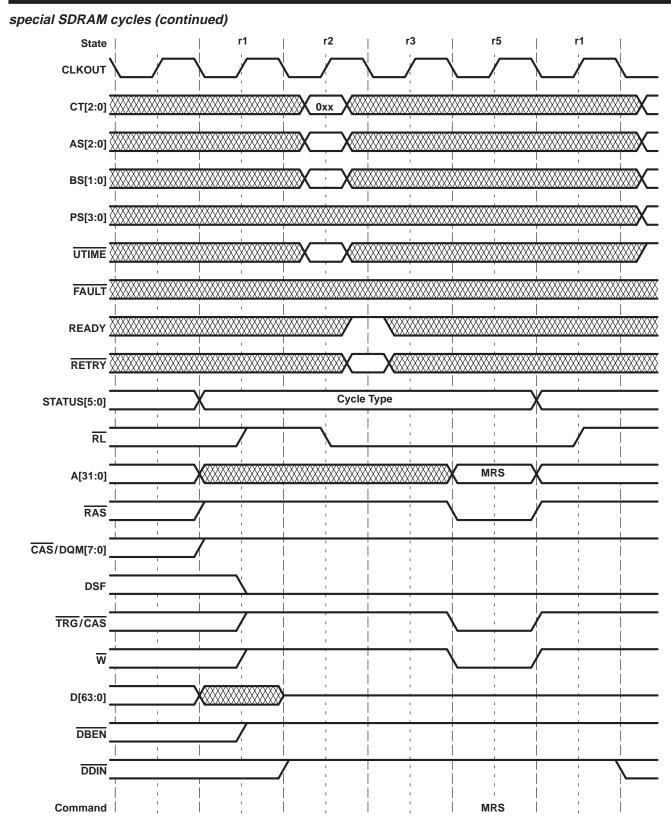


Figure 93. SDRAM Mode Register Set-Cycle Timing



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SDRAM read cycles

Read cycles begin with an activate (ACTV) command to activate the bank and to select the row. The TC outputs the column address and activates the $\overline{TRG}/\overline{CAS}$ strobe for each read command. For burst length 1 accesses, a read command can occur on each cycle. For burst-length 2 accesses, a read command can occur every two cycles. The TC places D[63:0] into the high-impedance state, allowing it to be driven by the memory, and latches input data during the appropriate column state. The TC always reads 64 bits and extracts and aligns the appropriate bytes. Invalid bytes for bus sizes of less than 64 bits are discarded. The \overline{CAS}/DQM strobes are activated two cycles before input data is latched. If the second column in a burst is not required, then \overline{CAS}/DQM is not activated. During peripheral device packet transfers, \overline{DBEN} remains high (see Figure 94 through Figure 99).



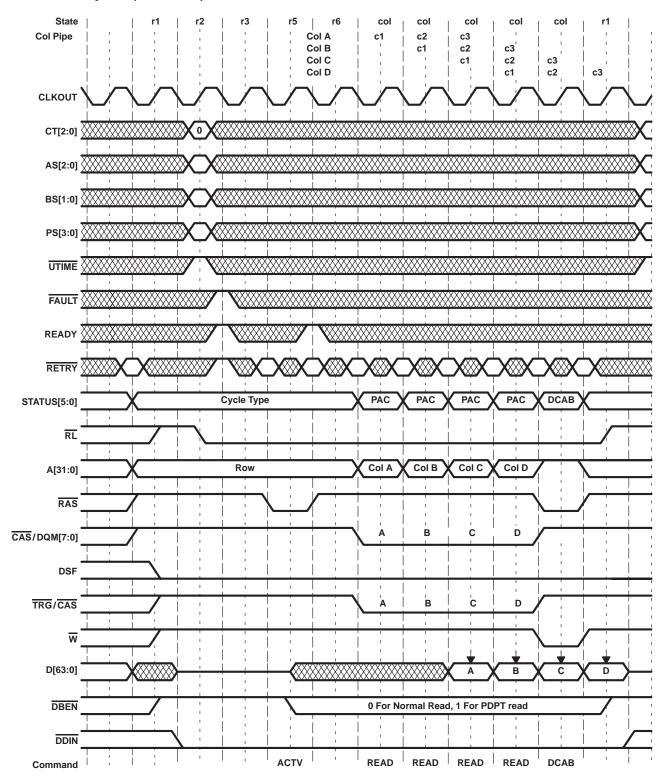


Figure 94. SDRAM Burst-Length 1, 2 Cycle Latency Read-Cycle Timing



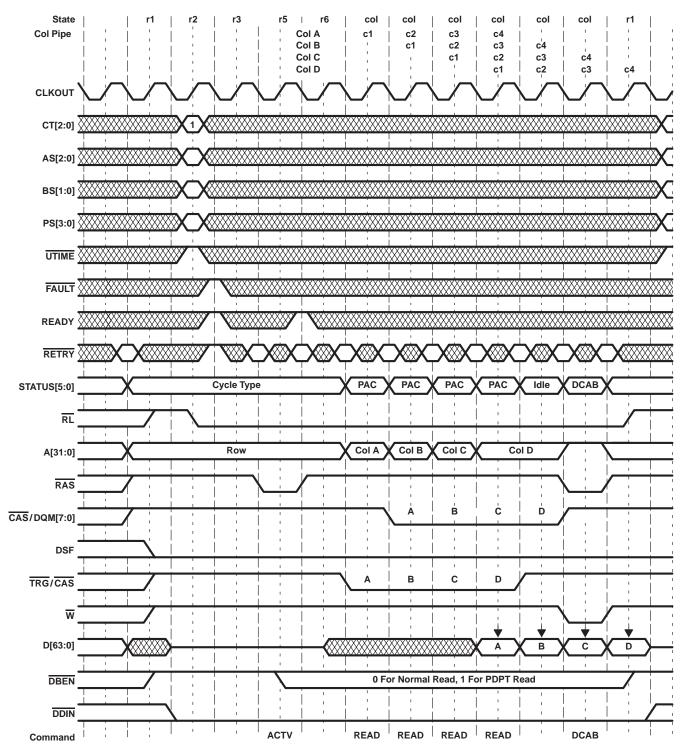


Figure 95. SDRAM Burst-Length 1, 3 Cycle Latency Read-Cycle Timing



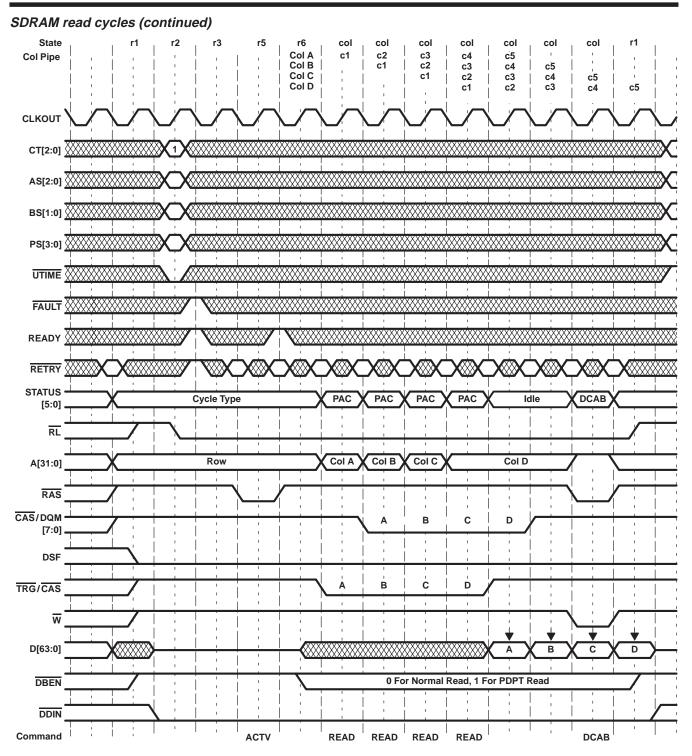


Figure 96. SDRAM Burst-Length 1, 4 Cycle Latency Read-Cycle Timing



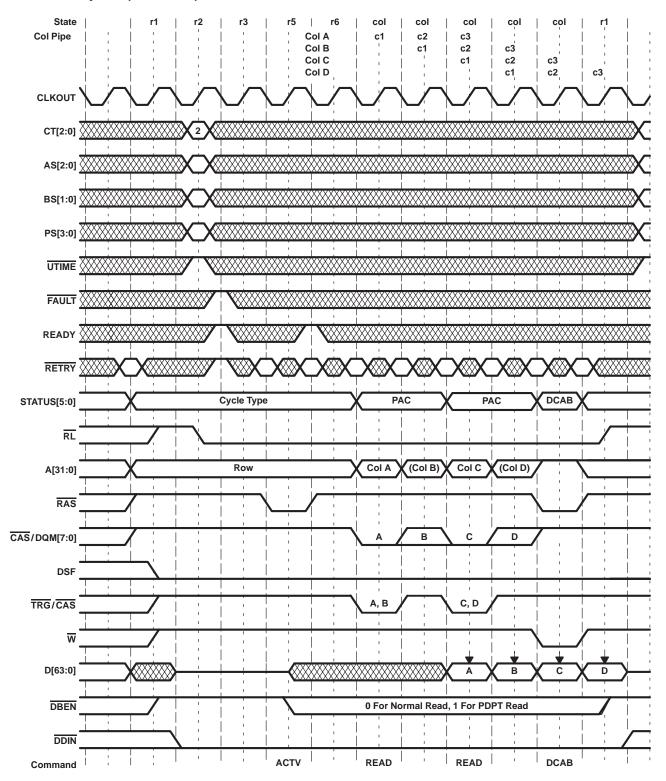


Figure 97. SDRAM Burst-Length 2, 2 Cycle Latency Read-Cycle Timing



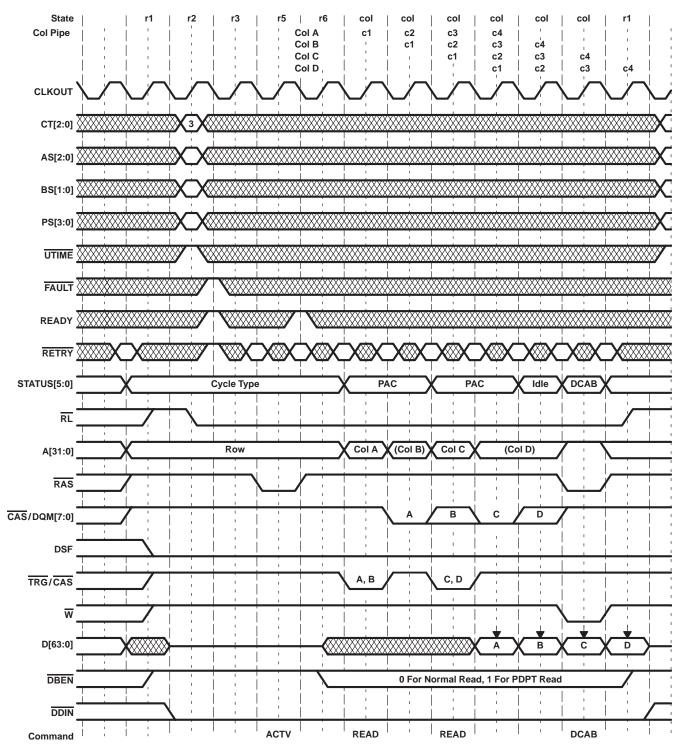


Figure 98. SDRAM Burst-Length 2, 3 Cycle Latency Read-Cycle Timing



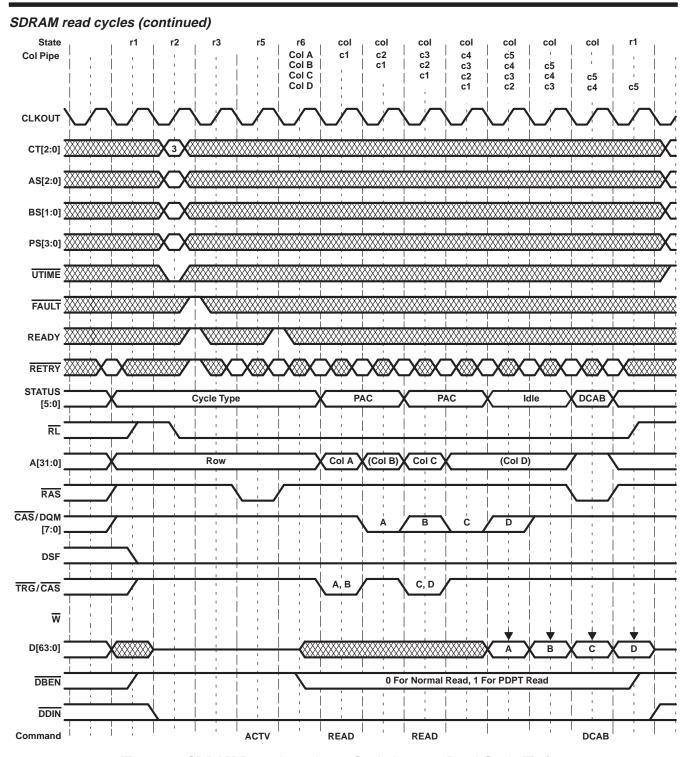


Figure 99. SDRAM Burst-Length 2, 4 Cycle Latency Read-Cycle Timing



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SDRAM write cycles

Write cycles begin with an activate (ACTV) command to activate the bank and select the row. The TC outputs the column address and activates the $\overline{TRG}/\overline{CAS}$ and \overline{W} strobes for each write command. For burst-length 1 accesses, a write command can occur on each cycle. For burst-length 2 accesses, a write command can occur every two cycles. The TC drives data out on D[63:0] during each cycle of an active-write command and indicates valid bytes by driving the appropriate \overline{CAS}/DQM strobes low. During peripheral device packet transfers, \overline{DBEN} remains high and D[63:0] are placed in the high-impedance state so that the peripheral can drive data into the memories. For SDRAM write cycles, see Figure 100 and Figure 101.

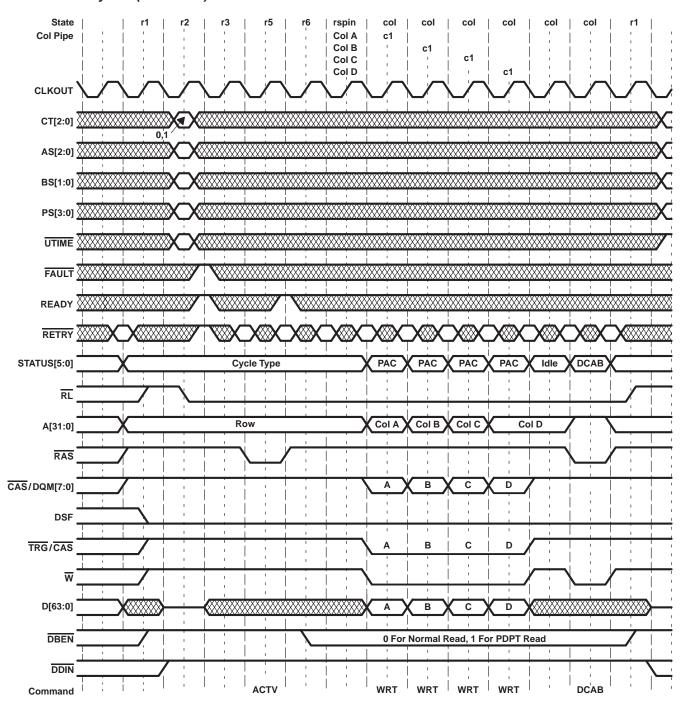


Figure 100. SDRAM Burst-Length 1 Write-Cycle Timing



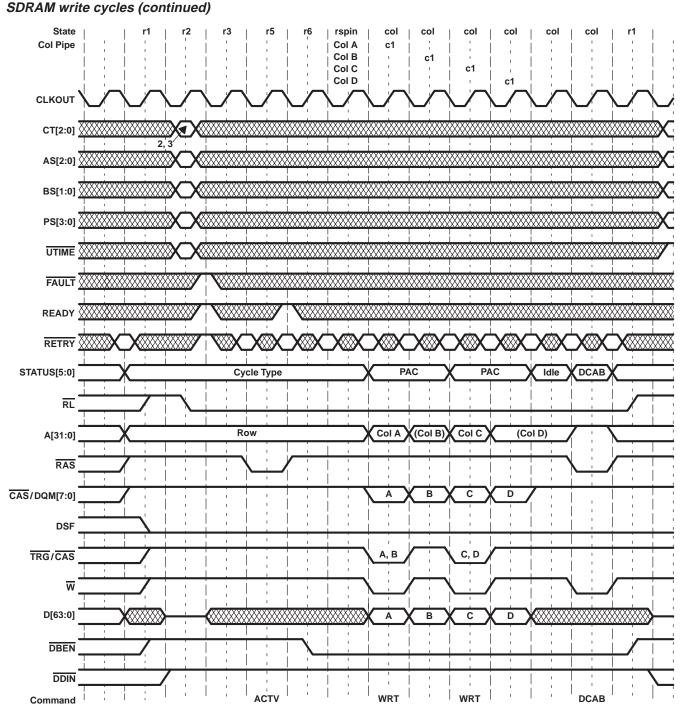


Figure 101. SDRAM Burst-Length 2 Write-Cycle Timing

special register set cycles

Special register set (SRS) cycles are used to program control registers within an SVRAM or SGRAM. The 'C80 only supports programming of the color register for use with block writes. The cycle is similar to a single burst length 1 write cycle but DSF is driven high. The values output on the 'C80 address bits cause the color register to be selected as shown in Figure 102 (see Figure 103).



special register set cycles (continued)

SDRAM Address Pin	BS	A8	A7	A6	A5	A4	A3	A2	A 1	A0
SDRAM Function	0	0	0	LC	LM	LS	Stop Register			
TMS320C80 Output Value	0	0	0	1	0	0	0	0	0	0

Figure 102. Special-Register-Set Value

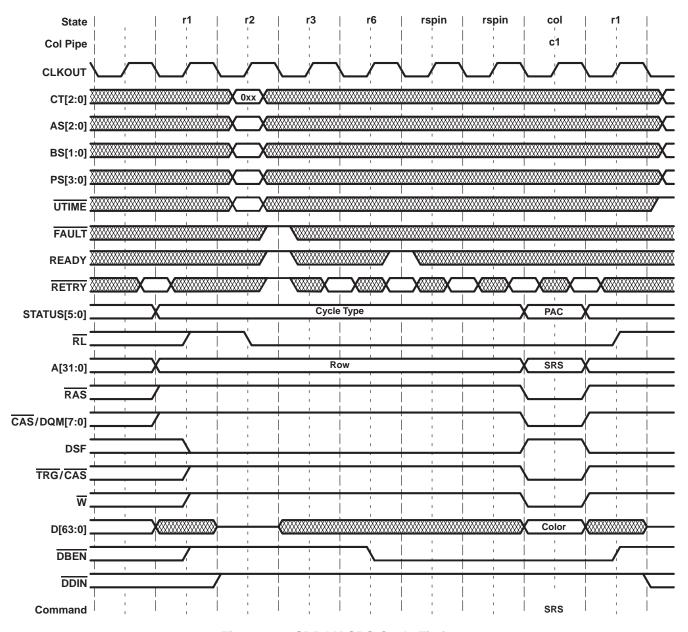


Figure 103. SDRAM SRS-Cycle Timing



SDRAM block-write cycles

Block-write cycles allow SVRAMs and SGRAMs to write a stored color value to multiple column locations in a single access. Block-write cycles are similar to write cycles except that DSF is driven high to indicate a block-write command. Because burst is not supported for block write, burst length 2 accesses generate a single block-write every other clock cycle (see Figure 104 and Figure 105).

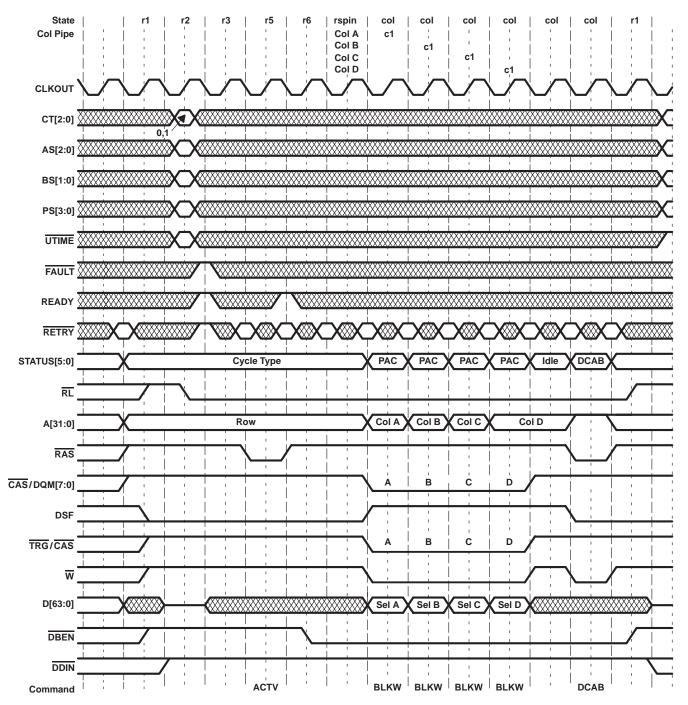


Figure 104. SDRAM Burst-Length 1 Block-Write Cycle Timing



SDRAM block-write cycles (continued)

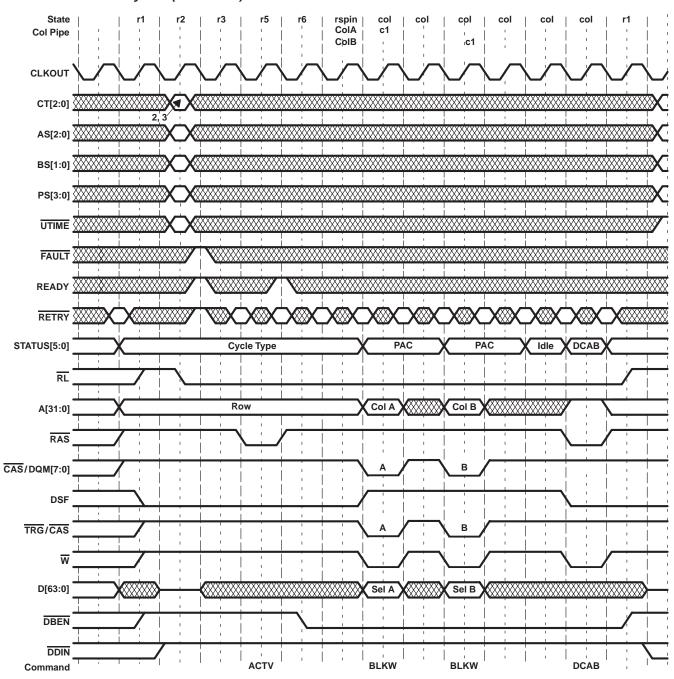


Figure 105. SDRAM Burst-Length 2 Block-Write Cycle Timing

SVRAM transfer cycles

The SVRAM read- and write-transfer cycles transfer data between the SVRAM memory-array and the serial register (SAM). The TMS320C80 supports both normal and split transfers for SVRAMs. Read-and split-read transfers resemble a standard read cycle. Write-and split-write transfers resemble a standard write cycle. Because the 'C80's TRG output is used as CAS, external logic must generate a TRG signal (by decoding STATUS) to enable the SVRAM transfer cycle. The value output on A[31:0] at column time represents the SAM tap point (see Figure 106 through Figure 113).



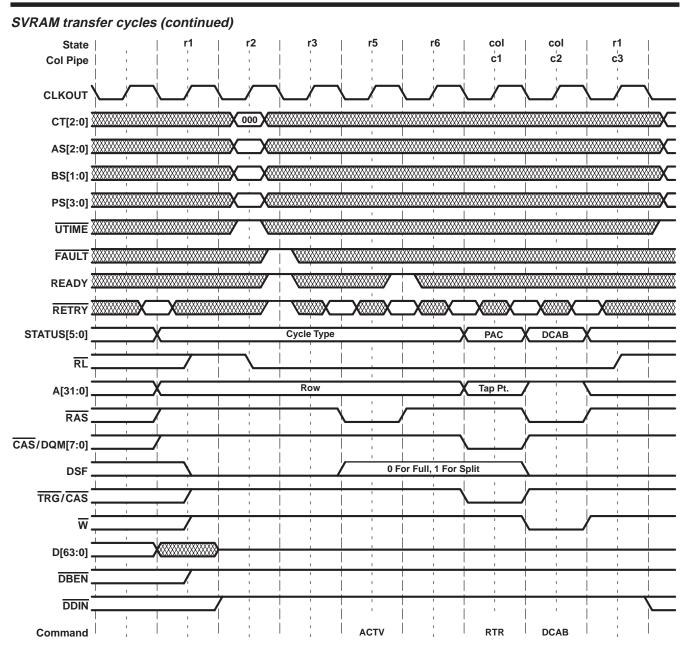


Figure 106. SVRAM Burst-Length 1, 2 Cycle Latency Read-Transfer Cycle Timing

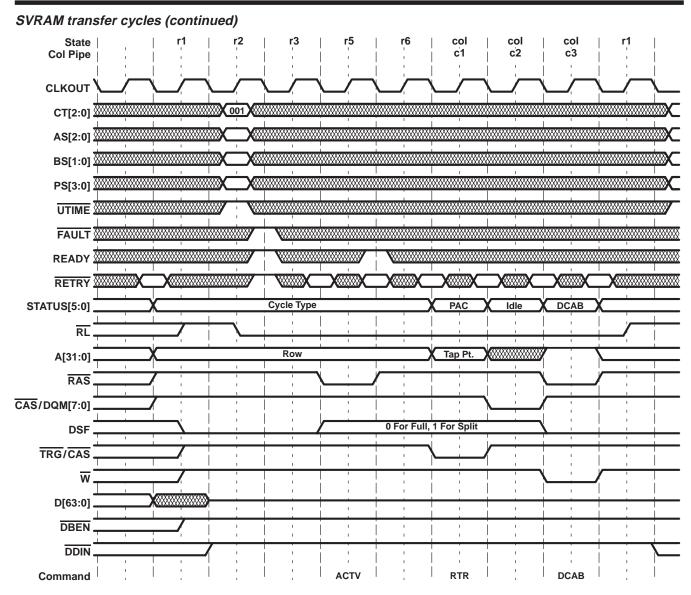


Figure 107. SVRAM Burst-Length 1, 3 Cycle Latency Read-Transfer Cycle Timing

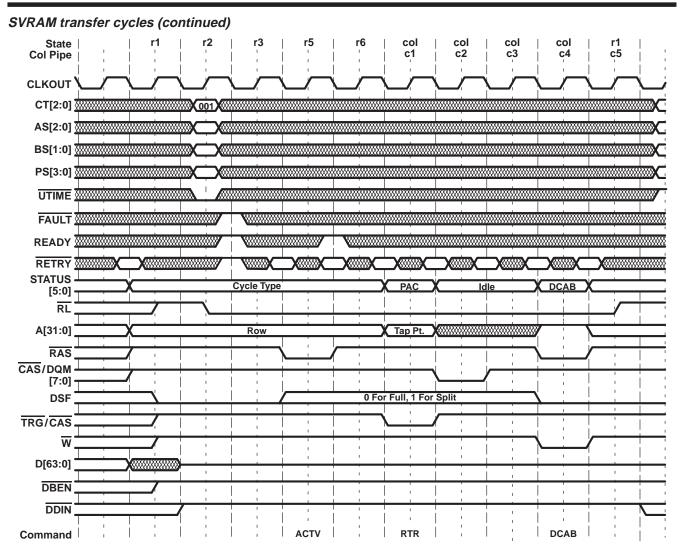


Figure 108. SVRAM Burst-Length 1, 4 Cycle Latency Read-Transfer Cycle Timing

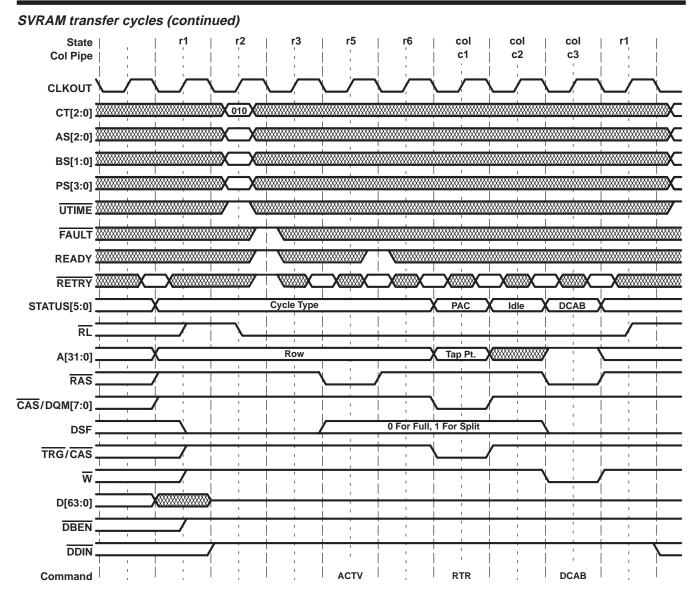


Figure 109. SVRAM Burst-Length 2, 2 Cycle Latency Read-Transfer Cycle Timing

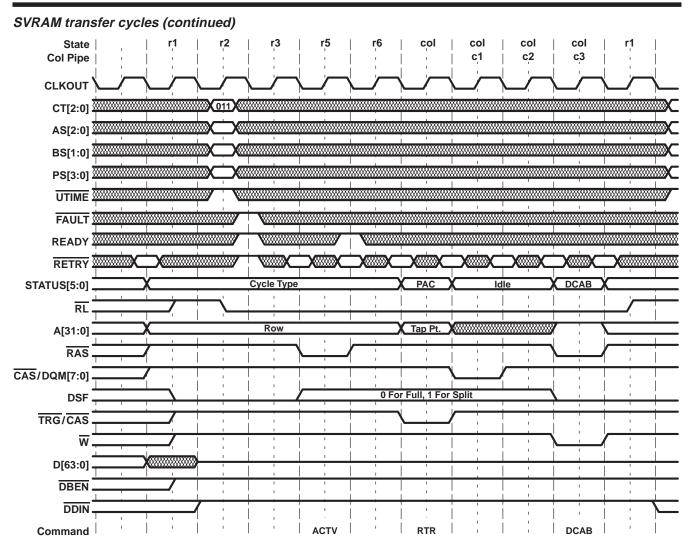


Figure 110. SVRAM Burst-Length 2, 3 Cycle Latency Read-Transfer Cycle Timing

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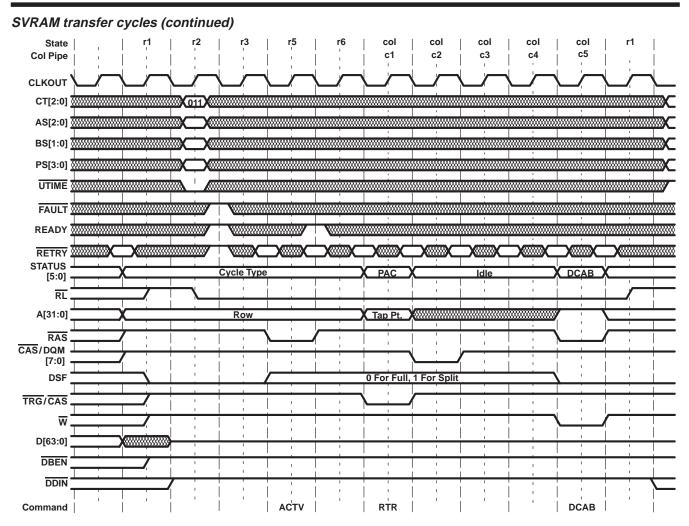


Figure 111. SVRAM Burst-Length 2, 4 Cycle Latency Read-Transfer Cycle Timing



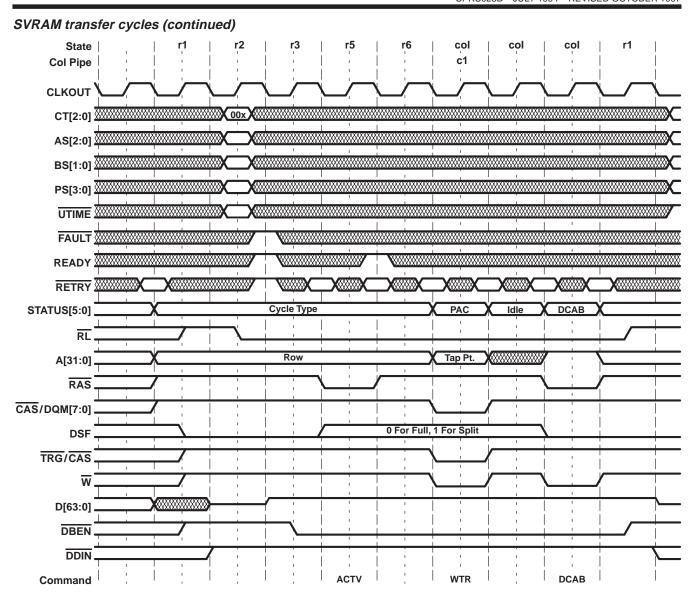


Figure 112. SVRAM Burst-Length 1, Write-Transfer Cycle Timing

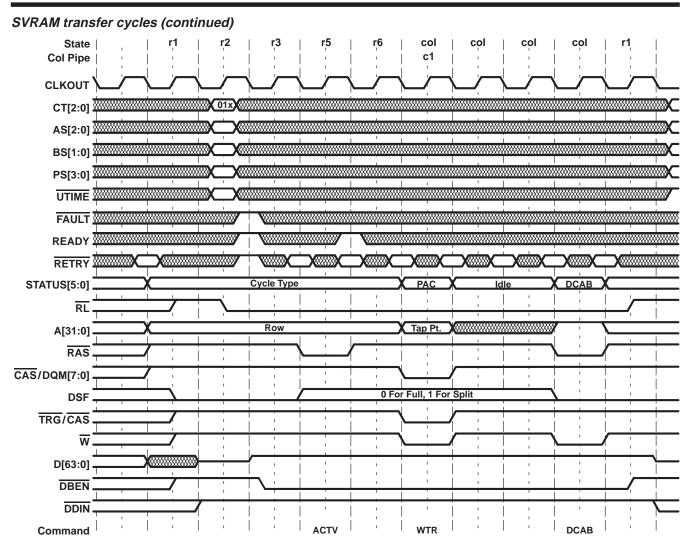


Figure 113. SVRAM Burst-Length 2, Write-Transfer Cycle Timing

SDRAM refresh cycle

The SDRAM refresh cycle is performed when the TC receives an SDRAM-cycle timing input (CT=0xx) at the start of a refresh cycle. The RAS and TRG/CAS outputs are driven low for one cycle to strobe a refresh command (REFR) into the SDRAM. The refresh address is generated internal to the SDRAM. The 'C80 outputs a 16-bit pseudo-address (used for refresh bank decode) on A[31:16] and drives A[15:0] low (see Figure 114).

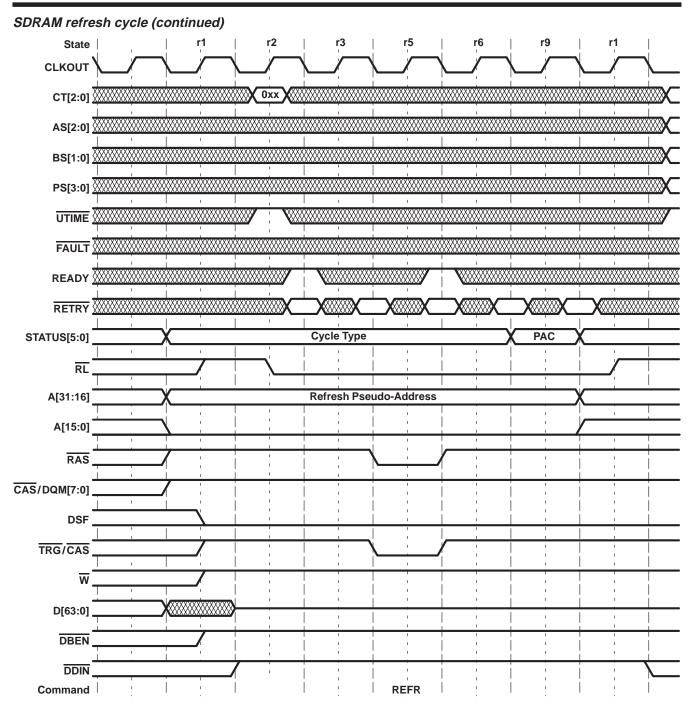


Figure 114. SDRAM Refresh-Cycle Timing

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host interface

The 'C80 contains a simple four-pin mechanism by which a host or another device can gain control of the 'C80 local memory bus. The HREQ input can be driven low by the host to request the 'C80's bus. Once the TC has completed the current memory access, it places the local bus (except CLKOUT) into a high-impedance state. It then drives the HACK output low to indicate that the host device owns the bus and can drive it. The REQ[1:0] outputs reflect the highest priority cycle request being received internally by the TC. The host can monitor these outputs to determine if it needs to relinquish the local bus back to the 'C80 (see Table 37).

Table 37. TC Priority Cycles

REQ[1:0]	REQ[1:0] ASSOCIATED INTERNAL TC REQUEST		
11 SRT, urgent refresh, XPT, or VCPT 10 Cache/DEA request, urgent packet transfer			
00	Low-priority packet transfer, trickle refresh, idle		

device reset

The TMS320C80 is reset when the RESET input is driven low. The 'C80 outputs immediately go into a high-impedance state with the exception of CLKOUT, HACK, and REQ[1:0]. While RESET is low, all internal registers are set to their default values and internal logic is reset.

On the rising edge of $\overline{\text{RESET}}$, the state of $\overline{\text{UTIME}}$ is sampled to determine if big-endian ($\overline{\text{UTIME}} = 0$) or little-endian ($\overline{\text{UTIME}} = 1$) operation is selected. Also on the rising edge of $\overline{\text{RESET}}$, the state of $\overline{\text{HREQ}}$ is sampled to determine if the master processor comes up running ($\overline{\text{HREQ}} = 0$) or halted ($\overline{\text{HREQ}} = 1$).

Once \overline{RESET} is high, the 'C80 drives the high-impedance signals to their inactive values. The TC then performs 32 refresh cycles to initialize system memory. If, during initialization refresh, the TC receives an SDRAM cycle timing code (CT = 0xx), it performs an SDRAM DCAB cycle and a MRS cycle to initialize the SDRAM, and then continues the refresh cycles.

After completing initialization refresh, if the MP is running, the TC performs its instruction-cache-fill request to fetch the cache block beginning at 0xFFFFFC0. This block contains the starting MP instruction located at 0xFFFFFF8. If the MP comes up halted, the instruction cache fill does not take place until the first occurrence of an EINT3 interrupt to unhalt the MP.

absolute maximum ratings over specified temperature ranges (unless otherwise noted)†

Supply voltage range, V _{DD} (see Note 1)	-0.3 V to 4 V
Input voltage range, V ₁	. – 0.3 V to 4 V
Output voltage range	. – 0.3 V to 4 V
Operating case temperature range, T _C	0°C to 85°C
Storage temperature range, T _{stq} –	55°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: All voltage values are with respect to VSS.

recommended operating conditions

		MIN	NOM	MAX	UNIT
V_{DD}	Supply voltage	3.135	3.3	3.465	V
VSS	Supply voltage (see Note 2)		0		V
IOH	High-level output current			- 400	μΑ
loL	Low-level output current			2	mA
T _C	Operating case temperature	0		85	°C

NOTE 2: In order to minimize noise on VSS, care should be taken to provide a minimum inductance path between the VSS pins and system ground.

electrical characteristics over recommended ranges of supply voltage and operating case temperature (unless otherwise noted)

	PARAMETER	TEST CONDITIONS‡	MIN	TYP§	MAX	UNIT	
V _{IH}	High-level input voltage		2		V _{DD} + 0.3	V	
V_{IL}	Low-level input voltage		- 0.3		0.8	V	
Vон	High-level output voltage	$V_{DD} = MIN, \qquad I_{OH} = MAX$	2.6	¶		V	
VOL	Low-level output voltage	$V_{DD} = MAX$, $I_{OH} = MIN$			0.6	V	
Ю	Output current, leakage (high impedance) (except EMU0 and EMU1)	$V_{DD} = MAX$, $V_{O} = 2.8 V$			20		
		$V_{DD} = MAX$, $V_{O} = 0.6 V$			- 20	μΑ	
Ц	Input current (except TCK, TDI, and TMS)	$V_I = V_{SS}$ to V_{DD}			±20	μА	
		V _{DD} = MAX, 60 MHz		1.2#	2.5#		
I_{DD}	Supply current (see Note 3)	V _{DD} = MAX, 50 MHz		1.0#	2.3#	Α	
		V _{DD} = MAX, 40 MHz		0.9#	1.9#		
Ci	Input capacitance			10		pF	
Со	Output capacitance			10		рF	

[‡] For conditions shown as MIN/MAX, use the appropriate value specified under the recommended operating conditions.

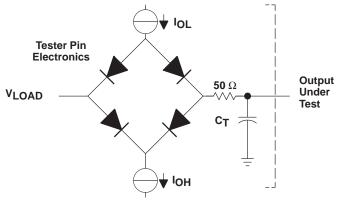
NOTE 3: Maximum supply current is derived from a test case that generates the theoretical maximum data flow using a worst case checkerboard data pattern on a sustained cycle by cycle basis. Actual maximum I_{DD} varies in real applications based on internal and external data flow and transitions. Typical supply current is derived from a test case which attempts to emulate typical use conditions of the on-chip processors with random data. Typical I_{DD} varies from application to application based on data flow and transitions and on-chip processor utilization.

[§] All typical values are at V_{DD} = 3.3 V, ambient air temperature = 25°C

[¶] Typical steady-state VOH will not exceed VDD

[#] Parameter value is representative of revision 4.x and higher devices.

PARAMETER MEASUREMENT INFORMATION



Where: I_{OL} = 2.0 mA (all outputs) I_{OH} = 400 μ A (all outputs)

 $V_{LOAD} = 1.5 V$

C_T = 60 pF typical load circuit capacitance

Figure 115. Test Load Circuit

signal transition levels

TTL-output levels are driven to a minimum logic-high level of 2.4 V and to a maximum logic-low level of 0.6 V. Figure 116 shows the TTL-level outputs.



Figure 116. TTL-Level Outputs

TTL-output transition times are specified as follows:

- For a high-to-low transition, the level at which the output is said to be no longer high is 2 V, and the level at which the output is said to be low is 0.8 V.
- For a low-to-high transition, the level at which the output is said to be no longer low is 0.8 V, and the level at which the output is said to be high is 2 V.

Figure 117 shows the TTL-level inputs.



Figure 117. TTL-Level Inputs

TTL-compatible input transition times are specified as follows:

- For a high-to-low transition on an input signal, the level at which the input is said to be no longer high is 2 V, and the level at which the input is said to be low is 0.8 V.
- For a low-to-high transition on an input signal, the level at which the input is said to be no longer low is 0.8 V, and the level at which the input is said to be high is 2 V.



PARAMETER MEASUREMENT INFORMATION

timing parameter symbology

Timing parameter symbols used herein were created in accordance with JEDEC Standard 100-A. In order to shorten the symbols, some of the pin names and other related terminology have been abbreviated as follows:

Α	A[31:0]	RDY		READY
CAS	CAS/DQM[7:0]	RST		RESET
CFG	AS[2:0], BS[1:0], CT[2:0], PS[3:0], UTIME	RTY		RETRY
CKI	CLKIN	REQ		REQ[1:0]
CKO	CLKOUT	RL		RL
CMP	RETRY, READY, FAULT	RR		READY, RETRY
D	D[63:0]	SCK		SCLK0, SCLK1
EIN	EINT1, EINT2, EINT3, or EINTx	TCK		TCK
EMU	EMU0, EMU1	TDI		TDI
FCK	FCLK0, FCLK1	TDO		TDO
HAK	HACK	TMS		TMS
HRQ	HREQ	TRS		TRST
LIN	LINT4	UTM		UTIME
MID	A[31:0], STATUS[5:0]	SI		HSYNCO, VSYNCO, CSYNCO, HSYNC1, VSYNC1,
				or CSYNC1
OUT	A[31:0], CAS/DQM[7:0], D[63:0], DBEN, DDIN, DSF, RAS, RL, STATUS[5:0], TRG/CAS, W	SY		HSYNCO, VSYNCO, CSYNCO/HBLNKO, CBLNKO/VBLNKO, HSYNC1, VSYNC1,
	DSF, RAS, RL, STATUS[5.0], TRG/CAS, W			CSYNC1/HBLNK1, CBLNK1/VBLNK1, CAREA0,
				or CAREA1
RAS	RAS	XPT		XPT[2:0] OR XPTx
Lowercas	se subscripts and their meanings are:		The	e following letters and symbols and their meanings are:
а	access time		Н	High
С	cycle time (period)		L	Low
d	delay time		V	Valid
h	hold time		Z	High impedance
su	setup time		Χ	Unknown, changing, or don't care level
t	transition time			
W	pulse duration (width)			

general notes on timing parameters

The period of the output clock (CLKOUT) is twice the period of the input clock (CLKIN), or $2 \times t_{\text{C(CKI)}}$. The half cycle time (t_H) that appears in the following tables is one-half of the output clock period, or equal to the input clock period, $t_{\text{C(CKI)}}$.

All output signals from the 'C80 (including CLKOUT) are derived from an internal clock such that all output transitions for a given half cycle occur with a minimum of skewing relative to each other.

The signal combinations shown in the following timing diagrams may not necessarily represent actual cycles. For actual cycle examples, refer to the appropriate cycle description section of this data sheet.

CLKIN timing requirements (see Figure 118)

NO.			'C80	-40	'C80	-50	'C80	-60	UNIT
NO.			MIN	MAX	MIN	MAX	MIN	MAX	UNIT
1	t _C (CKI)	Period of CLKIN (t _H)	12.5		10		8.3		ns
2	tw(CKIH)	Pulse duration of CLKIN high	4.8		4.2		3.9		ns
3	tw(CKIL)	Pulse duration of CLKIN low	4.8		4.2		3.9		ns
4	t _t (CKI)	Transition time of CLKIN [†]		1.5		1.5		1.5	ns

[†] This parameter is verified by computer simulation and is not tested.

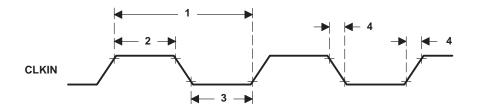


Figure 118. CLKIN Timing

local-bus switching characteristics over full operating range: CLKOUT‡(see Figure 119)

NO.		PARAMETER	'C80	-40	'C80	-50	'C80	-60	UNIT
INO.		FARAMETER	MIN	MAX	MIN	MAX	MIN	MAX	UNIT
5	t _C (CKO)	Period of CLKOUT	2t _{c(CKI)} §		2t _{C(CKI)} §		2t _{C(CKI)} §		ns
6	tw(CKOH)	Pulse duration of CLKOUT high	tH−5.5		t _H -4.5		t _H -3.7		ns
7	tw(CKOL)	Pulse duration of CLKOUT low	tH−5.5		t _H -4.5		t _H -3.7		ns
8	t _t (CKO)	Transition time of CLKOUT		2¶		2¶		2¶	ns

[‡] The CLKOUT output has twice the period of CLKIN. No propagation delay or phase relationship to CLKIN is assured. Each state of a memory access begins on the falling edge of CLKOUT.

[¶] This parameter is verified by computer simulation and is not tested.

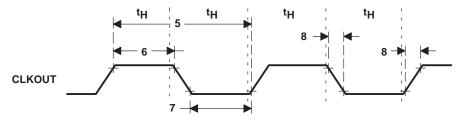


Figure 119. CLKOUT Timing

[§] This is a functional minimum and is not tested. This parameter may also be specified as 2t_H.

device reset timing requirements (see Figure 120)

NO.				MIN	MAX	UNIT
9		(RSTL) Pulse duration, RESET low Reset during a		6t _h		ns
9	^t w(RSTL)	Pulse duration, RESET low	6t _h		ns	
10	t _{su} (HRQL-RSTH)	Setup time of HREQ low to RESET high to configure s	4t _h		ns	
11	th(RSTH-HRQL)	Hold time, HREQ low after RESET high to configure s	elf-bootstrap mode	0		ns
12	t _{su} (UTML-RSTH)	Setup time of UTIME low to RESET high to configure	4t _h		ns	
13	th(RSTH-UTML)	Hold time, UTIME low after RESET high to configure by	oig-endian operation	0		ns

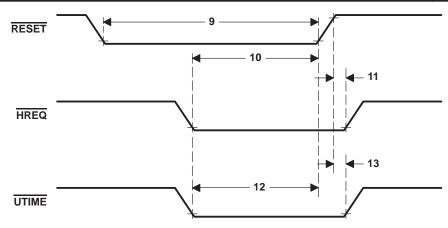


Figure 120. Device-Reset Timing

local bus timing requirements: cycle configuration inputs (see Figure 121)

The cycle configuration inputs are sampled at the beginning of each row access during the r2 state. The inputs typically are generated by a static decode of the A[31:0] and STATUS[5:0] outputs.

NO.		MIN	MAX	UNIT
14	t _{Su(CFGV-CKOH)} Setup time, AS, BS, CT, PS, and U	ITIME valid to CLKOUT no longer low 8		ns
15	th(CKOH-CFGV) Hold time, AS, BS, CT, PS, and U	TIME valid after CLKOUT high 2		ns
16	ta(MIDV-CFGV) Access time, AS, BS, CT, PS, and STATUS) valid	UTIME valid after memory identification (A,	3t _H – 10	ns

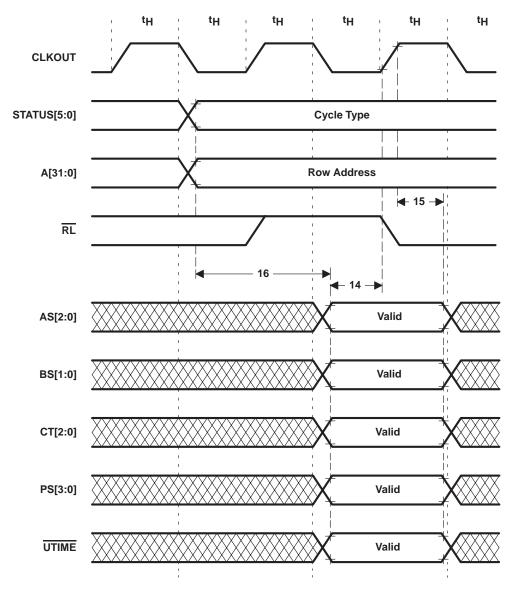


Figure 121. Local Bus Timing: Cycle Configuration Inputs

local bus timing: cycle completion inputs (see Figure 122 and Figure 123)

The cycle completion inputs are sampled at the beginning of each row access at the start of the r3 state. The READY input is also sampled at the start of the r6 state and during each column access (2 and 3 cyc/col accesses only). The RETRY input is sampled on each CLKOUT falling edge following r3. The value *n* as used in the parameters represents the integral number of half cycles between the transitions of the two signals in question.

NO				'C80	0-40	'C8	0-50	'C8	0-60	LINUT
NO.				MIN	MAX	MIN	MAX	MIN	MAX	UNIT
17	^t a(MIDV-CMPV)	Access time, RETRY, F after memory identifica valid	<i>'</i>		nt _H –9		nt _H –8		nt _H -7	ns
18	tsu(CMPV-CKOL)	Setup time, RETRY, RECLKOUT no longer hig		8.0		7.5		7.5		ns
19	th(CKOL-CMPV)	Hold time, RETRY, READY, FAULT valid after CLKOUT low		1.2		1.2		1.2		ns
20	^t a(RASL-RRV)	Access time RETRY, R	EADY valid from		nt _H -8		nt _H -7.5		nt _H -7.5	ns
21	ta(RLL-RRV)	Access time, RETRY, Flow	READY valid from RL		nt _H –8		nt _H -7.5		nt _H -7.5	ns
22	t- (0.40) . DDV0	Access time, READY valid from CAS low	2 cyc/col accesses		t _H -13.5		tH−12		t _H -12	ns
	^t a(CASL-RRV)	(non-usertime mode)	3 cyc/col accesses	nt _H -9 8.0 7.5 1.2 1.2 nt _H -8		2t _H -8		2t _H -7	113	

local bus timing: cycle completion inputs (continued)

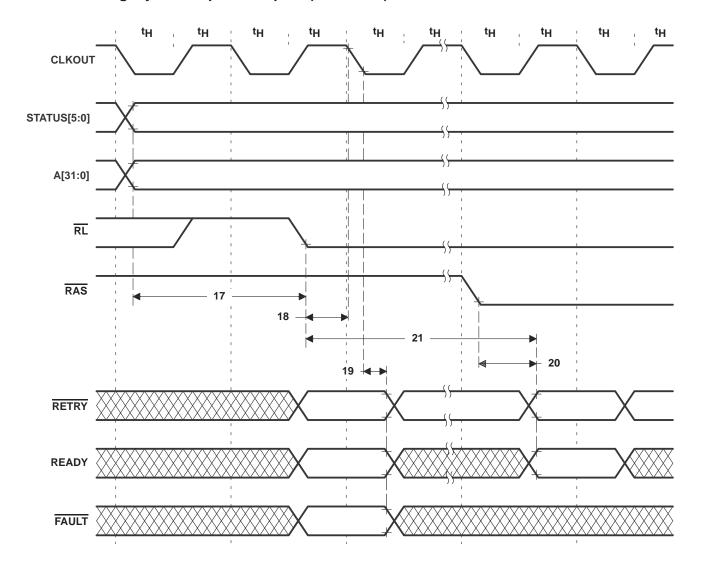


Figure 122. Local Bus Timing: Row-Time Cycle Completion Inputs

local bus timing: cycle completion inputs (continued)

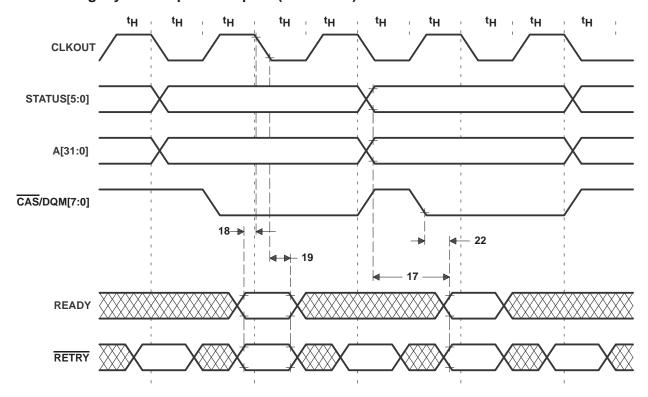


Figure 123. Local Bus Timing: Column-Time Cycle Completion Inputs

TMS320C80 DIGITAL SIGNAL PROCESSOR

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general output signal characteristics over full range of operating conditions

The following general timing parameters apply to all TMS320C80 output signals unless otherwise specifically given. The value *n* as used in the parameters represents the integral number of half cycles between the transitions of the two outputs in question. For timing purposes, outputs fall into one of three groups – the data bus (D[63:0]); the other output buses (A[31:0], STATUS[5:0], CAS/DQM[7:0]); and non-bus outputs (DBEN, DDIN, DSF, RAS, RL, TRG/CAS, W). When measuring output to output, the named group refers to the first output to transition (output A), and the second output (output B) refers to any output group (see Figure 124).

general output signal characteristics over full range of operating conditions†(continued)

NO.		PARAMETER	'C80	-40	'C80	-50	'C80	-60	LIMIT
NO.		PARAMETER	MIN	MAX	MIN	MAX	MIN	MAX	ns ns ns
23	^t h(OUTV-CKOL)	Hold time, CLKOUT high after output valid D[63:0] A[31:0], STATUS[5:0], CAS/DQM[7:0 [‡] DBEN, DDIN, DSF, RAS, RL, TRG/CAS, W	nt _H –7 nt _H –6.5 nt _H –5.5		nt _H -5.3 nt _H -4.3 nt _H -3.9		nt _H -5.3 nt _H -4.3 nt _H -3.9		ns
24	^t h(OUTV-CKOH)	Hold time, CLKOUT low after output valid D[63:0] A[31:0] STATUS[5:0], CAS/DQM[7:0]‡ DBEN, DDIN, DSF, RAS, RL, TRG/CAS, W	nt _H -7 nt _H -6.5 nt _H -6.5 nt _H -5.5		nt _H -5.5 nt _H -4.5 nt _H -4.5 nt _H -4.1		nt _H –4 nt _H –4 nt _H –4.5 nt _H –4.1		ns
25	th(CKOL-OUTV)	Hold time, output valid after CLKOUT low	nt _H -5.5		nt _H -5		nt _H -5		ns
26	th(CKOH-OUTV)	Hold time, output valid after CLKOUT high	nt _H -5.5		nt _H -5		nt _H -4		ns
27	^t h(OUTV-OUTV)	Hold time, output valid after output valid D[63:0] A[31:0], STATUS[5:0], CAS/DQM[7:0] [‡] DBEN, DDIN, DSF, RAS, RL, TRG/CAS, W	nt _H -7 nt _H -6.5 nt _H -5.5		nt _H -6.5 nt _H -5.5 nt _H -5		nt _H -5.9 nt _H -5.5 nt _H -4.7		ns
28	[‡] d(CKOH-OUTV)	Delay time, CLKOUT no longer low to output valid D[63:0] A[31:0], STATUS[5:0], CAS/DQM[7:0] [‡] DBEN, DDIN, DSF, RAS, RL, TRG/CAS, W		nt _H +7 nt _H +6.5 nt _H +5.5		nt _H +6.5 nt _H +5.5 nt _H +5		nt _H +5.9 nt _H +5.5 nt _H +4.7	ns
29	^t d(CKOL-OUTV)	Delay time, CLKOUT no longer high to output valid D[63:0] A[31:0], STATUS[5:0], CAS/DQM[7:0] [‡] DBEN, DDIN, DSF, RAS, RL, TRG/CAS, W		nt _H +7 nt _H +6.5 nt _H +5.5		nt _H +6.5 nt _H +5.5 nt _H +5		nt _H +5.9 nt _H +5.5 nt _H +4.7	ns
30	^t d(OUTV-CKOH)	Delay time, output no longer valid to CLKOUT high		nt _H +5.5		nt _H +5		nt _H +5	ns
31	td(OUTV-CKOL)	Delay time, output no longer valid to CLKOUT low		nt _H +5.5		nt _H +5		nt _H +5	ns
32	^t d(OUTV-OUTV)	Delay time, output no longer valid to output valid D[63:0] A[31:0], STATUS[5:0], CAS/DQM[7:0] [‡] DBEN, DDIN, DSF, RAS, RL, TRG/CAS, W		nt _H +7 nt _H +6.5 nt _H +5.5		nt _H +6.5 nt _H +5.5 nt _H +5		nt _H +6.1 nt _H +5.5 nt _H +5	ns

[†] Tested across full voltage. Test temperature is selected by manufacturing test flow. Compliance across full temperature range is ensured by device characterization.

[‡] Except for CAS/DQM[7:0] during non user-timed 2 cycle/column accesses



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general output signal characteristics over full range of operating conditions† (continued)

NO.		PARAMETER	'C80)-40	'C80	-50	'C80)-60	UNIT
NO.		PARAMETER	MIN	MAX	MIN	MAX	MIN	MAX	UNII
33	^t w(OUTV)	Pulse duration, output valid D[63:0] A[31:0], STATUS[5:0], CAS/DQM[7:0] [‡] DBEN, DDIN, DSF, RAS, RL,	nt _H –7		nt _H -6.5 nt _H -5.5		nt _H -6.1		ns
		TRG/CAS, W	nt _H -5.5		nt _H -5		nt _H -5		

[†] Tested across full voltage. Test temperature is selected by manufacturing test flow. Compliance across full temperature range is ensured by device characterization.

[‡] Except for CAS/DQM[7:0] during non user-timed 2 cycle/column accesses

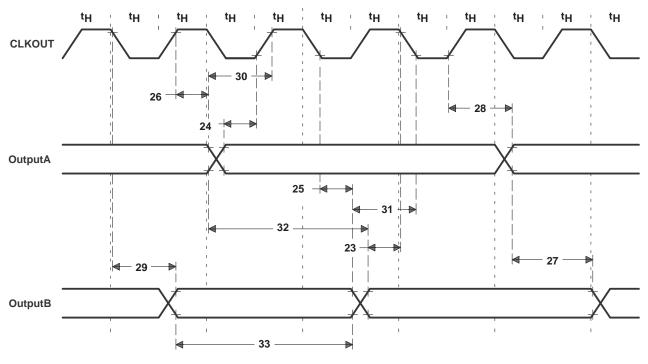


Figure 124. General Output-Signal Timing

data input timing

The following general timing parameters apply to the D[63:0] inputs unless otherwise specifically given. The value n as used in the parameters represents the integral number of half cycles between the transitions of the output and input in question (see Figure 125).

NO.		PARAMETER	'C80	-40	'C8	0-50	'C80	0-60	LINIT
INO.		FARAMETER	MIN	MAX	MIN	MAX	MIN	MAX	ns ns ns ns ns
34	ta(CKOH-DV)	Access time, CLKOUT high to D[63:0] valid		nt _H -8		nt _H -5.3		nt _H -4.0	ns
35	ta(CKOL-DV)	Access time, CLKOUT low to D[63:0] valid		nt _H -8		nt _H -6.5		nt _H -6.5	ns
36	t _{su(DV-CKOH)}	Setup time, D[63:0] valid to CLKOUT no longer low	8		6.1		6.1		ns
37	tsu(DV-CKOL)	Setup time, D[63:0] valid to CLKOUT no longer high	8		6.1		6.1		ns
38	th(CKOL-DV)	Hold time, D[63:0] valid after CLKOUT low	2		2		2		ns
39	th(CKOH-DV)	Hold time, D[63:0] valid after CLKOUT high	2		2		2		ns
40	^t a(OUTV-DV)	Access time, output valid to D[63:0] inputs valid A[31:0], CAS/DQM[7:0]†, STATUS[5:0] DBEN, DDIN, DSF, RAS, RL, TRG/CAS, W		nt _H –9		nt _H -7		nt _H -7	ns
41	th(OUTV-DV) [‡]	Hold time, D[63:0] valid after output valid RAS, CAS/DQM[7:0] A[31:0]	2 3		2 3		2 3		ns

[†] Except CAS/DQM[7:0] during non user-timed 2 cycle/column accesses

[‡] Applies to RAS, CAS/DQM[7:0], and A[31:0] transitions that occur on CLKOUT edge coincident with input data sampling

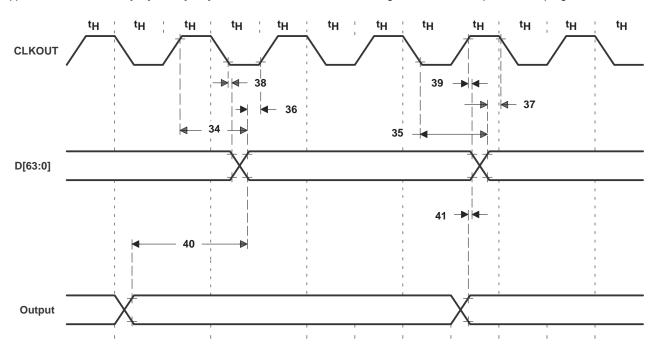


Figure 125. Data-Input Timing

local bus timing: 2 cycle/column CAS timing

These timing parameters apply to the $\overline{\text{CAS}}/\text{DQM}[7:0]$ signals during 2 cycle per column memory accesses only. They should be used in place of the general output and data input timing parameters when the 2 cycle/column (non user-timed) cycle timing is selected (CT[2:0] inputs = 0b110). The value n as used in the parameters represents the integral number of half cycles between the transitions of the signals in question (see Figure 126).

NO.			'C80	-40	'C80 'C80		UNIT
			MIN	MAX	MIN	MAX 2 ns 5 ns 5 ns	
42	tw(CASH)	Pulse duration, CAS/DQM high	t _H -2		t _H -2		ns
43	tw(CASL)	Pulse duration, CAS/DQM low	3t _H -11		3t _H -9.5		ns
44	^t h(OUTV-CASL)	Hold time, CAS/DQM high after output valid D[63:0] A[31:0], STATUS[5:0] DBEN, DDIN, DSF, RAS, RL, TRG/CAS, W	nt _H -5 nt _H -4.5 nt _H -3.5		nt _H -4.5 nt _H -3.5 nt _H -3		ns
45	th(CASL-OUTV)	Hold time, output valid after CAS/DQM low	nt _H -11		nt _H -9.5		ns
46	^t a(CASL-DV)	Access time, data valid from CAS/DQM low		3t _H -12		3t _H -12	ns
47	th(CASH-DV)	Hold time, data valid after CAS/DQM high	2		2		ns

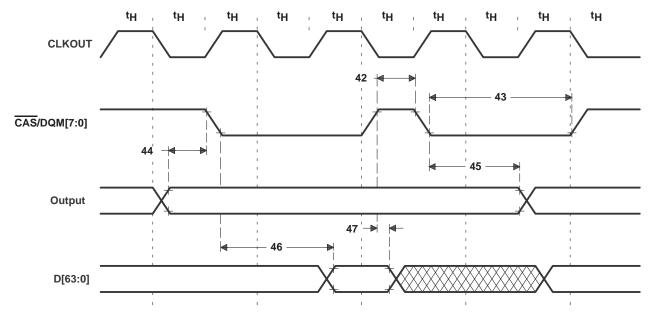


Figure 126. 2 Cycle/Column CAS Timing

external-interrupt timing

The following description defines the timing of the edge-triggered interrupts $\overline{\text{EINT1}}$ – $\overline{\text{EINT3}}$ and the level triggered interrupt $\overline{\text{LINT4}}$ (see Note 4). See Figure 127.

NO.			'C80	-40	'C80 'C80		UNIT
			MIN	MAX	MIN	MAX	
48	tw(EINL)	Pulse duration, EINTx low [†]	6		6		ns
49	t _{su} (EINH-CKOH)	Setup time, EINTx high before CLKOUT no longer low [‡]	11.5		9.5		ns
50	tw(EINH)	Pulse duration, EINTx high†	6		6		ns
51	tsu(LINL-CKOL)	Setup time, LINT4 low before CLKOUT no longer high‡	10		8		ns

[†] This parameter is assured by characterization and is not tested.

NOTE 4: In order to assure recognition, LINT4 must remain low until cleared by the interrupt service routine.

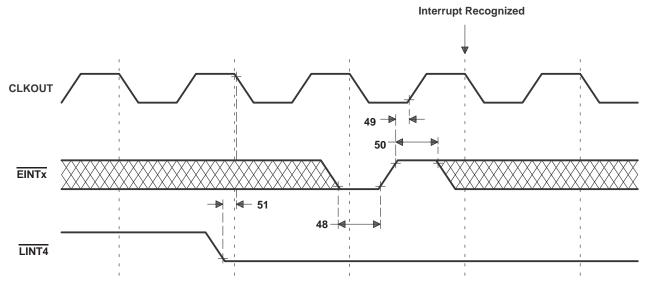


Figure 127. External-Interrupt Timing

[‡] This parameter must only be met to ensure that the interrupt is recognized on the indicated cycle.

XPT input timing

The following description defines the sampling of the $\overline{XPT[2:0]}$ inputs. The value encoded on the $\overline{XPT[2:0]}$ inputs is synchronized over multiple cycles to ensure that a stable value is present (see Figure 128 and Figure 129).

NO.			'C80	-40	'C80 'C80		UNIT
			MIN	MAX	MIN	MAX	
52	tw(XPTV)	Pulse duration, XPTx valid [†]	12t _H		12t _H		ns
53	t _{su(XPTV-CKOH)}	Setup time, XPT[2:0] valid before CLKOUT no longer low [‡]	13.5		12		ns
54	th(CKOH-XPTV)	Hold time, XPT[2:0] valid after CLKOUT high	5		5		ns
55	th(RLL-XPTV)	Hold time, XPT[2:0] valid after RL low§		6t _H		6t _H	ns

[†] This parameter is a functional minimum assured by logic and is not tested.

[§] This parameter must be met to ensure that a second XPT request does nor occur. This parameter is a functional maximum assured by logic and is not tested.

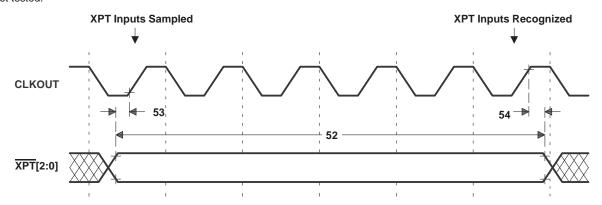


Figure 128. XPT Input Timing – XPT Recognition

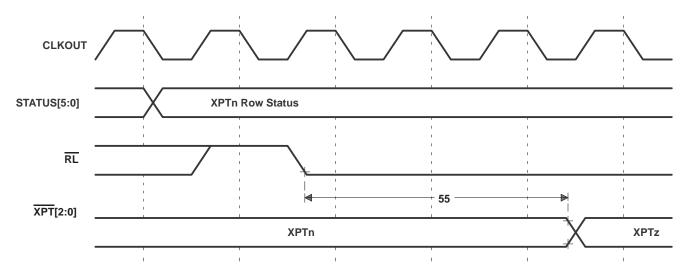


Figure 129. XPT Input Timing - XPT Service

[‡] This parameter must only be met to ensure that the XPT input is recognized on the indicated cycle.

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host-interface timing (see Figure 130)

NO.				'C80-	40	'C80-	50	'C80-	60	UNIT
NO.				MIN	MAX	MIN	MAX	MIN	MAX	UNIT
56	t _{su} (REQV-CKOH)	Setup time, REQ1-REGIONGER low	Q0 valid to CLKOUT no	t _H – 7		t _H – 7		t _H – 5.5		ns
57	th(CKOH-REQV)	Hold time, REQ1-REQ	0 valid after CLKOUT	t _H – 7		t _H – 7		t _H – 5.5		ns
58	th(HRQL-HAKL)	Hold time for HACK high after HREQ goes low		4t _H – 12		4t _H – 12		4t _H – 12		ns
59	^t d(HAKL-OUTZ)	Delay time, HACK low to output hi-Z‡	All signals except D[63:0]		0		0		0	ns
	,	to output III-2+	D[63:0]		1		1		1	
60	td(HRQH-HAKH)	Delay time, HREQ high	to HACK no longer low		10		10		10	ns
61	td(HAKH-OUTD)	Delay time, HACK high	to outputs driven†	6t _H		6t _H		6t _H		
62	t _{su} (HRQL-CKOH)	Setup time, HREQ low to low (see Note 5)	to CLKOUT no longer	10.5		8.5		8.5		ns

[†] This parameter is a functional minimum assured by logic and is not tested.

[‡]This parameter is assured by characterization and is not tested.

NOTE 5: Parameter must be met only to ensure HREQ recognition during the indicated clock cycle.

host-interface timing (see Figure 130) (continued)

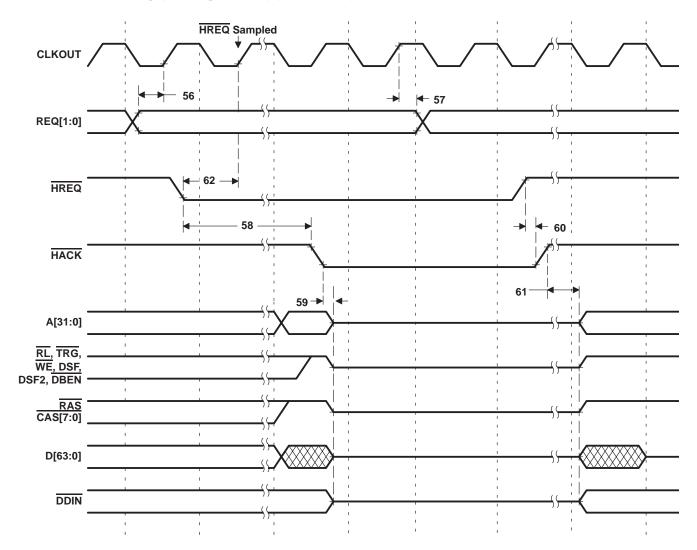


Figure 130. Host-Interface Timing

video interface timing: SCLK timing (see Figure 131)

NO.			MIN	MAX	UNIT
63	t _C (SCK)	SCLK period	13		ns
64	tw(SCKH)	Pulse duration, SCLK high	5		ns
65	tw(SCKL)	Pulse duration, SCLK low	5		ns
66	tt(SCK)	Transition time, SCLK (rise and fall) [†]		2	ns

[†] This parameter is assured by simulation and is not tested.

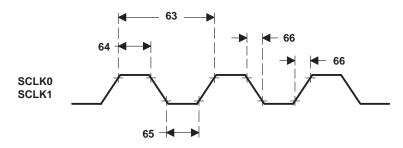


Figure 131. Video Interface Timing: SCLK Timing

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video interface timing: FCLK input and video outputs (see Note 6 and Figure 132)

NO.			MIN	MAX	UNIT
67	t _C (FCK)	FCLK period	25		ns
68	tw(FCKH)	Pulse duration, FCLK high	8		ns
69	tw(FCKL)	Pulse duration, FCLK low	8		ns
70	tt(FCK)	Transition time, FCLK (rise and fall) [†]		2	ns
71	th(FCKL-SYL)	Hold time, HSYNC, VSYNC, CSYNC/HBLNK, CBLNK/VBLNK, or CAREA high after FCLK low	0		ns
72	th(FCKL-SYH)	Hold time, HSYNC, VSYNC, CSYNC/HBLNK, CBLNK/VBLNK, or CAREA low after FCLK low	0		ns
73	td(FCKL-SYL)	Delay time, FCLK no longer high to HSYNC, VSYNC, CSYNC/HBLNK, CBLNK/VBLNK, or CAREA low		20	ns
74	^t d(FCKL-SYH)	Delay time, FCLK no longer high to HSYNC, VSYNC, CSYNC/HBLNK, CBLNK/VBLNK, or CAREA high		20	ns

[†] This parameter is assured by simulation and is not tested.

NOTE 6: Under certain circumstances these outputs also can transition asynchronously. These transitions occur when controller timing register values are modified by user programming. If the new register value forces the output to change states then this transition occurs without regard to FCLK inputs.

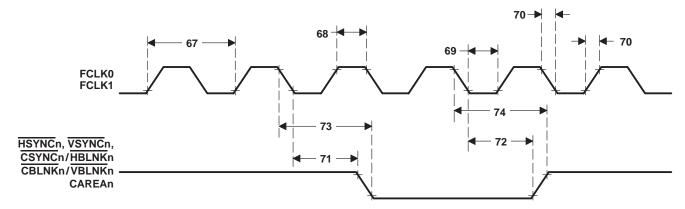


Figure 132. Video Interface Timing: FCLK Input and Video Outputs

video interface timing: external sync inputs

When configured as inputs, the HSYNCn, VSYNCn, and CSYNCn signals may be driven asynchronously. The following parameters apply only when the inputs are being generated synchronous to FCLKn in order to ensure recognition on a particular FLCKn edge (see Figure 133).

NO.			MIN	MAX	UNIT
75	t _{su(SIL-FCKH)}	Setup time, HSYNC, VSYNC, or CSYNC low to FCLK no longer low [†]	5		ns
76	th(FCKH-SIL)	Hold time, HSYNC, VSYNC, or CSYNC high after FCLK high‡	7		ns
77	t _{su} (SIH-FCKH)	Setup time, HSYNC, VSYNC, or CSYNC high to FCLK no longer low§	5		ns
78	th(FCKH-SIH)	Hold time, HSYNC, VSYNC, or CSYNC low after FCLK high¶	7		ns

[†] This parameter must be met only to ensure the input is recognized as low at FLCK edge B.

[¶] This parameter must be met only to ensure the input is recognized as low at FLCK edge C.

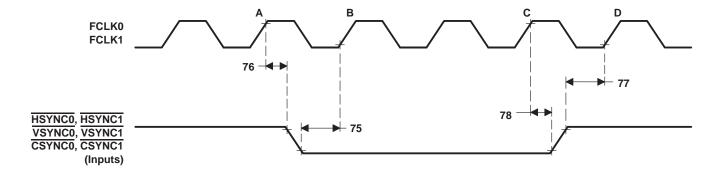


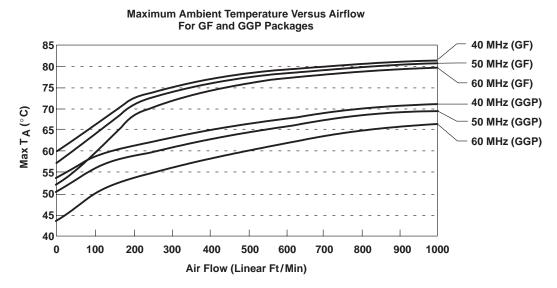
Figure 133. Video Interface Timing: External Sync Inputs

[‡] This parameter must be met only to ensure the input is recognized as high at FLCK edge A.

[§] This parameter must be met only to ensure the input is recognized as high at FLCK edge D.

thermal resistance

Figure 134 illustrates the maximum ambient temperature allowed for various air flow rates across the TMS320C80 to ensure that the case temperature is kept below the maximum operating temperature (85°C) (see Note A). Values for the GF package include integral heat sink. Values for the GGP package are with no heat sink



NOTE A: TMS320C80 power consumption is based on the "typical" values of I_{DD} measured at V_{DD} = 3.3 V. Power consumption varies by application based on TMS320C80 processor activity and I/O pin loadings. User must ensure that the case temperature (T_C) specifications are met when defining airflow and other thermal constraints of their system.

Figure 134. Airflow Requirements



emulator interface connection

The 'C80 supports emulation through a dedicated emulation port that is a superset of the IEEE Standard 1149.1 (JTAG) Standard. To support the 'C80 emulator, a target system must include a 14-pin header (2 rows of 7 pins) with the connections shown in Figure 135.



Figure 135. Target System Header

Table 38. Target Connectors

XDS 510 SIGNAL	XDS 510 STATE	TARGET STATE	DESCRIPTION		
TMS	0	Į	Test-mode select [†]		
TDI	0	Į.	Test-data input [†]		
TDO	I	0	Test-data output [†]		
TCK	0	I	Test clock – 10 MHz clock source from emulator. Can be used to drive system-test clock.†		
TRST	0	I	Test reset [†]		
EMU0	I	I/O	Emulation pin 0		
EMU1	I	I/O	Emulation pin 1		
PD (3.3 V)	I	0	Presence detect. Indicates that the target is connected and powered up. Should be tied to + 3.3 V on target system.		
TCKRET I O Test clock return. Test clock input to the version of TCK.†		0	Test clock return. Test clock input to the XDS 510 emulator. Can be buffered or unbuffered version of TCK.†		

[†] IEEE Standard 1149.1.

For best results, the emulation header should be located as close as possible to the 'C80. If the distance exceeds six inches, the emulation signals should be buffered. See Figure 136.

emulator-interface connection (continued)

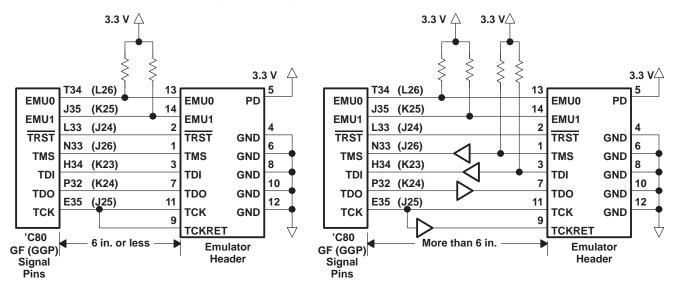


Figure 136. Emulation Header Connections – Emulator Driven Test Clock

The target system also can generate the test clock. This allows the user to:

- Set the test clock frequency to match the system requirements. (The emulator provides only a 10-MHz test clock.)
- Have other devices in the system that require a test clock when the emulator is not connected

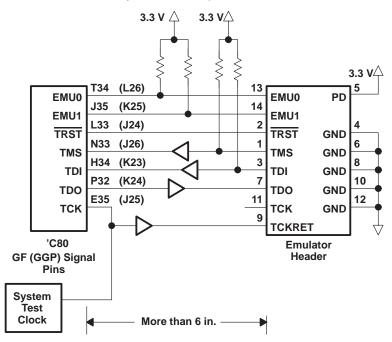


Figure 137. Emulation Header Connections - System Driven Test Clock

emulator-interface connection (continued)

For multiprocessor applications, the following conditions are recommended:

- To reduce timing skew, buffer TMS, TDI, TDO, and TCK through the same physical package.
- If buffering is used, 4.7 k Ω resistors are recommended for TMS, TDI, and TCK which should be pulled high (3.3 V).
- Buffering EMU0 and EMU1 is highly recommended to provide isolation. The buffers need not be in the same physical package as TMS, TCK, TDI, or TDO. Pullups to 3.3 V are required and should provide a signal rise time of less than 10 μ s. A 4.7 k Ω resistor is suggested for most applications.
- To ensure high quality signals, special printed wire board (PWB) routing and use of termination resistors may be required. The emulator provides fixed series termination (33 Ω) on TMS and TDI and optional parallel terminators (180 Ω pullup and 270 Ω pulldown) on TCKRET and TDO.

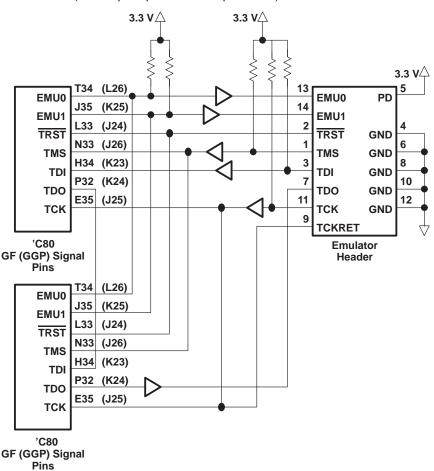
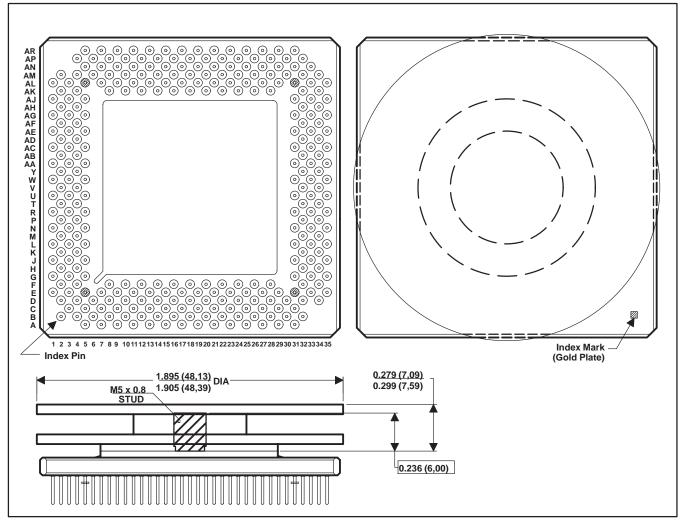


Figure 138. Emulation Header Connections - Multiprocessor Applications

GF package drawing



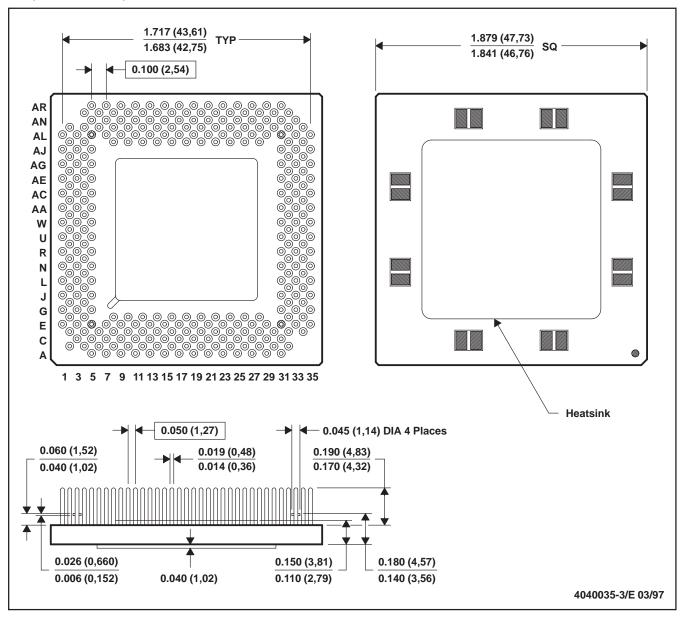
- NOTES: A. Pins are located within 0,13 (0.005) radius of the true position relative to each other at maximum material condition and within 0,457 (0.018) radius of the center of the ceramic.
 - B. Dimensions do not include solder finish.

Figure 139. Assembled Package Drawing Showing Integral Heatsink

MECHANICAL DATA

GF (S-CPGA-P305)

CERAMIC PIN GRID ARRAY PACKAGE



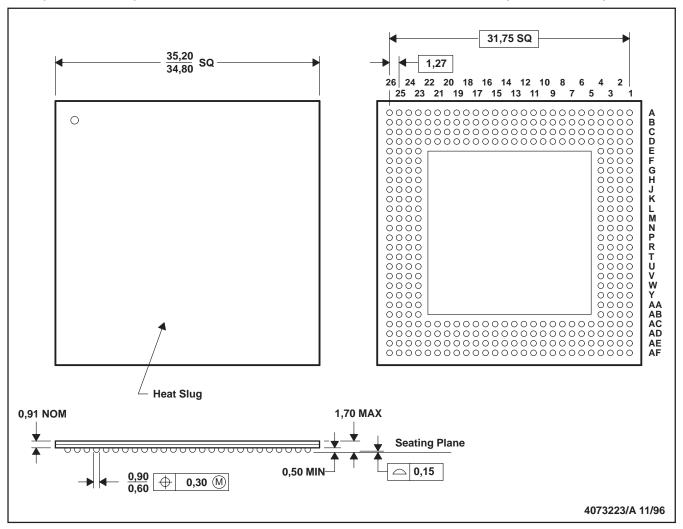
NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. Package thickness of 0.150 (3,81) / 0.110 (2,79) includes package body and lid, but does not include integral heatsink or attached features.

MECHANICAL DATA

GGP (S-PBGA-N352)

PLASTIC BALL GRID ARRAY (CAVITY DOWN) PACKAGE



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- Thermally enhanced die down plastic package with top surface metal heat slug.





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PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp (3)
TMS320C80GF	OBSOLETE	CPGA	GF	305		TBD	Call TI	Call TI
TMS320C80GF50	NRND	CPGA	GF	305	10	TBD	Call TI	Level-NC-NC-NC
TMS320C80GF60	NRND	CPGA	GF	305	10	TBD	Call TI	Level-NC-NC-NC
TMS320C80GGP50	NRND	BGA	GGP	352	24	TBD	SNPB	Level-4-220C-72HR
TMS320C80GGP60	NRND	BGA	GGP	352	1	TBD	SNPB	Level-4-220C-72HR
TMX320C80GF50	OBSOLETE	CPGA	GF	305		TBD	Call TI	Call TI
TMX320C80GF60	OBSOLETE	CPGA	GF	305		TBD	Call TI	Call TI
TMX320C80GGP	OBSOLETE	BGA	GGP	352		TBD	Call TI	Call TI
TMX320C80GGP50	OBSOLETE	BGA	GGP	352		TBD	Call TI	Call TI
TMX320C80GGP60	OBSOLETE	BGA	GGP	352	•	TBD	Call TI	Call TI

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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